



PSM20-374FB



MXi501U
TECHNICAL SERVICE MANUAL



LARCAN INC.
228 AMBASSADOR DRIVE
MISSISSAUGA, ONTARIO
CANADA L5T 2J2
PHONE: (905) 564-9222
FAX: (905) 564-9244
EMAIL: techservices@larcan.com

PSM20-374FB
September 2010

CONTENTS

PSM20-374FB MXi501U TECHNICAL SERVICE MANUAL

1 MXI501U AMPLIFIER INTRODUCTION 1

2 SAFETY NOTICES 2

2.1 BERYLLIUM OXIDE WARNING..... 2

2.2 OTHER TOXIC MATERIALS 2

2.3 DANGEROUS VOLTAGES..... 2

 2.3.1 *Switch to Safety*..... 3

3 LARCAN PARTS, ASSEMBLIES, ASSEMBLY DRAWINGS AND SCHEMATIC NUMBERS 5

3.1 VENDOR STANDARD PART NUMBERS 5

3.2 LARCAN NUMBERS FOR PARTS, ASSEMBLIES AND DOCUMENTATION 5

3.3 LEADED RESISTORS..... 6

3.4 SURFACE MOUNT RESISTORS 1/4W AND LESS 6

3.5 SURFACE MOUNT CAPACITORS..... 7

3.6 PARTS LISTS..... 7

 3.6.1 *Production Changes*..... 7

FIGURES

FIGURE 1 MXI501U AMPLIFIER ASSEMBLY 1

FIGURE 2 MXI501U POWER SUPPLY ASSEMBLY..... 1

PUB07-025FB MXi501U OPERATIONS AND MAINTENANCE

1 MXI501U AMPLIFIER 3

2 MXI501U AMPLIFIER HEATSINK ASSEMBLY 4

3 MXi AMPLIFIER CONTROLLER..... 5

4 AMPLIFIER INSTALLATION AND STARTUP 7

4.1 BEFORE APPLYING AC TO THE UNIT 7

4.2 APPLYING AC TO THE UNIT 7

4.3 BEFORE TURNING THE AMPLIFIER ON 8

4.4 AMPLIFIER ON SEQUENCE 8

 4.4.1 *Turning ON MXi Amplifier* 9

 4.4.2 *TYPICAL DATA read on the LCD* 9

5 TEST AND TROUBLESHOOTING 10

5.1 BENCH TEST PROCEDURES..... 10

 5.1.1 *Front-End Module Bench Test Procedure* 10

 5.1.2 *IPA, 21B1324, Bench Test Procedure*..... 10

 5.1.3 *Driver, 21B1639, Bench Test Procedure* 11

 5.1.4 *PA Pallet 11A2142G1 Bench Test Procedure*..... 11

5.2 BASIC TROUBLESHOOTING TECHNIQUES..... 12

 5.2.1 *No RF Output*..... 12

 5.2.2 *Output Reduced to 56%*..... 12

6 MAINTENANCE..... 13

6.1 DAILY 13

6.2 MONTHLY 13

6.3 SEMI-ANNUALLY AND ANNUALLY..... 13

MXI501U TECHNICAL SERVICE MANUAL

6.4 TRANSMITTER COOLING SYSTEM..... 13

7 SERVICE..... 14

7.1 REMOVING THE FAN ARRAY 14

7.2 REPLACING THE ENTIRE FAN ARRAY 15

7.3 REPLACING A SINGLE FAN 15

8 TEST EQUIPMENT SETUP..... 16

9 SPECIFICATIONS 17

9.1 ELECTRICAL 17

9.2 ENVIRONMENTAL 17

9.3 COOLING 17

9.4 DIMENSIONS..... 17

9.5 SHIPPING WEIGHT 17

PUB07-026FB MXi501U AMPLIFIER CHASSIS

1 MXI501U AMPLIFIER 1

PUB07-027FB MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

1 POWER AMPLIFIER HEATSINK ASSEMBLY 40D2104G1..... 1

2 FRONT END MODULE ASSEMBLY 21B1473G1..... 2

3 IPA MODULE 21B1951G1..... 3

4 DRIVER MODULE 21B1639G1 5

5 PA PALLET ASSEMBLY 11A2142G1 6

6 FOUR-WAY SPLITTER 21B2425G1..... 7

7 FOUR-WAY COMBINER 21B2426G1 8

PUB07-029FB MXi501/1002U EXTERNAL DIRECTIONAL COUPLER

1 MXI501/1002U EXTERNAL DIRECTIONAL COUPLER 1

PUB07-015FB MXi501/1002U POWER SUPPLY

1 MXI501/1002U POWER SUPPLY PFC2K-3212A-P6951 1

2 POWER SUPPLY DATA SHEET REPRINT 3

PUB07-028FB MXi501U POWER SUPPLY CHASSIS

1 MXI501U POWER SUPPLY CHASSIS..... 1

2 CURRENT SENSOR BOARD 11A2226G1..... 3

PUB06-82 Rev2 MXi CONTROLLER BOARD

1	INTRODUCTION	1
2	GENERAL OPERATIONS	3
2.1	CONNECTOR AND SIGNAL DEFINITIONS	3
2.1.1	J1 BDM (Background Debug Mode) Connection	3
2.1.2	J2 Remote RS232 Connection	3
2.1.3	J3 Front Panel LCD and Touchpad	3
2.1.4	J4 +32 Volt DC Power Supply	3
2.1.5	J5 +32 Volt DC Power Supply Sensing (External)	3
2.1.6	J6 Remote Controls	3
2.1.7	J7 Transmitter Switch Interface	4
2.1.8	J8 Fan Interface	4
2.1.9	J9 External Controls	4
2.1.10	J10 AGC Control	4
2.1.11	J11 Aural Detector (Optional)	4
2.1.12	J12 Forward RF Sample	4
2.1.13	J13 Reflected RF Sample	4
2.1.14	J14 Front Panel LCD Power	4
2.2	JUMPER OPTIONS	4
2.2.1	BDM Slide Switch S2	4
2.3	FRONT PANEL AND CONTROL INDICATORS	7
2.3.1	Default/Normal E5= Ext E7=Out	7
2.3.2	Manual Override E5= Int E7=Out	7
2.3.3	Remote Override E5= Ext E7=In	7
2.3.4	Manual and Remote Override E5= Int E7=In	7
2.4	RF DETECTOR OPERATION	8
2.5	AGC, VSWR AND CUTBACK OPERATION	9
2.6	INTERLOCKS	10
2.6.1	Hard Interlocks	10
2.6.2	Soft Interlocks	11
2.7	EXTERNAL SIGNALS AND REMOTE CONTROL	11
2.7.1	External #1 Interlock	11
2.7.2	Remote Controls (Individual)	12
2.7.3	Remote Interface (Serial)	12
2.7.4	Transmitter Switching Interface	12
2.7.5	External DC Power Supply	12
3	LCD GUI INTERFACE AND TOUCHPAD	13
3.1	MAIN SCREEN AND TOUCHPAD OPERATIONS	13
3.1.1	REM	14
3.1.2	AGC	14
3.1.3	ERR	14
3.1.4	LOG	14
3.1.5	AMP	15
3.1.6	P/S	15
3.1.7	INTK	15
3.1.8	GEN	15
3.2	AMPLIFIER SCREEN	15
3.2.1	TRIP	17
3.2.2	L/O	17
3.2.3	RF	17
3.2.4	INTK	17

MXI501U TECHNICAL SERVICE MANUAL

3.2.5	<i>PSOK</i>	17
3.2.6	<i>FAN1</i>	17
3.2.7	<i>FAN2</i>	18
3.2.8	<i>FAN3</i>	18
3.3	POWER SUPPLY SCREEN	18
3.3.1	<i>OK STAT</i>	19
3.3.2	<i>PS ON</i>	19
3.3.3	<i>INTK</i>	19
3.3.4	<i>FAN</i>	19
3.4	INTERLOCKS SCREEN	19
3.4.1	<i>TRIP</i>	20
3.4.2	<i>L/O</i>	21
3.4.3	<i>TEMP</i>	21
3.4.4	<i>PSOK</i>	21
3.4.5	<i>VOR</i>	21
3.4.6	<i>CUTB</i>	21
3.4.7	<i>FANS</i>	21
3.5	REMOTE CONTROLS AND RS232 SERIAL SCREEN	22
3.5.1	<i>Remote</i>	23
3.5.2	<i>NewFmt</i>	23
3.5.3	<i>ExtCmd</i>	23
3.5.4	<i>SerCmd</i>	23
3.5.5	<i>Error</i>	24
3.5.6	<i>Logs Screen</i>	24
3.6	GENERAL SCREEN	25
4	SETUP PROCEDURES	27
4.1	RF DETECTOR	27
4.2	AGC AND CUTBACK PROTECTION	29
4.2.1	<i>AGC Setup</i>	29
4.2.2	<i>Cutback Setup</i>	29
4.3	VSWR PROTECTION	29
4.4	REMOTE CONTROL INTERFACE BAUD	30
4.5	POWER SUPPLY VOLTAGE AND CURRENT CALIBRATION	31
5	REMOTE CONTROL CONNECTIONS MXi TRANSMITTER.....	32
5.1	REMOTE CONTROLS	32
5.1.1	<i>RC_TX_On Remote Transmitter ON Control</i>	33
5.1.2	<i>RC_TX_Off Remote Transmitter OFF Control</i>	33
5.1.3	<i>RC_TX_VOR Remote Transmitter VOR Control</i>	34
5.1.4	<i>RC_RESET Remote RESET Control</i>	34
5.2	EXT1 SECONDARY EXTERNAL #1 INTERLOCK	34
5.2.1	<i>Status Outputs</i>	35
5.3	TELEMETRY OUTPUTS	35
6	CIRCUIT DESCRIPTIONS	37
6.1	MC68HC908 MICROPROCESSOR	37
6.2	POWER SUPPLY VOLTAGE AND CURRENT MONITORING	38
6.3	ON/OFF RELAY K1	40
6.4	AGC, CUTBACK AND VSWR	40
6.5	SPI UART	41
6.6	SPI NVPOT	42
6.7	RF DETECTOR	42
6.7.1	<i>Circuit Description</i>	42
6.8	J12 CHANNEL – VISUAL FORWARD	42
6.9	J13 CHANNEL – REFLECTED	43
6.10	J12 CHANNEL – AURAL FORWARD	44

MXI501U TECHNICAL SERVICE MANUAL

7	ADDENDUMS	45
7.1	ADDENDUM 1– CDS51405 DISPLAY CONTROLLER	46
7.2	ADDENDUM 2–DUAL DIGITAL POTENTIOMETER WITH EEPROM	49
7.3	ADDENDUM 3–SPI/MICROWIRE-COMPATIBLE UART AND +/-15kV ESD-PROTECTED RS-232 TRANSCEIVERS WITH INTERNAL CAPACITORS.....	52
7.4	ADDENDUM 4–MC68HC908GTXX DATA SHEET	55
7.5	ADDENDUM 5– CURRENT TRANSDUCER HXS 20-NP	62

MXI501U TECHNICAL SERVICE MANUAL

1 MXI501U AMPLIFIER INTRODUCTION

This Technical Service Manual contains publications (PUBs) describing the technical details of the MXi501U amplifier, as well as the overall operating instructions, including the bench test procedures of the amplifier stages incorporated in this unit. It also covers the transmitter's start-up operation, and troubleshooting, as well as basic transmitter maintenance guidelines.

The transmitter consists of an amplifier chassis that houses the main controller and touch LCD and a power supply chassis that houses the power supply used to power the amplifiers.



Figure 1 MXi501U Amplifier Assembly



Figure 2 MXi501U Power Supply Assembly

2 SAFETY NOTICES

This section provides general guidance and information for the operation, maintenance, and service personnel who are familiar with the hazards of working with high-powered electronic circuits. This manual does not detail all of the safety precautions which should be observed when servicing this or any other electronic equipment. **Service by inadequately trained or inexperienced personnel can result in personal injury or death and/or damage to the equipment.**

Important: All personnel concerned with the servicing of this equipment should be thoroughly familiar with standard first aid procedures for the treatment of electrical burns and shock, including cardio-pulmonary resuscitation (CPR).

Use the “buddy” system, with one person performing the actual service and a colleague observing. The observer must be familiar with the work being performed and within sight and sound of the person doing the work. The observer should not be engaged in any other work or be otherwise distracted; he must be available **instantly** in case of accident.

Always have the observer with you when you work on the transmitter.

2.1 BERYLLIUM OXIDE WARNING

Internal thermal management in certain RF devices in this equipment is accomplished through the use of Beryllium Oxide ceramic material. Do not break open any RF power transistors, or otherwise dismantle them. Beryllium Oxide is a hard white ceramic used as insulation for heatsinking of RF power semiconductors. Beryllium Oxide is a **poison**. In case of accidental breakage of devices, **do not inhale the resulting beryllium dust and avoid getting beryllium dust in your mouth. Do not let beryllium into your blood stream through cuts or open wounds.** Seek **immediate** medical attention if the dust enters your body in any manner. Avoid cuts by wearing gloves while picking up the broken pieces. Be careful – do not inhale dust while replacing or emptying vacuum cleaner filter bags and wash your hands thoroughly afterward. Wash your hands thoroughly after replacing RF power devices. Dispose of defective RF power devices only through approved toxic waste facilities. Wear gloves when picking up the pieces. Wash your hands thoroughly after replacing devices. Dispose of defective devices only through approved toxic waste facilities.

When cleaning up after an accidental breakage, remember to wear a respirator mask to avoid inhaling the dust while replacing or emptying vacuum cleaner filter bags and to wash your hands well after servicing the vacuum cleaner. If possible, use a wet vacuum, in which the dust gets trapped in water.

2.2 OTHER TOXIC MATERIALS

The non-metallic coverings of some coaxial cables used in this equipment are **flammable** and can transmit fire when ignited. Other wire coverings are not capable of supporting combustion but any non-metallic covering when heated sufficiently can emit dense smoke and acid gases, which can be highly toxic and often corrosive.

Solvents and glues can emit toxic vapors and can be flammable. Read and understand the directions on the containers and ensure that they are used only in well ventilated locations.

2.3 DANGEROUS VOLTAGES

This equipment has been designed to protect operating personnel from accidental contact with dangerous voltages, by means of shields and covers. It is extremely important that any protective covering devices be kept in place at all times.

While all practical safety precautions have been adopted to safeguard personnel from possible injury, both supervisory and operating personnel are urged to ensure that the safety rules detailed below are followed as an established routine at all times. The following four Rules are the standard safety guidelines for working with and around transmitters.

MXI501U TECHNICAL SERVICE MANUAL

Rule #1 **KILL THE AC POWER BEFORE IT KILLS YOU**

Under no circumstances should any person reach within the cabinets for the purpose of servicing or adjusting the equipment without first disconnecting the AC power or without the immediate presence of another person capable of rendering aid. The "buddy" system is encouraged for transmitter work.

Rule #2 **DO NOT TAMPER WITH INTERLOCKS OR SAFETY SHIELDS**

Under normal circumstances, no safety shield should be removed.

Rule #3 **REMOVE PERSONAL JEWELRY WHEN WORKING ON THE EQUIPMENT**

The mains AC power to this transmitter can deliver high currents capable of melting metallic tools or personal jewelry, such as watch bands, bracelets, or rings. Accidental short circuits from such metallic objects can cause an explosive shower of molten metal which can result in serious personal injury.

Rule #4 **KNOW FIRST AID AND KEEP FIRST AID SUPPLIES AVAILABLE**

Illustrated first aid instructions for the treatment of electrical shock and burns and CPR procedures should be displayed in a prominent location adjacent to the equipment. In rendering first aid, the timeliness and effectiveness of the treatment are vitally important to the recovery of the injured person.

Always have a colleague with you when you work on the transmitter and make sure both of you know first aid, including cardio-pulmonary resuscitation (CPR). This is most important.

Without exception, all personnel should thoroughly familiarize themselves with the procedures involved. One person, whose normal duties place him or her at the transmitter site often, should be given complete responsibility and authority to ensure that first aid supplies are kept onsite and maintained. Prominently display a list of emergency phone numbers. This list should include the numbers of the nearest police, ambulance, hospital, doctor, fire department, paramedics, poison control center, public works (roads) department, and the utility (power and phone) companies.

Do not try to work on the transmitter if you are tired or drowsy; you could make a fatal error in judgment.

2.3.1 Switch to Safety

Here are some safety suggestions, based partially on the knowledge of experts familiar with high-powered tubed equipment, and partially on the procedures used at a typical utility company and at a company which makes and tests high voltage devices. A few of these suggestions apply primarily to factory environments and require some modification to be applied in transmitter settings.

Our thanks to the Varian Corporation for sharing its "Electrical Safety Training Program" notes. Our thanks also to Ontario Hydro for its information booklets dealing with high voltage.

Have in place a comprehensive safety program, with defined procedures. Know First Aid and CPR.

Use the "buddy" system, with one person performing the actual service and a colleague observing. The observer must be familiar with the work being performed and within sight and sound of the person doing the work. The observer should not be engaged in any other work or be otherwise distracted; he must be available **instantly** in case of accident. *Always have the observer with you when you work on the transmitter.*

Pay attention to emergency communications requirements. This could even include a voice channel on the STL so that constant communication with the studio can be maintained. Headset-equipped phones connected on this voice channel should be installed in locations near hazardous areas or everyone on site should carry fully charged cell phones. When you are administering CPR, you might not be able to leave your patient for the length of time it could take to call paramedics, especially if phone service is poor, or lines are down, and/or you are in a rural area without emergency telephone service (e.g., 911 in North America).

Do not defeat the interlock switches on access doors unless it is absolutely necessary and you know **exactly** what you are doing.

Keep the area neat and tidy, free of any interfering conductive material and free of any sharp objects. Remember that reaction to a shock could cause you to strike nearby objects.

MXI501U TECHNICAL SERVICE MANUAL

Avoid wearing loose clothing and personal jewelry such as rings, watches, and chains when working near energized circuits. Make a habit of removing all jewelry and storing it in a safe place as soon as you enter the transmitter building.

Before beginning work, **shut off all AC to the transmitter power supplies. Tag and lockout the switches.** Your safety routine must ensure that the person placing the tag and locking the switch is the only person who removes it and reactivates the switch. You might want to include the AC to the remote control as well, if there is any possibility that a studio worker could unknowingly activate the transmitter while you are working on it. One way of ensuring that the lockout "placer and remover" are the same person is to issue individual padlocks to each person on the transmitter technical staff.

You might want to include your tower contractor's rigging crew in the list of people who are allowed to use tags and padlocks. As an alternative, Dielectric™ makes a transmission line lockout switch that is intended for riggers to turn off and lock out any RF before climbing over the antenna to replace light bulbs, etc.

Proper grounding is **vital**. Make ground inspection a part of your maintenance program; someone's life could depend on it.

3 LARCAN PARTS, ASSEMBLIES, ASSEMBLY DRAWINGS AND SCHEMATIC NUMBERS

3.1 VENDOR STANDARD PART NUMBERS

Vendor or original manufacturer part numbers are indicated for most components.

3.2 LARCAN NUMBERS FOR PARTS, ASSEMBLIES AND DOCUMENTATION

An index of LARCAN specified numbers are used to define and specify the following:

- parts made by a manufacturer to LARCAN specification;
- an assembled unit or “group” such as a PC Board or completed cabinet;
- assembly drawings and schematics;
- standards.

Depending on the application, AutoCAD drawing or Microsoft Word document format is used.

Document numbers have the format **YYZXXXXKn Rev m** where:

YYZ Prefix denoting drawing size and Product type. Can be 10A, 11A, 20B, 21B, 30C, 31C, 40D, 41D, 50E, 51E
– describes drawing or document size, VHF or UHF application

XXXX Drawing Index number. Between 0000 to 9999.

K Refers to the type of drawing / document:

- “no suffix” for drawing of part (assembly or schematic)
- P = Part
- G = Group of parts
- A = Assembly drawing
- F = PC board fabrication films and
- S = Schematic

n Index number for drawing type. Part, group, assembly drawing or schematic next number and may be one or more digits

Rev Revision (sometimes denoted as R or R–)

m Revision number and may be one digit or more. May contain a decimal (e.g., Revision 3.2)

Drawings may consist of one or more sheets. Generally multiple sheets are used if one sheet is not enough to show all necessary information. Sometimes, especially with older drawings, multiple sheets are used to show more than one part or assembly.

MXI501U TECHNICAL SERVICE MANUAL

3.3 LEADED RESISTORS

Generic carbon composition resistors with leads are numbered as follows:

3R	□□□	P	nnnx - or - nnx	□
----	-----	---	-----------------------	---

<u>Power Rating</u>	<u>Resistance Value *</u>	<u>Tolerance</u>
152 = 1/4W	nn - first digits of resistance (5, 10% tol.)	K =10%
77 = 1/2W		J =5%
78 = 1W	nnn - first digits of resistance (1% tol.)	H =1%
79 = 2W	x - x10 multiplier	

For values between 1Ω and 10Ω, a letter “R” will appear in the resistance value to indicate the decimal place.

For vendor leaded resistors a generic drawing describing basic specifications, but having many “parts”, will often be used.

“3R152P5R6J” is 5.6Ω, 1/4W, ±5%

“3R152P470K” is 47Ω, 1/4W, ±10%

“3R152P1022H” is 10.2kΩ, 1/4W, ±1%

“3R152P102J” is 1kΩ, 1/4W, ±5%

3.4 SURFACE MOUNT RESISTORS 1/4W AND LESS

There is no specified recommended supplier of these parts. The Philips numbering system is employed with the following parameters/designations (example follows):

9C	□□□□	□	A	nnnx	□	□
----	------	---	---	------	---	---

<u>SIZE LxW</u>	<u>POWER RATING</u>	<u>RESISTANCE VALUE</u>	<u>TOLERANCE</u>	<u>TEMP COEF</u>
0603 =1.6x08mm	1 = 1/16W	nnx tolerance>=5% nn=first 2 digits x=multiplier	D =0.5%	C =50ppm/°C
0805 =2x1.25mm	2 = 1/10W		F =1%	K =100ppm/°C
1206 =3.2x1.6mm	2 = 1/8W (1% tol.)	nnnx tolerance<5% nnn=first 3 digits x=multiplier	J =5%	L =200ppm/°C
	3 =1/4W (5% tol.)		M =300ppm/°C	

nRnx or nnRnx or nRnnx
R inserted as decimal point
where required

0000 - four zeros for jumper

The pairs of parameters enclosed in boxes are normally mutually selected; for example, a resistor having 1% tolerance normally is selected as having a temperature coefficient of 100ppm/°C.

MXI501U TECHNICAL SERVICE MANUAL

Example: **9C08052A1001FK**

(Size 0805, Power Rating 1/10W, Resistance 1kohm, Tolerance 1%, Temperature Coefficient 100ppm/°C)

3.5 SURFACE MOUNT CAPACITORS

There is no specifically recommended supplier of these parts. The part numbering system being used is based on a Philips (now Yageo/Phycomp) numbering system with the following parameters/designations (example follows):

<u>SIZE LxW</u>	<u>DIELECTRIC MATERIAL</u>	<u>CAPACITANCE VALUE</u> (in Pico farads)	<u>TOLERANCE</u>	<u>VOLTAGE RATING</u>	<u>TERMINATION</u>
0603 =1.6x08mm	CG = NPO	nn =first 2 digits	B =0.10pF	7 =16VDC	B =Ni/Sn
0805 =2x1.25mm	2R = X7R	x =multiplier as shown below	C =0.25pF	8 =25VDC	A=Ag/Pd
1206 =3.2x1.6mm	2F = Y5V *	8=x0.01	D =0.50pF	9 =50 VDC	C=Ni/Sn-Pb
	2E = Z5U *	9=x0.1	F =1%	0 =100VDC	
		0=x1	G =2%	B =200VDC	
		1=x10	J =5%	D =500VDC	
		2=x100	K =10%		
		3=x1000	M =20%		
		4=x10000			
		5=x100000			

* (infrequent use)

e.g., 0805CG102J9B

SIZE	=0805
DIELECTRIC MATERIAL	=NPO
VALUE	=1000pF
TOLERANCE	=5%
VOLTAGE RATING	=50V
TERMINATION	=Ni/Sn
PACKAGING	=Not Specified
MARKING	=None

Note that “u” appears in most cases instead of the correct symbol “μ” whenever a “micro” is required. Electronic parts list data, when imported by our PC publication program, allows us to substitute the correct “μ” when checking and editing.

3.6 PARTS LISTS

Parts lists for all assemblies in the transmitter are provided on CD-ROM, in PDF format. The CD-ROM is packed inside the transmitter cabinet for shipping.

Parts lists are generated in a hierarchical structure, beginning with major assemblies, then the subassemblies of each major assembly, and so forth.

3.6.1 Production Changes

From time to time, it may become necessary to make changes in the equipment described in this manual. Such changes are usually made either to provide improved performance or to accommodate component substitutions.

MXI501U TECHNICAL SERVICE MANUAL

A revision letter or number may follow the model or group number marked on the nameplate, chassis, or circuit board; or on the parts list (where it is an "R" followed by a dash and a number). Whenever a revision letter or number appears, it should be quoted in any communication regarding the equipment.

MXI501U OPERATIONS AND MAINTENANCE

CONTENTS

1	THE MXi501U TRANSMITTER.....	3
2	MXi501U AMPLIFIER HEATSINK ASSEMBLY	4
3	MXi AMPLIFIER CONTROLLER.....	5
4	AMPLIFIER INSTALLATION AND STARTUP	7
4.1	BEFORE APPLYING AC TO THE UNIT	7
4.2	APPLYING AC TO THE UNIT	7
4.3	BEFORE TURNING THE AMPLIFIER ON	8
4.4	AMPLIFIER ON SEQUENCE.....	8
4.4.1	<i>Turning ON the MXi Transmitter.....</i>	<i>9</i>
4.4.2	<i>TYPICAL DATA read on the LCD.....</i>	<i>9</i>
5	TEST AND TROUBLESHOOTING	10
5.1	BENCH TEST PROCEDURES	10
5.1.1	<i>Front-End Module, 21B1473, Bench Test Procedure.....</i>	<i>10</i>
5.1.2	<i>IPAI, 21B1324, Bench Test Procedure.....</i>	<i>10</i>
5.1.3	<i>Driver Pallet, 21B1639, Bench Test Procedure.....</i>	<i>11</i>
5.1.4	<i>PA Pallet 11A2142G1 Bench Test Procedure.....</i>	<i>11</i>
5.2	BASIC TROUBLESHOOTING TECHNIQUES	12
5.2.1	<i>No RF Output.....</i>	<i>12</i>
5.2.2	<i>Output Reduced to 56%.....</i>	<i>12</i>
6	MAINTENANCE.....	13
6.1	DAILY.....	13
6.2	MONTHLY.....	13
6.3	SEMI-ANNUALLY AND ANNUALLY	13
6.4	TRANSMITTER COOLING SYSTEM	13
7	SERVICE.....	14
7.1	REMOVING THE FAN ARRAY.....	14
7.2	REPLACING THE ENTIRE FAN ARRAY	15
7.3	REPLACING A SINGLE FAN.....	15
8	TEST EQUIPMENT SETUP.....	16
9	SPECIFICATIONS	17
9.1	ELECTRICAL	17
9.2	ENVIRONMENTAL	17
9.3	COOLING	17
9.4	DIMENSIONS	17
9.5	SHIPPING WEIGHT	17

FIGURES

FIGURE 1	MXi501 AMPLIFIER (TOP), AND POWER SUPPLY.....	3
FIGURE 2	MXi501 AMPLIFIER HEATSINK ASSEMBLY.....	4
FIGURE 3	MXi CONTROLLER.....	5
FIGURE 4	MXi FRONT PANEL	5
FIGURE 5	MAIN MENU SCREEN	5
FIGURE 6	AMPLIFIER (AMP) SUBMENU	6
FIGURE 7	POWER SUPPLY (P/S) SUBMENU SCREEN	6
FIGURE 8	REAR PANEL SHOWING INTERLOCK CONNECTOR	7

MXI501U OPERATIONS AND MAINTENANCE

FIGURE 9 MAIN MENU.....	8
FIGURE 10 INTERLOCKS STATUS	8
FIGURE 11 TRANSMITTER ON	9
FIGURE 12 BOTTOM VIEW OF MXI.....	14
FIGURE 13 FAN ARRAY	14
FIGURE 14 FAN ATTACHMENT TO MOUNTING PLATE.....	15
FIGURE 15 TEST EQUIPMENT SETUP.....	16

MXI501U OPERATIONS AND MAINTENANCE

1 THE MXi501U TRANSMITTER

The MXi501U transmitter is usually comprised of a LARCAN Modulator, a Power supply chassis, and Amplifier chassis

The RF section of the MXi501U consists of an amplifiers chassis capable of delivering power over 500 Watts ATSC Digital power. Its also contains the main controller board and LCD display

The power supply chassis mounted below the amplifier chassis houses a high efficiency dual output (+12VDC and +50VDC) switching power supply. The +12VDC power supply provides power to the amplifier controller and fans, and the +50V supplies power to the amplifier.



Figure 1 MXi501 Amplifier (top), and Power Supply

2 MXi501U AMPLIFIER HEATSINK ASSEMBLY

Each amplifier assembly consists of a control board, a heatsink assembly that includes four cascaded broadband amplifier stages, a 4-way splitter, a 4-way combiner, and a fuse block. The final amplifier stage (PA) comprises five amplifiers configured in parallel. Figure 2 below shows the layout of this assembly.



Figure 2 MXi501 Amplifier Heatsink Assembly

Also mounted on the heatsink located near the output side of the combiner is a thermal switch that protects the amplifier from over temperature conditions. Cooling is achieved using multiple muffin fans located under the hood between the heatsink and the controller. This fan-array assembly is accessible from the bottom of the amplifier assembly, and can be serviced easily by removing 3 screws.

3 MXi AMPLIFIER CONTROLLER

The MXi control board (Assembly 31C1897) is a single-circuit assembly that provides all of the control functions required for the MXi series of transmitters on a single circuit board. This board can be configured for a number of different transmitter types, power levels, transmission standards and options.



Figure 3 MXi Controller

The MXi control board provides local front panel interface via ON/OFF and RESET buttons as well as a graphical user interface through a front panel LCD assembly with touchpad for user commands. The board implements controls/status/telemetry for remote control through a rear panel connector that will interface to a typical remote control systems (such as Moseley or Gentner). An RS232 serial port is also provided to allow the operator to access the MXi through an external computer (with the appropriate software). The MXi control board has RF detectors for forward and reflected power and all the circuitry to support AGC/VSWR/Cutback functions. Circuitry to control and monitor the +50V power supply is also included on this board.



Figure 4 MXi Front Panel

The user interface to the amplifier is accomplished with the front panel LCD that incorporates a touchpad as an integral part of the unit. The LCD has the capability of displaying a variety of screens, which are selected by the user via the touchpad. Figure 5 shows the LCD main menu, which shows the present status of the amplifier along with the selections of submenus.

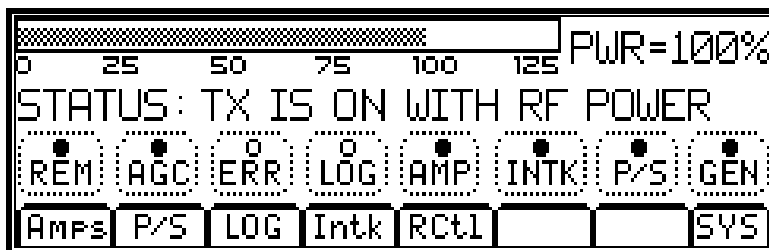


Figure 5 Main Menu Screen

MXI501U OPERATIONS AND MAINTENANCE

Forward (FWD) and Reflected power (RFL), AURal power, AGC and CUTBack (VSWR) control voltage, as well as the heatsink TEMPerature (Optional) can be displayed by selecting the AMP submenu as shown in Figure 6.

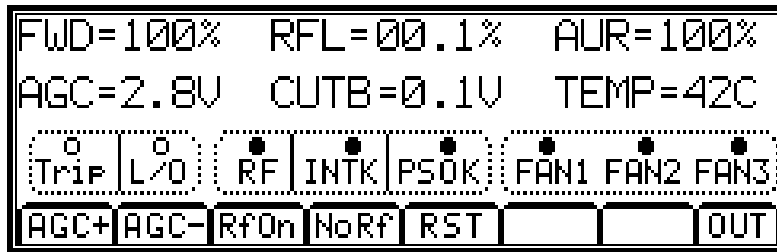


Figure 6 Amplifier (AMP) Submenu

Pressing the power supply P/S submenu from the Main Menu displays the power supply voltage and current consumption as well as its status.

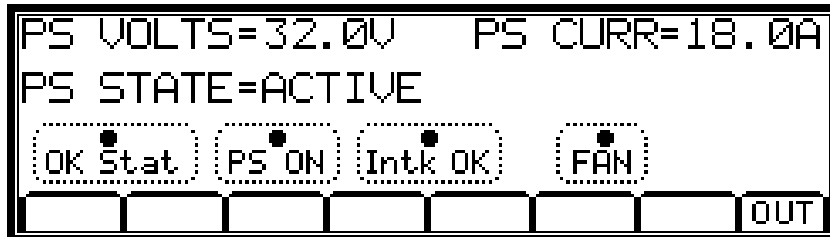


Figure 7 Power Supply (P/S) Submenu Screen

For complete documentation regarding the Amplifier Controller, see the publication *MXi Controller Board*.

4 AMPLIFIER INSTALLATION AND STARTUP

The MXi501U Amplifier was fully tested at LARCAN before it was delivered. Under normal circumstances, the transmitter can be fully operational with minimal setup when turned ON. However, a good practice is to take the “start from scratch” approach, which means that one should take precautionary measures before the amplifier is allowed to run at full rated power. These important steps will avoid any catastrophic failures at start-up. The procedure described is essentially the same approach taken at the factory with a new and untested transmitter. This also applies if there is a need to completely replace a major sub-assembly in the transmitter.

4.1 BEFORE APPLYING AC TO THE UNIT

Pay careful attention to items 1 to 3 before applying AC to the amplifier. These are initial steps that **must** be observed and followed for proper and safe operation of the amplifier.

1. Termination

- Ensure that the amplifier is properly terminated with a suitable load. This can be into a dummy load or into the transmitter output system. A 50 Ohm, 1kW load with at least -20dB return loss (1.2 VSWR) is recommended. Preferably, directional couplers with known coupling levels at the frequency of interest should be connected at the input and output of the band-pass filter. These points are very useful in determining absolute power levels and losses, and also for use as an RF sample for monitoring purposes. See Figure 12 for a typical transmitter test equipment setup.

2. Interlocks

- Interlocks must be connected to the amplifier to avoid damage to the equipment and to the output section. An Interlock is provided at the INTERLOCK terminal block located on the rear panel of the amplifier chassis. If this interlock is open, the B+ to the amplifiers will shut down, including the cooling fans.

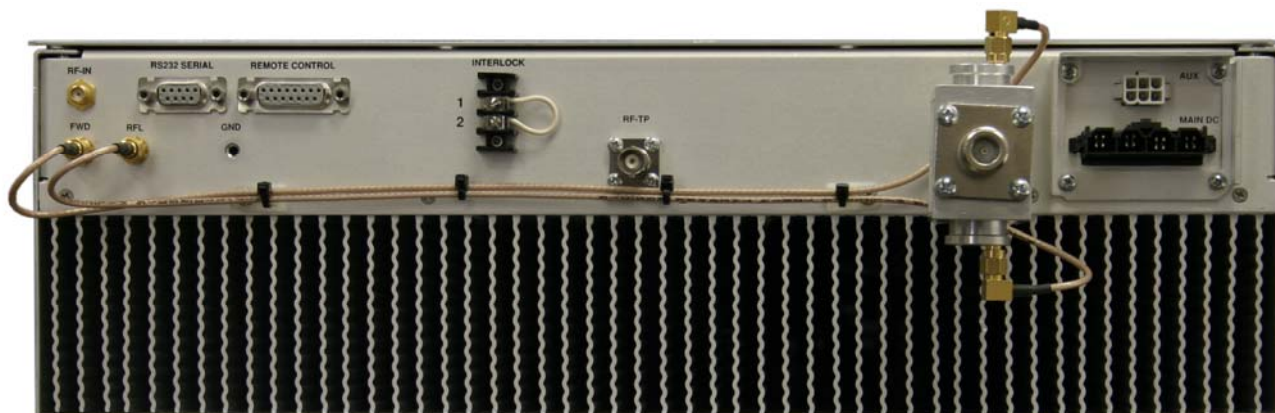


Figure 8 Rear Panel Showing Interlock Connector

3. Power At Minimum

- Initially, the modulator's output should be at minimum level..

4.2 APPLYING AC TO THE UNIT

- Check that the AC MAINS going into TB1 (across L1 and L2/N) ranges from 190-264VAC. If this is so, proceed to applying power, otherwise, investigate the source of the problem.
- Usually, once the AC is applied to TB1, the Control Power Supply turns ON and applies +12V to the MXi controller in the amplifier chassis.
- The Power-Up screen will be displayed on the LCD, followed immediately by the MXi Main Menu.

MXI501U OPERATIONS AND MAINTENANCE

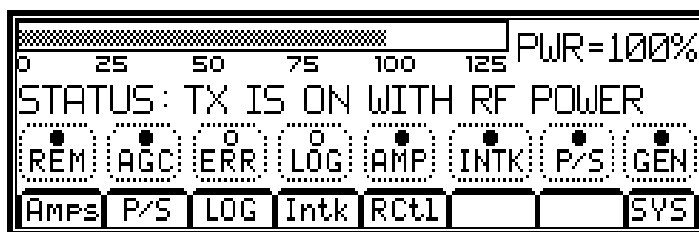


Figure 9 Main Menu

4.3 BEFORE TURNING THE AMPLIFIER ON

From the Main Menu, the status of the amplifier is displayed and shows if the amplifier is ready for operation. Status legends, when lit, such as the INTK (INTERLOCK), usually signify OK conditions and that the transmitter is ready to be switched ON.

Check that all of the following conditions are met:

1. Modulator and the up-converter, or Channel Processor are ready.
 - Usually in the application of AC, the modulator goes through its warm-up sequence. When all of the red LEDs are extinguished (not lit), it means that the modulator or up-converter is ready.
2. POWER METERING is at Zero.
 - On the LCD (see Main Menu display in Figure 9), the PWR should be at 000% and the STATUS should be TX IS OFF, NORMALLY.
3. MXi CONTROLLER is ready.
 - If there were prior faults, clear them by pushing the RESET button on the power supply chassis front panel.
4. INTERLOCKS are closed or OK.
 - Interlocks and Status are OK.

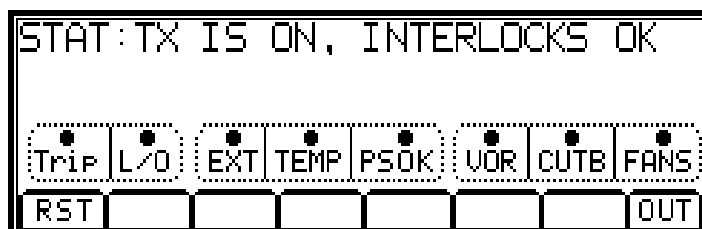


Figure 10 Interlocks Status

5. AGC control is DISABLED at this time.
 - Remove the AGC jumper from the control board.
6. The Amplifier is in LOCAL mode.
 - Push the REM button so that it is NOT lit.
7. The TX is OFF.
 - Push the Front Panel ON/OFF button so that it is NOT pushed in.

4.4 AMPLIFIER ON SEQUENCE

Upon depressing the ON button, the fans start and at the same time the +50V power supplies are enabled, thus applying B+ to both amplifiers. Since the modulator/up-converter or Channel Processor are on hot standby (RF is always applied), the amplifiers normally produce 100% output power immediately. For first time installations, it is recommended that the level of the modulator be set to minimum initially and then increase in steps until 100% power is attained. This is done so that catastrophic failure is avoided. Keep in mind that in a newly installed

MXI501U OPERATIONS AND MAINTENANCE

transmitter that loose or bad connections in the output, as an example, is possible particularly when the output system is not swept for proper matching or VSWR. Hence, as the power is increased, by observing the combined, single amplifier, reflected, and reject power metering one will be able to assess if everything is in proper order.

4.4.1 Turning ON the MXi Transmitter

1. Enable amplifier LOCAL operation by pressing the REM touch button such that the REM legend is NOT lit.
 - Push the front panel ON button.
 - The MXi Amplifier should now be ON.

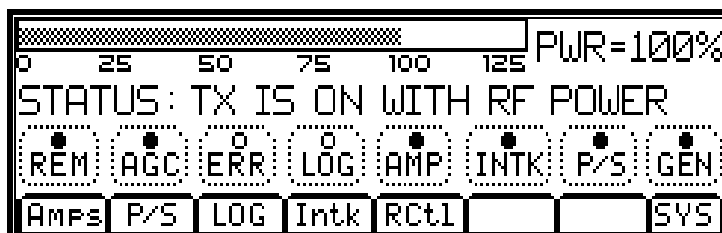


Figure 11 Transmitter ON

2. Monitor both +32V power supply voltages and currents on the LCD. Check that the power supplies are operating by pressing the P/S touch button. The voltage readings should be about 30V and the currents should be about 11A under Static condition (no RF drive).

ALLOW THE AMPLIFIER SOME WARM-UP TIME!

Only after the transmitter has been ON for approximately 15 minutes should you perform the fine adjustments. The amplifiers must be allowed to reach their operating temperature for stable operation. The Power Amplifiers in the MXi transmitter are equipped with thermal compensation circuits, which reduce the output power when the temperature rises. Therefore, the operating temperature must be reached before adjusting the RF level to its proper level, i.e. 100%. The amplifiers are also equipped with Automatic Gain Control, primarily designed to prevent the transmitter from overpower or overdrive condition.

3. Increase the RF output by slowly turning the Modulator/Exciter or Channel Processor output level control. Stop at about 25% output power indicated on the LCD. At this level, the current should not be more than 35 Amps.
4. If the current is not drastically higher, increase the power to 50%. Again, make note of the PS current readings. The current should be less than 50 Amps. Proceed to the next step if this condition is met.
5. Increase the RF output to 100%. The current should be about 60A with a black video signal. Typically, with a 50% APL video signal, the current drawn is about 50A.
6. AGC SETTING: With the AGC still disabled, increase the output power to 110%, using the output level control in the Exciter or Channel processor. Enable the AGC by inserting the AGC jumper, E16, on the control board. Use the LOWER button on the LCD to set the power to 100%.
7. With the amplifier fully functional and adjusted to its final setting, record keeping becomes very important. Record the current, voltage, power, etc. This data can be used as a very valuable troubleshooting tool later. Below is typical test data pertaining to the MXi amplifier at 100% output power.

4.4.2 TYPICAL DATA read on the LCD

Amplifier

FWD	100%	RFL	00.2%
AGC	1.0V	CUTB	0.0V

Power Supply

PS1 VOLTS	32.0V	PS1 CURR	58.0A
-----------	-------	----------	-------

5 TEST AND TROUBLESHOOTING

5.1 BENCH TEST PROCEDURES

The following procedures are test instructions for the amplifier modules comprising the MXi amplifier.

5.1.1 Front-End Module, *21B1473*, Bench Test Procedure

- Connect a +32V power supply to E1.
- Apply a 0dBm (1mW) RF input to the amplifier.
- Turn RV2 fully clockwise. The front-end should have a gain of 9dB. Adjusting R25 from one extreme to the other should vary the gain by 4dB.
- RF Mute Check: Connect a variable supply to J3-2. Gradually increase the voltage until the gain drops by 30dB or more. The applied voltage should be approximately 2.5 volts.
- Reflected Power Cutback Check: Connect the variable supply to J4-9. Increase the voltage gradually until the gain drops by 30dB or more. The voltage should be approximately 4.0 Volts $\pm 0.2V$. This same voltage should also be present at J3-14. J3-6 should be 4.0 volts.
- Overdrive Cutback Check: Connect the variable supply to J3-7. Increase the voltage until the gain drops by 30dB or more. The voltage should be 7.0 volts $\pm 0.5V$. The voltage at J3-11 should be the same and the voltage at J3-7 should be 4.0 volts.
- Set an adjustable power supply to 2.0 volts. Connect this voltage to J4-1, J4-3 and J4-5 simultaneously. J2-6 and J3-5 should be high. Disconnecting any one or more of J4-1, 3 or 5 should cause both J2-6 and J3-5 to go low (0V).

5.1.2 IPA1, *21B1324*, Bench Test Procedure

This amplifier must be mounted on a properly sized heatsink for testing.

- Connect a suitable load to the output of the Front-End module.
- On the unit under test (IPA), set RV200 fully clockwise and set RV110 fully counter-clockwise.
- Set variable power supply to 50.0 volts and set its current limit to 1 ampere.
- Apply the +50V to the feed-through capacitor of the pre-amp shield box.
- Adjust RV3 to achieve 6.5 ± 0.2 volts at the junction of R5 and RV100.
- Adjust RV200 to achieve total current draw of 500 ± 20 mA.
- Check that the junction of R100 and CR100 measures between 3.5 and 5.5 volts.
- Adjust RV110 to raise total current draw to 1000 ± 50 mA.
- Check that the junction of R110 and CR110 measures between 3.5 and 5.5 volts.
- Increase the power supply current limiting to 2.2 Amps.
- Increase RV3 clockwise slowly and check that the maximum current limits itself at 1.6 ± 0.1 Amp but do not allow current to go above 2 amps while performing this test.
- Reset RV3 to achieve 6.5 ± 0.2 volts measured at the junction of R5 and RV100.
- Check balance of the two transistors with a voltmeter connected between the hot sides of C105 and C115; the difference in voltage should be less than 3mV.
- Apply RF drive (max. +18 from a pre-amp) and adjust C101, C103, C111, and C113 for minimum frequency response ripple and flat response. Gain should be a minimum of 15dB with maximum variation less than 0.5dB over the frequency range 470MHz through 860MHz (**Note:** output will then be about +33dBm or 2 Watts for an input of +18dBm, so make sure you properly protect your test equipment).

MXI501U OPERATIONS AND MAINTENANCE

- If roll off at the higher frequencies prevents meeting this gain-bandwidth specification, it may be necessary to replace either C103 or C113 or both with a higher value; use variable capacitor made by Johanson, part # 16E2320-2, which is 2.5 to 10pF.

5.1.3 Driver Pallet, 21B1639, Bench Test Procedure

- **BIAS SETTING:** Connect a 50-Ohm load to the output of the pallet.
 - Before applying +50V to the module, adjust R12 fully clockwise. Limit the power supply current to 3.0A.
 - Apply +50V to the B+ terminal. Monitor the current and adjust R12 counter clockwise (CCW) for a total current of about **2.0A ± 0.1A**.
 - Still monitoring the current, adjust R11 for the current to be at minimum, i.e. current dipping at 1.9A. This procedure balances the current drawn by the devices, therefore, R11 should not be adjusted again unless one or both transistors are replaced. Any bias adjustment required from here on should be done using the overall bias adjustment, R12.
 - Readjust R12 to 2.0A. This setting is an initial bias setting and may vary depending on the pallet's application. On analog transmitters, this adjustment is used to optimized the inter-modulation products as well as the system linearity.
 - Proceed to the next step if a network analyzer or similar equipment is available.
- **RF SWEEP:** Adjust C7 for best frequency response. With the bias set at 2.0A, the gain in the frequency range of 470MHz to 860MHz should be 14 to 16dB.

5.1.4 PA Pallet 11A2142G1 Bench Test Procedure

- **BIAS SETTING:** Connect a 50-Ohm load to the output of the pallet.
 - Before applying +50V to the module, adjust R11 fully counter-clockwise. Limit the power supply current to 3.0A.
 - Apply +50V to the B+ terminal. Monitor the current and adjust R11 clockwise (CW) for a total current of 2.0A + or – 0.2A.
 - Proceed to the next step if a network analyzer or similar equipment is available.
- **RF SWEEP:** Adjust C4 for best frequency response. The gain, in the range of 470MHz to 860MHz, should be between 15 to 16dB.

5.2 BASIC TROUBLESHOOTING TECHNIQUES

One of the best tools in troubleshooting is knowing what the nominal figures or typical values of the MXi amplifier when it is at its normal performance. If a fault condition occurs, then you can compare the data taken previously with the present conditions and come up with a reasonable conclusion about what is at fault.

The following describes some fault conditions and possible solutions.

5.2.1 No RF Output

- Check for proper power supply voltage and current
- Check for the presence of video signal to the modulator
- Ensure the modulator IF carrier switches are ON.
- Check for potential connector problems causing either no drive to a module pallet (input connector) or VSWR (output connector) problems.
- Check the fuses on the driver stages.

5.2.2 Output Reduced to 56%

If the output is approximately 56%, a possible cause is a total loss of a pallet from the amplifiers. The MXi501 transmitter utilizes a 4-port 3dB quadrature hybrid combiner to combine the power of the four pallets on the amplifier. For example if the amplifier pallet on input J1 produced no RF power, then half of the power at input J2 is directed into reject load R1. This occurs because 3dB hybrid coupler HY1 has only a single input and now acts as a splitter. As a result of the reduced power at the output of HY1, some power will also be dissipated in R3. A measurement of the current drawn by the amplifier will determine if this condition exists.

MXI501U OPERATIONS AND MAINTENANCE

6 MAINTENANCE

Equipment which is regularly and carefully maintained is far less likely to be subject to sudden failure than that which is operated without regard to basic maintenance requirements. A detailed preventive maintenance program should be established to ensure that the original efficiency and picture quality is maintained throughout the life of the equipment. Given reasonable care and attention, the transmitter will provide efficient and reliable service for many years.

Preventive maintenance techniques do not necessarily involve extensive dismantling of the various assemblies; on the contrary, this practice is to be discouraged unless a valid reason exists for doing so. Preventive maintenance is more directed at detailed physical inspection and the general observation of the equipment during and after operation, to detect the presence of any abnormality, which, if not corrected, might result in operational failure.

In preparing any maintenance program, the frequency and scope of the inspections must be determined and to a great degree will be influenced by site location and the station's market parameters and consequently its hours of operation, equipment configuration, and technical personnel deployment. For example, is the station on the air for 24 hours-a-day? Are there main/standby transmitters and are they attended or unattended?

In general, the following routines should form the basis of any maintenance program.

6.1 DAILY

At an attended site, the operator is afforded the opportunity to make frequent checks on the equipment and thereby increase his/her familiarity with its operation. The transmitter log entries made during these checks would include all meter readings, also any irregularity in performance or in picture quality, for later analysis. An unattended site where equipment is operated by remote control and monitored by telemetry and a high quality off-air receiver or demodulator can also be continuously checked for performance by studio technical personnel.

6.2 MONTHLY

In addition to the normal operational tests, thorough physical inspection of every piece of equipment should be made, with all power turned off. All surfaces should be dusted off or wiped down, terminal boards checked for loose connections, and all components examined for any evidence of overheating. Air filter media should be inspected and replaced if necessary. High-pressure air, not over 20psi, can be used with discretion to dislodge dust from inaccessible places.

6.3 SEMI-ANNUALLY AND ANNUALLY

Check all external RF connections for tightness, looking specifically for any discoloration, which might indicate a loose inner connector, flange or sleeve coupling. Test the passive RF system with a transmission test set or network analyzer, if one is available, to identify any potential problems with the antenna or line. Inspect and clean contacts on all switches and contactors; carefully redress contact surfaces if pitted.

Check the operation of all interlocks including patch panel, dummy load, air and thermal switches and emergency interlocks (if applicable).

6.4 TRANSMITTER COOLING SYSTEM

All cooling fans in the transmitter are fitted with sealed bearings requiring no lubrication during the lifetime of the motor. Access to the fan assembly is via the bottom of the transmitter.

7 SERVICE

The MXi contains few user-serviceable parts; the modular surface-mount design makes module replacement and/or factory repair the most efficient repair method.

The service most likely to be performed by users is the replacement of the fan array.

7.1 REMOVING THE FAN ARRAY

The MXi fan array consists of four 4" muffin-type fans which are attached to the mounting plate. The mounting plate is secured to the bottom of the MXi chassis with five Phillips head screws.

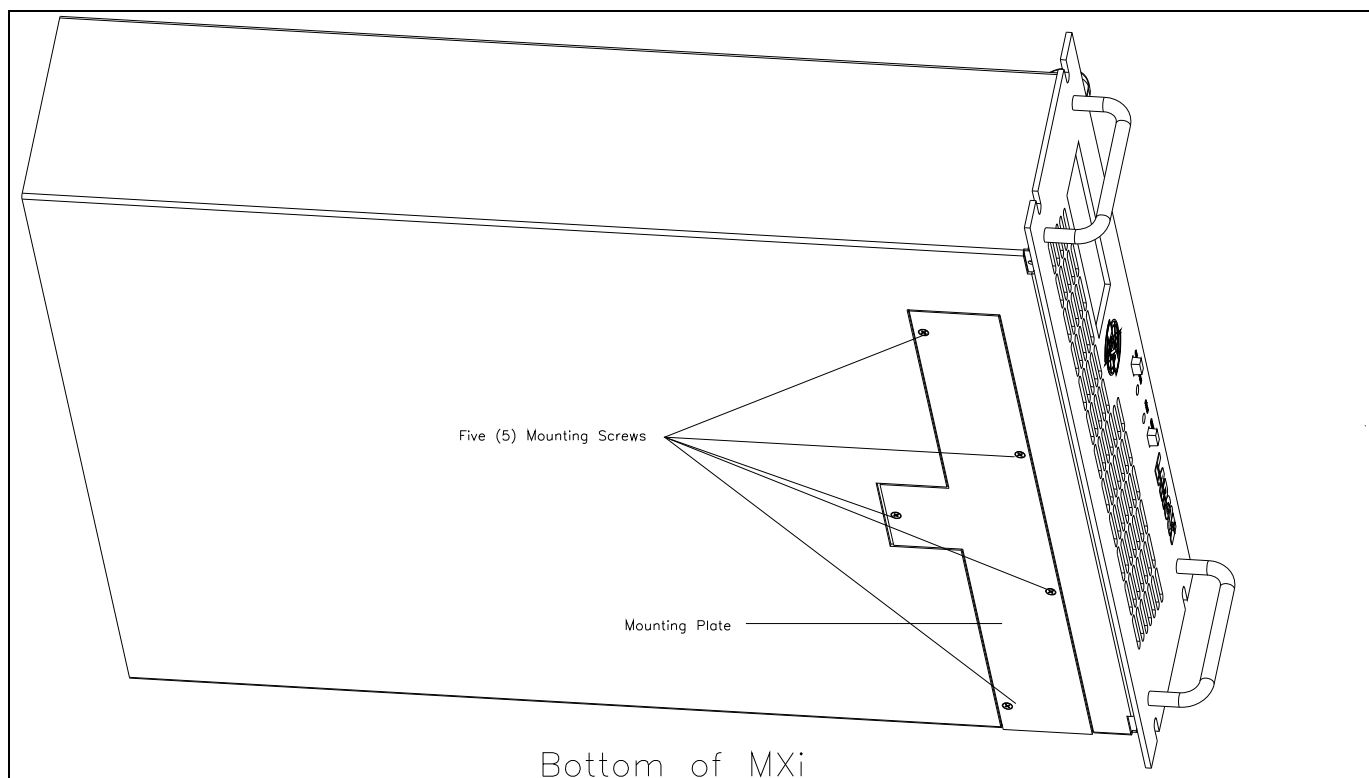


Figure 12 Bottom View of MXi

1. Turn the MXi OFF.
2. Disconnect the AC power from the MXi.
3. Slide the MXi partially out from the mounting rack. **Important:** Ensure that the weight of the MXi is fully supported.
4. With a Phillips screwdriver, remove the five mounting screws on the underside of the MXi. When removing the last screw, be sure to hold the mounting plate in place.
5. Remove the mounting plate. The fan array is attached to the mounting plate and comes out with the plate.



Figure 13 Fan Array

MXi501U OPERATIONS AND MAINTENANCE

7.2 REPLACING THE ENTIRE FAN ARRAY

In the event of a fan failure, LARCAN recommends replacing the entire array, as all fans have a similar lifespan.

1. Remove the fan array as described in Section 7.1.
2. Slide the new fan array into the MXi. The power connection is aligned so that it connects when the mounting plate is fully in place.
3. Insert and tighten the five mounting screws. **Note:** Screws only need to be snug; do not overtighten.

7.3 REPLACING A SINGLE FAN

1. Remove the fan array as described in Section 7.1.
2. Each of the four fans is attached to the mounting plate via two screw-and-nut assemblies. Remove the screws and nuts and set aside.

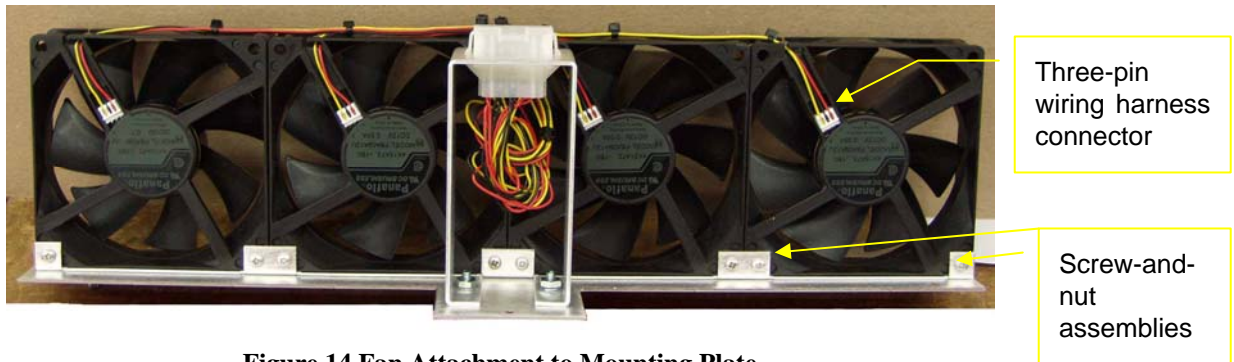


Figure 14 Fan Attachment to Mounting Plate

3. Disconnect the three-pin wiring harness connection by *gently* sliding it back with a fingernail or small plastic tool.
4. If necessary, carefully cut and remove the zip tie holding the wires to the fan frame.
5. Remove the defective fan and replace with a known good fan of *exactly* the same dimensions and specifications.
6. Re-connect the three-pin wiring harness connection.
7. Re-fasten the two screw-and-nut assemblies holding the fan to the mounting plate.
8. If necessary, replace the zip tie holding the wires to the fan frame.
9. Replace fan array into MXi as described in Section 7.1.

MXi501U OPERATIONS AND MAINTENANCE

9 SPECIFICATIONS

Specifications are subject to change without notice.

9.1 ELECTRICAL

AC Line Input 190 to 264VAC, 50 to 60Hz
Power Consumption, black picture + 10% aural 4000VA (typical)

9.2 ENVIRONMENTAL

Ambient Temperature 0°C to +45°C (0°F to 113°F)
Humidity 0% to 90%
Altitude 2286 m (7500 ft)

9.3 COOLING

Four 4" muffin fans per amplifier push air through the heatsinks and through the rear panel perforations.

9.4 DIMENSIONS

The Amplifiers, Power Supply, IF Modulator, and Up-converter chassis are standard 19" rack wide units.

Height

Amplifiers and Power Supply..... 10.5" (6RU)
Modulator..... 1.75" (1RU)
Total Height 14" (8RU)

Depth is 31" to the back of the 2-way combiner.

9.5 SHIPPING WEIGHT

Weight

Amplifier Approximately 17kg (37lbs)
Power Supply Approximately 18kg (40lbs)
Total Weight Approximately 35kg (77lbs)

MXi501U AMPLIFIER CHASSIS

CONTENTS

1	MXi501U AMPLIFIER	1
----------	--------------------------------	----------

FIGURES

FIGURE 1	FRONT VIEW OF MXi501U AMPLIFIER	1
FIGURE 2	REAR VIEW OF MXi501U AMPLIFIER	1
FIGURE 3	MXi FAN ARRAY	2
FIGURE 4	MXi AMPLIFIER INTERIOR	2
FIGURE 5	41D2168 MXi501U/1002U AMPLIFIER WIRING SCHEMATIC SHT1 REV 0.....	3

MXi501U AMPLIFIER CHASSIS

1 MXi501U AMPLIFIER

The MXi501U Amplifier Chassis Assembly 41D2101G1 consists of a standard 19" rack mountable 5.25" (3RU) enclosure containing the amplifier heatsink assembly, a fan array assembly consisting of four DC cooling fans, a controller board with built-in RF detectors, and a front panel consisting of ON/OFF, RESET switches and an LCD/Touchpad, and a rear panel assembly with connectors for interfacing to external equipment. Figure 1 is a front view of the MXi501U amplifier, showing the LCD Touchpad, ON/OFF switch, Status PWR (Green) and FAULT (Red) LEDs, and RESET switch.



Figure 1 Front View of MXi501U Amplifier



Figure 2 Rear View of MXi501U Amplifier

The rear of the MXi501U AMPLIFIER has the following connectors (from left to right):

- RS232 SERIAL nine-pin connector
- REMOTE CONTROL 15-pin D-shell connector
- RF IN SMA connector
- INTERLOCK terminal board
- RF TP SMA connector – RF sample
- RF OUT N connector
- 12V 6-pin connector
- 28V 4-pin connector

The MXi501U is classified as a broadband amplifier, thus it is operational to cover the entire UHF television spectrum ranging in frequencies from 470MHz to 860MHz.

Controlled DC power to the amplifier assembly comes from the high efficiency switching power supply via a 50V four-pin connector. Regulated DC of 50V from the switching power supply is the B+ voltage to the amplifier

MXi501U AMPLIFIER CHASSIS

heatsink assembly. The second auxiliary output of the power supply is +12VDC, which is used for powering the controller and the cooling fans.

The heatsink cooling fans are the +12VDC, 4-inch muffin model. Typically, they come ON at the same time B+ is applied to the power amplifier. The voltage is supplied to the amplifier from the 12V six-pin connector on the rear panel and it is connected to the controller PC board connector, J8. As built, the cooling fans push air from the front panel through the heatsink and through the perforations in the rear panel. This assembly is located underneath the MXi Controller board.



Figure 3 MXi Fan Array

A thermal switch is mounted on the heatsink where the operating temperature is sensed. If this temperature increases beyond the trip point of the thermal switch, which is about 76°C, its contact opens and breaks the interlocking circuit of the MXi amplifier. The interlock circuit ultimately controls the power supply to the power amplifier and therefore shuts down and remains OFF until the heatsink cools down to about 60°C.



Figure 4 MXi Amplifier Interior

An external directional coupler is mounted at the rear of the heatsink to the output connector and provides forward and reflected RF signals to the controller. These RF samples are detected and processed on the MXi controller to provide DC outputs corresponding to these signals. They are then used for AGC, VSWR supervision.

The chassis is wired according to the functional diagram 41D2168 as shown in Figure 5.

MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

CONTENTS

1 POWER AMPLIFIER HEATSINK ASSEMBLY 40D2104G1.....1

2 FRONT END MODULE ASSEMBLY 21B1473G1.....2

3 IPA MODULE 21B1951G1.....3

4 DRIVER MODULE 21B1639G15

5 PA PALLET ASSEMBLY 11A2142G16

6 FOUR-WAY SPLITTER 21B2425G1.....7

7 FOUR-WAY COMBINER 21B2426G1.....8

FIGURES

FIGURE 1 MXI SUB-ASSEMBLIES 1

FIGURE 2 FRONT END MODULE 2

FIGURE 3 IPA MODULE 3

FIGURE 4 DRIVER MODULE 5

FIGURE 5 PA PALLET ASSEMBLY 6

FIGURE 6 FOUR WAY SPLITTER 7

FIGURE 7 FOUR WAY COMBINER 8

FIGURE 8 MXI AMPLIFIER REAR PANEL 11

FIGURE 9 21B1473 MXI FRONT END UHF DTV DRIVER ASSEMBLY SHT1 REV 5.1 12

FIGURE 10 11A1354 MXI FRONT END UHF DTV DRIVER SCHEMATIC SHT1 REV 2.1..... 13

FIGURE 11 21B1950A1 IPA FINAL ASSEMBLY SHT1 REV 2 14

FIGURE 12 21B1950S1 IPA SCHEMATIC DIAGRAM SHT1 REV 0.1 15

FIGURE 13 21B1639S DRIVER PALLET SCHEMATIC SHT1 REV 5 16

FIGURE 14 11A2142A1S PALLET CIRCUIT SCHEMATIC SHT1 REV 3 17

FIGURE 15 21B2425A1 4 WAY SPLITTER ASSEMBLY SHT1 REV 0 18

FIGURE 16 21B2425S1 4 WAY SPLITTER SCHEMATIC SHT1 REV 0 19

FIGURE 17 21B2426A1 4 WAY COMBINER ASSEMBLY SHT1 REV 2 20

FIGURE 18 21B2426S1 4 WAY COMBINER SCHEMATIC SHT1 REV 2 21

MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

1 POWER AMPLIFIER HEATSINK ASSEMBLY 40D2104G1

The MXi Power Amplifier Heatsink Assembly 40D2104G1 consists of a fan-cooled heatsink and nine printed circuit board sub-assemblies. The first module is a pre-amplifier, known as the Front-End Module, then the Intermediate Power Amplifier, IPA. These first two stages are Class A amplifiers. Next is the Driver pallet, which is biased so as to pre-correct for the non-linearity in the final amplifier stage. The next stage is the four way splitter that splits the RF power so it can be fed to the PA pallets. The final amplifier stage is the PA pallets, which are capable of delivering over 125W Analog power each. The last sub-assembly on the heatsink is the four way combiner which combines the output power from the PA pallets. Also mounted on the heatsink is a thermal switch, which protects the amplifiers from over-temperature conditions such as the absent of cooling or amplifier over dissipation. This heatsink assembly is mounted in the Amplifier Chassis Assembly 41D2101G1. Descriptions of each stage are detailed in the following pages.

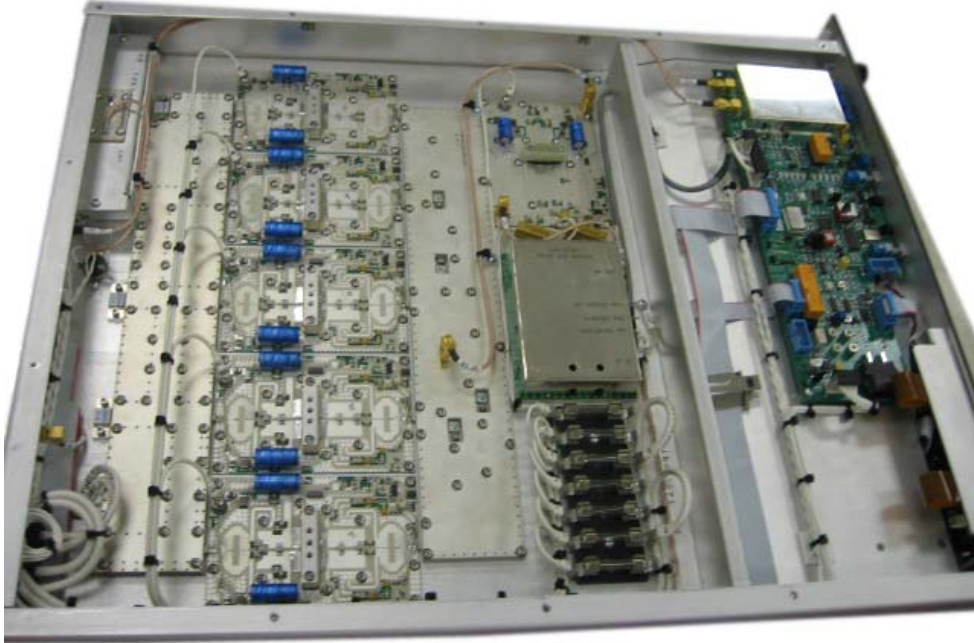


Figure 1 MXi Sub-Assemblies

The above picture illustrates the arrangement of the sub-assemblies on the amplifier heatsink assembly. From right to left are the Front-End, IPA and Driver modules. Centered and towards the back are the Splitter, PA modules and the Combiner. Strategically installed on the heatsink, is a thermal switch which protects the amplifier from over temperature conditions.

Cooling for the heatsink is provided by a fan array assembly consisting of four 4-inch axial flow +12VDC muffin fans. This array is situated near the front section of the MXi housing underneath the MXi Amplifier Controller PC board. The fans blow air into the finned portion of the heatsink, which exhausts through the rear.

2 FRONT END MODULE ASSEMBLY 21B1473G1

The front end module performs several distinctive functions. Firstly, it serves as a pre-amplifier, which boosts the signal from the up-converter by approximately 9dB. This module also contains a phase shift circuit and a variable attenuator; both adjustments are available and set to maximum and do not need to be adjusted in the MXi amplifier. These circuits are only used for adjusting phase and gain balance between two paralleled amplifiers.



Figure 2 Front End Module

The RF signal is fed to the amplifier through hybrid HY1 and attenuator P-AT1. Refer to Figure 10.

HY1, along with associated components CR1, CR2, C1 through C6, R1, R2 and RV1 act as a phase shifter. P-AT1 is a variable attenuator. The attenuation is controlled by RV2. Typically, RV2 is adjusted for minimum attenuation (fully clockwise) during the bench testing of the module. Once this is done, RV2 is not adjusted again.

U1 is a hybrid linear amplifier with a nominal gain of 17.5dB. The typical operating point of the amplifier in this application is well below the 1 Watt rating of the hybrid.

The power to the Front-End module (+50VDC) comes in at TP2.

The control voltage at TP1 comes from the AGC and VSWR cutback circuit in controller board. This voltage corresponds to the output power of the final amplifier. If the AGC circuit is enabled and the output power tries to increase, TP1 voltage increases, thus maintaining the output at the pre-set level. Similarly, if the reflected power increases past the VSWR cutback setting, TP1 increases and the output power is reduced.

The higher the voltage at TP1, the higher the attenuation in the module, therefore, lower the overall output power.

RF STATUS (TP3) and as mentioned above the PHASING control (RV1) and GAIN control (RV2) are other features of this module which are not applicable to this amplifier.

3 IPA MODULE 21B1951G1

The Intermediate Amplifier 21B1951G1 consists of two FET amplifiers, type MRF181, paralleled in RF phase quadrature and operated in Class A. Amplifier static bias control and over-current protection is provided by an industry-standard type μ A723 regulator IC, U1. The overall gain of the pre-amplifier is a nominal 15dB over the UHF band. Refer to Figure 12.



Figure 3 IPA Module

The input signal is split evenly by quadrature hybrid splitter HY1. Each FET gate is matched with the equivalent of an L network followed by a π network. Capacitors C100 and C110 provide DC blocking of the gate voltage. A couple of low impedance microstripline sections along with adjustable capacitor (C101 or C111) to ground and the gate capacitance of the FET form the L-C-L-C matching network for the input circuit. This matching arrangement is good for operation from 470 through 860MHz, adjustable capacitors C101 and/or C111 provide for a flat frequency response over the range.

The output circuit is similar except it uses narrower (higher impedance) microstriplines because the drain impedance of the FET is higher. The output-matching network is adjustable with variable capacitor C103 or C113. Again, this capacitor is adjusted only to provide flat response over the 470 to 860MHz range. An output coupling capacitor C104 or C114 completes the match to 50 ohms; two amplifier outputs are combined in a quadrature hybrid HY2.

Bias to the gates of the FETs passes through R100 or R110 from balance controls RV100 or RV110. The bias regulator UI uses an μ A723 (MC1723CD) to provide approximately 6.5 volts to the gate bias controls RV100 and RV110. Voltage divider R5, R6 provides the inverting input of the regulator error amplifier with a sample of the output voltage and the wiper of RV3 provides the non-inverting input with its reference signal, which is an adjustable fraction of the 7.15 V built-in reference of the μ A723. The adjustment of RV3 should therefore be able to give an output within the range from zero to approximately 9 volts. R4, C2, C1, R3, and C4 provide frequency-compensation and maintain regulator stability.

Drain current of the two FETs is sampled by the voltage drop across R7. When this voltage exceeds approximately 0.5V at normal operating temperature (about 1.5 amps total FET current), Q3 begins conduction and feeds voltage to pin 2 of the regulator to start its current foldback/limiter circuit. The regulator reduces its output voltage which in turn reduces the bias on the FETs; they decrease their drain currents, reducing the voltage drop across R7 and over-current protection is achieved. CR1 protects Q3 emitter-base junction from current inrush to C3 and C107 charging during start-up.

Setup is performed during initial factory testing by first setting RV110 to its maximum CCW position so that Q2 receives no bias voltage, therefore should not conduct, then setting RV3 for regulator output at U1 pin 10 to exactly $+6.5 \pm 0.2$ volts. An ammeter is connected in series with the +50V supply lead. Then RV100 is set for 500mA reading on the ammeter due to Q1 conduction. Next, RV110 is set for Q2 also 500mA so that $Q1 + Q2 =$ twice as much current = 1A.

MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

Another (final) check is made before applying RF: gate voltages at C102 and C112 are measured. With good FETs, both voltages should be approximately equal and in the range +3.5 to +5.5VDC.

Current limiting is checked by increasing the setting of RV3; the current will increase to a threshold of, and must not exceed, 1.6 amperes. RV3 is then reset to obtain the original +6.5 volts at U1-10.

When RF sweep is applied, C101, C111, C103 and C113 are adjusted for flat response over the range.

The overall gain of the Intermediate Amplifier is a nominal 15dB over the band.

4 DRIVER MODULE 21B1639G1

The design of the Driver Module 21B16391G1 is based on the device MRF374A. It is a Lateral N-channel Broadband Push-Pull Power MOSFET capable of power near 100W (rated power). However, for this application and the desired linear performance, its output to the final stage is about 5W. Refer to Figure 13.

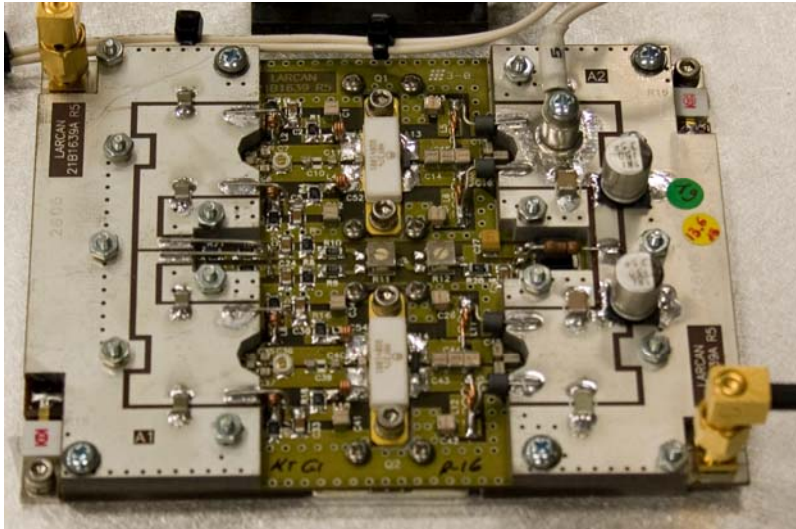


Figure 4 Driver Module

The strip-line balun developed at LARCAN is a practical implementation of the coaxial cable based solution on a broadside-coupled horizontal stripline structure. It is made up of three printed circuit boards of high dielectric material bolted together. Using this structure, very tight coupling can be achieved, thus emulating the properties of a coaxial transmission line balun. With this arrangement, the characteristic impedance and degree of coupling can be controlled through geometric dimensions. This circuit is the subject of a patent application.

Components C6 through C11 and C52, along with the associated printed circuit traces, form the matching network to the gate of the push-pull transistor Q1. L2 and R2 along with L3 and R3 are low frequency parasitic arrestors. Similarly, C14 through C15 and C53 along with associated stripline traces provide output matching on the drain of the device. C6, C8, C16 and C18 also provide DC blocking of the supply and bias voltage. C7 is factory adjusted for a flat frequency response from 470 to 860MHz.

DC power enters the module through a screw terminal connection and is fed to the main circuit board through a series of jumpers. +50VDC is fed to the drains of the FETs via L5 and L6 with bypass capacitors C13, C25, C20, C22 and C28. Bias for the devices is via L1/L4 with bypass capacitors C1, C2, C5 and C12. The bias voltage is adjusted via R12 and R11, from a regulated source provided by UI. R12 sets the overall bias and R11 provides adjustment for balance between Q1 and Q2. Thermistors R21 and R22 provide thermal stability for the bias.

5 PA PALLET ASSEMBLY 11A2142G1

Drawing reference: Figure 14

The Power Amplifier pallet is a FET amplifier assembly containing a stripline balun system. The baluns are used for impedance matching and coupling signals at the input and output of the pallet. It is a practical implementation of the coaxial-based solution on a broadside-coupled horizontal stripline structure. It is made up of two circuit boards fabricated using high dielectric constant material. Using this structure, a very tight coupling can be achieved, thus emulating the properties of a coaxial transmission line balun. With this arrangement, the characteristic impedance and degree of coupling can be controlled through geometric dimensions.



Figure 5 PA Pallet Assembly

The amplifier circuit is based on the Laterally Double-Diffused MOSFET, Q1.

Capacitors C2, C3, C4, C8 and C33 along with the associated printed circuit traces, form the matching network to the gates of Q1. C4 is factory adjusted for a flat frequency response. Similarly, C12 through C15 and C28 along with associated stripline traces provide output matching on the drain of the device. C3, C8, C14 and C15 also provide DC blocking of the supply and bias voltage.

DC power (between +28VDC and + 50 VDC, depending on the application) enters the module through a screw terminal connection. This DC voltage is fed to the drains of the device via L1 and L2 with bypass capacitors and C16 to C27. Bias for the devices is via R8 and R5 with bypass capacitors C5 to C7 and C9 to C11.

The bias circuit is located on the 11A2142 board at the input side of the pallet. It provides two functions; precision gate bias setting and external shutdown. The pallet's shutdown function is used in certain applications where the pallet is used as a driver amplifier.

The bias voltage is adjusted using R11 from a regulated source provided by U1. Thermistor R18 provides thermal stability for the bias.

The source of the bias voltage is a reference IC, U1, which has its ground reference terminal connected to the collector of Q5. Q5 is biased using R10 and R16 to provide thermal compensation.

When no Shutdown (5V) is applied at R1, the precision reference is active and provides 6.2VDC to the level adjustment circuit R21, R11 and R17. When R11 has been set to achieve 2A bias current to the pallet, a bias voltage of approximately 3.6 to 3.8VDC is applied to the gates of the FETs.

6 FOUR-WAY SPLITTER 21B2425G1

Drawing reference: Figure 15 and Figure 16

The splitter utilizes 4-port 3dB quadrature (90° phase difference) hybrid couplers that require a termination on the 4th port. The termination maintains isolation between the two output ports.

The splitter provides four equal amplitude signals to the pallet amplifier inputs with the proper phase relationship so that the combiner will provide a single output at the desired connector. Any phase and / or amplitude differences will result in increased dissipation in the combiner isolation terminations and a corresponding reduction in output power.

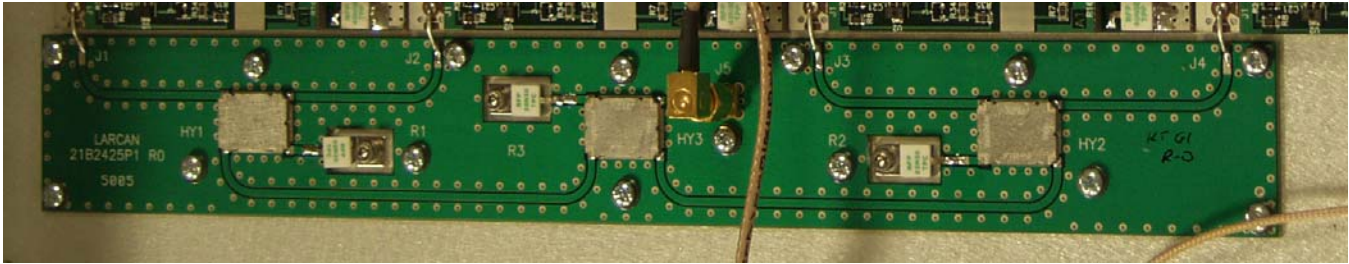


Figure 6 Four Way Splitter

The splitter assembly is constructed on a fiberglass substrate using commercially available 3dB hybrid couplers (Anaren 1F1304-3). All of the transmission lines are 'Coplanar Waveguide' type and are arranged so that all pairs of lines at the output of each hybrid coupler are identical in length to preserve the phase relationship. Direct connections are made using short lengths of bus wire soldered between the splitter outputs and each amplifier pallet input. These short connections minimize the phase errors and reflections that can occur with many cable interfaces.

RF power enters the splitter at SMA type connector J5. The signal is applied to the input port of HY3 and is split into two equal power (quadrature phase) signals. One output from HY3 is then applied to the input of HY1 and the other to HY2. The final result is four equal power signals at J1 through J4, each with appropriate phasing to match up with the four way combiner. The worst case variation in power level between the highest and lowest output is on the order of 1dB, with all other output levels approximately midway between these highest and lowest values. The operating bandwidth of the splitter is 470-860 MHz and is determined solely by the hybrid couplers.

The splitter assembly is constructed on a fiberglass substrate using coplanar waveguide 50 ohm transmission lines to connect all of the components. The width of this type of transmission line can be set at a particular width (independent of board thickness to a certain degree) so that it matches up well with the hybrid couplers. The narrow gap between the transmission lines and the ground plane helps to keep the RF field close to the board surface. However, the transmission lines are still open and will be affected by any outside influence such as fingers or tools placed near or on the lines. Please keep this in mind if probing around while the unit is operating.

The four way splitter is designed to comfortably handle 25W average power at the input. The power rating in this case is limited by the losses in the board material. Each of the hybrid couplers is rated 100W CW when provided with an adequate heatsink and the terminations are rated 20W each. These terminations provide isolation between the inputs of each pallet amplifier and would not normally be subject to any RF power. Even if the splitter was operated completely open circuited, the terminations would still be able to dissipate the full 25W of input power if necessary.

7 FOUR-WAY COMBINER 21B2426G1

Drawing reference: Figure 17 and Figure 18

The combiner utilizes 4-port 3dB quadrature (90° phase difference) hybrid couplers that require a termination on the 4th port. The termination maintains isolation between the two input ports. The combiner is wideband and covers the entire UHF television band from 470MHz to 860MHz.

The combiner is constructed using a stacked arrangement of three separate PCBs. All of the stripline traces are found on the middle PCB and each hybrid coupler is formed using broadside coupled lines on opposite sides of the middle board. The two outside PCBs support the ground planes required above and below the stripline. Cutouts are made in the upper and lower ground plane PCBs to allow access to the connection points on the middle layer. Direct connections are made using short lengths of bus wire soldered between the combiner inputs and each amplifier pallet output. These short connections minimize the phase errors and reflections that can occur with many cable interfaces.

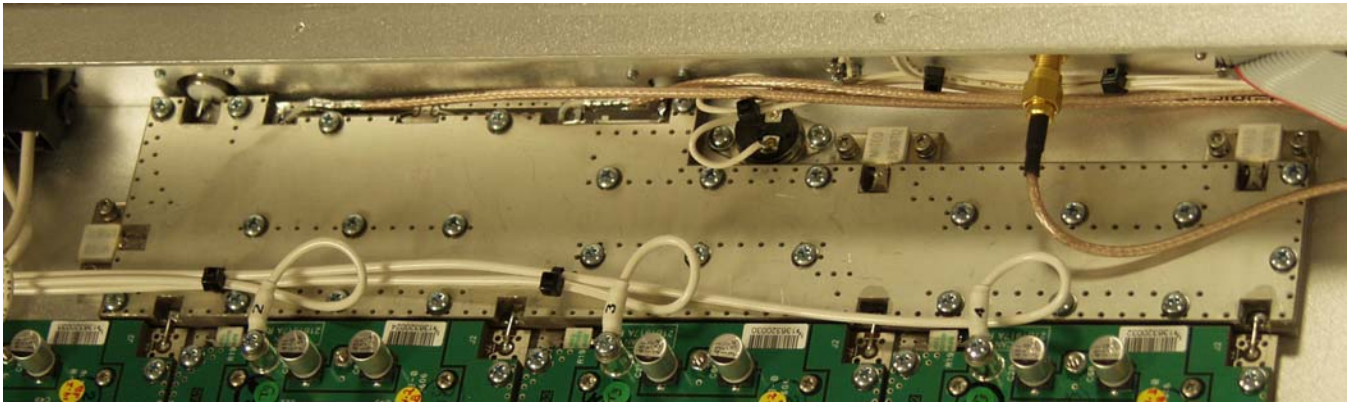


Figure 7 Four Way Combiner

In the four way combiner, the RF power arriving at the four inputs is added at two successive stages and exits the assembly on a single transmission line. In addition to combining, the assembly also provides a forward RF sample for monitoring (-58dB nominal).

The combiner is constructed using a sandwich of three separate Teflon-woven fiber PCBs. The two outside ground plane boards are 1/8" thick and the middle board is 0.020" thick for a total height of nearly 0.28" when the copper layers are added in. This type of substrate material exhibits very low RF power loss and withstands high temperatures. This combiner is designed to handle 350W of average RF power.

Transmission lines etched on the middle board are called 'Stripline' with this stacked arrangement of boards. The two outside boards are strictly ground planes and all of the RF circuitry is found on the middle board. The 3dB hybrid couplers are formed by placing two striplines opposite one another on each side of the middle board. Lines arranged in this manner are referred to as 'Broadside Coupled Lines'. Hybrid couplers of this type are fully symmetrical such that any one of the four ports may be chosen as the output (when used as a combiner) or input (when used as a splitter). The transmission lines that connect the hybrid couplers are etched on whatever side of the board is most convenient. Strictly speaking, these transmission lines are called 'Offset Striplines' because they are not fully centered between the ground planes.

When an RF signal within the proper frequency range of the 3dB hybrid coupler is applied to one port of the coupled lines (assuming all other ports are properly terminated), two equal power (within 1dB) signals appear at the two output ports. These two signals will have a 90° phase difference, with the mainline output port lagging the coupled port. The mainline is considered the line with DC connection between the input and one of the output ports. The coupled port has no DC connection to the input, but does have a DC connection to the termination resistor. When looking at the 3dB hybrid as a combiner, each of the input ports may be treated separately and viewed as a splitter. The resulting signals arriving at the output port add because they are equal in amplitude and phase while the signals arriving at the reject port cancel because they are opposite in phase.

In order for proper combining to take place, all four signals must be present, have the same amplitude, and the proper phasing. If not, then some of the power will be directed toward one or more of the reject loads, which purposely dissipate these imbalances. At this point, assume that all four inputs are present, have equal

MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

amplitudes and the proper phasing. Power at combiner input ports J1 and J2 is combined at the output of HY1 and becomes one of the input signals to HY3. The same occurs with the power entering at ports J3 and J4 – it adds at the output port of HY2 which in turn is connected to the other input port of HY3. The combined power appearing at the output of HY3 is then directed through a directional coupler before reaching the combined output port at J5.

The power handling capacity of the combiner is limited by the power rating of the balancing terminations used. These balancing terminations, or reject loads, are used to absorb power that would otherwise be reflected or directed toward other amplifier outputs. If an amplifier pallet output power is reduced, or drops to zero (in the case of DC power removal due to a blown fuse), some power from the remaining amplifiers will be dissipated in the reject loads. As an example, if the DC power were removed from the amplifier pallet on input J1, then half of the power at input J2 is directed into reject load R1. This occurs because 3dB hybrid coupler HY1 has only a single input and now acts as a splitter. As a result of the reduced power at the output of HY1, some power will also be dissipated in R3. The worst case scenario involves the complete shutdown of a pair of amplifiers with zero power entering either ports J1 and J2 or ports J3 and J4. The combined power of two of the pallets is applied to one port of HY3 and no power appears at the second input of HY3. HY3 now acts as a power splitter and directs half of the power toward the reject termination. As an example, if the RF power from each pallet is 100W, then the power applied to one input of HY3 would be 200W which would then be divided between the output and reject ports of HY3. Under these conditions, the reject load would be required to dissipate 100W. The terminations used on the combiner have an individual power rating of 250W average RF power, but we typically de-rate them by at least half in order to ensure long term reliability.

The formulas following this paragraph may be used to determine the level of reject power in any particular reject load based on the input power to that hybrid coupler.

For a single 3dB hybrid coupler:

$$P_{out} = \frac{1}{2}(P_1 + P_2) + [\sqrt{(P_1 P_2)}] \cos \theta$$

$$P_{rej} = \frac{1}{2}(P_1 + P_2) - [\sqrt{(P_1 P_2)}] \cos \theta$$

P1 and P2: power at each input port

Pout: combined output power

Prej: power dissipated in the reject load

Θ: phase error between P1 and P2 (Θ=0 assumed)

Total Output and Reject Power
in a Four Way Combiner:

$$P_{Tout} = [1 - (n/4)]^2 \times 100\%$$

$$P_{Trej} = 1/4[n - (n^2/4)] \times 100\%$$

PTout: total combined power at the combiner output port
as a percentage of the rated output power

PTrej: total power dissipated in reject loads expressed
as a percentage of the rated output power

n: number of pallet amplifiers not supplying power to the
combiner

Example: If one pallet amplifier is not supplying power, then n=1 and the power appearing at the combined output and in the reject loads is as follows:

$$P_{Tout} = [1 - (1/4)]^2 \times 100\% = 56\% \text{ (of rated output)}$$

$$P_{Trej} = 1/4[1 - (1 - (n^2/4))] \times 100\% = 19\% \text{ (of rated output)}$$

MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

It should be noted that the total power (56+19=75%) represents the input power as a percentage of the rated output power $[1-(n/4)] \times 100\%$.

The value of P_{Trej} is the total power dissipated in all of the reject loads. In order to calculate the power in a particular load, then the formula for a single 3dB hybrid coupler must be used. As an example, assume a total combined output of 300W average RF power from the combiner and 75W at each input (disregarding losses). Using the same example as above, assume that no power enters at J1. The resulting power dissipated in R1 and R3 is calculated as follows (assume ideal phasing in all cases $\cos\theta=1$): Refer to schematic drawing 21B2426S1 as a guide

$$\begin{aligned} \text{HY1: } & \text{power into J2} = 75\text{W} \quad (P1=75) \\ & \text{power into J1} = 0\text{W} \quad (P2=0) \\ & P_{out} = \frac{1}{2}(P1 + P2) + [\sqrt{(P1P2)}]\cos\theta \\ & \quad = \frac{1}{2}(75 + 0) + [[\sqrt{(75 \times 0)}]\cos\theta \\ & \quad = 37.5\text{W} \\ & P_{rej} = \frac{1}{2}(P1 + P2) - [\sqrt{(P1P2)}]\cos\theta \\ & \quad = \frac{1}{2}(75 + 0) - [\sqrt{(75 \times 0)}]\cos\theta \\ & \quad = 37.5\text{W} \end{aligned}$$

Power into J1+J2 input of HY3 = 37.5W

Power into R1 = P_{rej} = 37.5W

$$\begin{aligned} \text{HY2: } & \text{power into J3} = 75\text{W} \quad (P1=75) \\ & \text{power into J4} = 75\text{W} \quad (P2=75) \\ & P_{out} = \frac{1}{2}(P1 + P2) + [\sqrt{(P1P2)}]\cos\theta \\ & \quad = \frac{1}{2}(75 + 75) + [[\sqrt{(75 \times 75)}]\cos\theta \\ & \quad = 150\text{W} \\ & P_{rej} = \frac{1}{2}(P1 + P2) - [\sqrt{(P1P2)}]\cos\theta \\ & \quad = \frac{1}{2}(75 + 75) - [\sqrt{(75 \times 75)}]\cos\theta \\ & \quad = 0\text{W} \end{aligned}$$

Power into J3+J4 input of HY3 = 150W

Power into R2 = P_{rej} = 0W

$$\begin{aligned} \text{HY3: } & \text{power into J1+J2 input} = 37.5\text{W} \quad (P1=37.5) \\ & \text{power into J3+J4 input} = 150\text{W} \quad (P2=150\text{W}) \\ & P_{out} = \frac{1}{2}(P1 + P2) + [\sqrt{(P1P2)}]\cos\theta \\ & \quad = \frac{1}{2}(37.5 + 150) + [[\sqrt{(37.5 \times 150)}]\cos\theta \\ & \quad = 168.8\text{W} \\ & P_{rej} = \frac{1}{2}(P1 + P2) - [\sqrt{(P1P2)}]\cos\theta \\ & \quad = \frac{1}{2}(37.5 + 150) - [\sqrt{(37.5 \times 150)}]\cos\theta \\ & \quad = 18.8\text{W} \end{aligned}$$

MXi501/1002U POWER AMPLIFIER HEATSINK ASSEMBLY

Power at HY3 output = 168.8W

Power into R3 = Prej = 18.8W

As a cross check of the earlier calculations, the total output (168.8W) as a percentage of the output (300W) is indeed 56%. The total reject power (56.3W = 37.5 + 0 + 18.8) as a percentage of the rated output (300W) is also correct at 19%.

The combiner also contains a directional coupler which is constructed from edge coupled transmission lines. This is also a 4 port device similar to the 3dB couplers, except the coupling is much weaker (-40dB nominal in this case). The input and output port of the directional coupler is the main output 50Ω transmission line, while the other two ports are the ends of the coupled line. The coupled line is simply a second 50Ω transmission line laying parallel and spaced some distance away from the main line. The coupled port closest to the amplifier output connector is terminated by a 51Ω resistor and the other coupled port is directly connected to the centre pin of the 'RF-TP' (RF Test Point) BNC connector located on the rear panel of the amplifier. The primary function of this directional coupler is to provide a low power RF sample of the forward power appearing at the amplifier combined output. The nominal coupling is given as -40dB, but the coupling does vary with frequency from about -43dB at 470MHz to about -38dB at 860MHz.

This is the second RF connector (BNC) from the right side of the rear panel shown below.

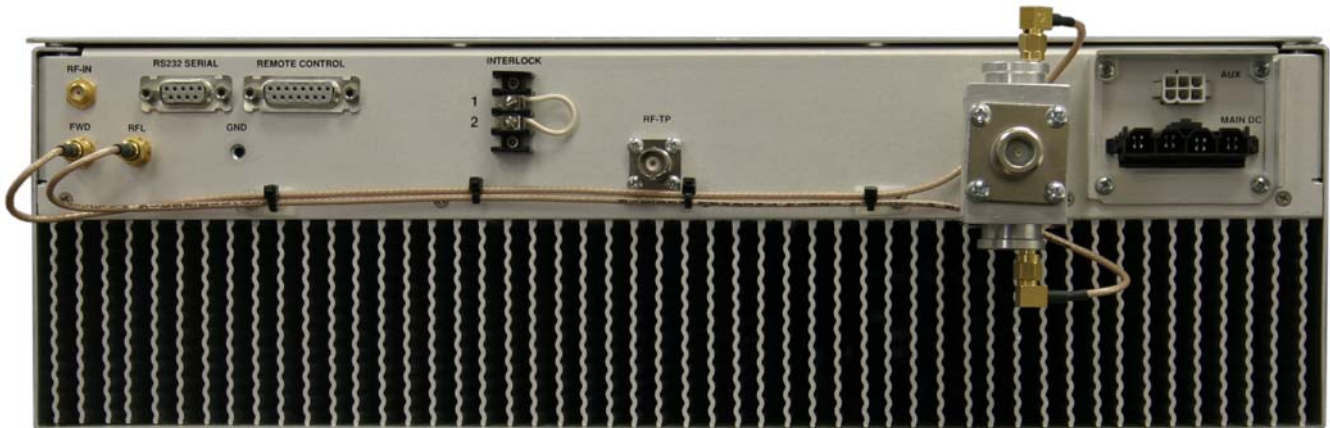


Figure 8 MXi Amplifier Rear Panel

MXi501/1002U POWER SUPPLY

CONTENTS

1	MXi501/1002U POWER SUPPLY	1
---	---------------------------------	---

FIGURES

FIGURE 1	MXi501U POWER SUPPLY	1
FIGURE 2	TERMINAL INTERFACES	1

MXi501/1002U POWER SUPPLY

1 MXi501/1002U POWER SUPPLY PFC2K-3212A-P6951

The power supply used in the MXi501U and MXi1002U UHF amplifiers is a free-standing, power factor corrected unit. It has the capability to deliver up to 62A when the power supply output is set to +50VDC. The design of this unit results in a highly efficient power supply ideal for the MXi501U power level. This unit also contains an internal auxiliary 12VDC power supply rated at 3A which is used to provide power to the MXi Controller board as well as supplying power to the cooling fans. This auxiliary power supply provides +12VDC output as long as the main AC input is present.



Figure 1 MXi501/1002U Power Supply

There are 2 terminal blocks used for connecting the AC and the Auxiliary voltage and monitoring. The Main DC power is connected to the large lugs on the right hand side of the power supply.



Figure 2 Terminal Interfaces

MXi501/1002U POWER SUPPLY

TB1 TERMINAL/DESCRIPTION

1. GND
2. PH
3. N

FUNCTION

- AC GND
AC Phase (Line)
AC Neutral

TB2 TERMINAL/DESCRIPTION

1. -12VDC OUTPUT
2. +12VDC OUTPUT
3. POWER GOOD
4. +12V ENABLE INPUT

FUNCTION

- (-) return of the 12V power supply
+12VDC for powering the MXi controller
A High (+12V) is measured here if the +50V power supply is OK
If +12V is applied here, it will turn ON the +50VDC power supply.
This enable signal comes from the MXi controller board provided the interlocks are closed and there are no fault conditions.

32V TERMINAL/DESCRIPTION

1. +32VDC OUTPUT
2. -32VDC OUTPUT

FUNCTION

- +50VDC output of the power supply
(-) return of the 50V power supply

MXi501U POWER SUPPLY CHASSIS

CONTENTS

1	MXi501U POWER SUPPLY CHASSIS	1
2	CURRENT SENSOR BOARD 11A2226G1.....	3

FIGURES

FIGURE 1	FRONT VIEW OF MXi501U POWER SUPPLY CHASSIS	1
FIGURE 2	REAR VIEW OF MXi501U POWER SUPPLY CHASSIS	1
FIGURE 3	MXi501U POWER SUPPLY CHASSIS INTERIOR.....	2
FIGURE 4	11A2226S1 MXi501 CURRENT SENSOR SCHEMATIC SHT1 REV 1	4
FIGURE 5	41D2185 MXi501 POWER SUPPLY CHASSIS WIRING SCHEMATIC SHT1 REV 0.....	5

MXi501U POWER SUPPLY CHASSIS

1 MXi501U POWER SUPPLY CHASSIS

The MXi501U Power Supply Chassis Assembly 41D2164G1 consists of a standard 19" rack mountable 5.25" (3RU) enclosure containing the power supply and current sensor board and connectors for interfacing to the MXi501 Amplifier Chassis. Figure 1 is a front view of the MXi501U power supply chassis.



Figure 1 Front View of MXi501U Power Supply Chassis



Figure 2 Rear View of MXi501U Power Supply Chassis

The rear of the MXi501U Power Supply Chassis has the following connectors:

- A 6 pin connector for 12V and main DC monitoring and control for MXi501 Amplifier
- A 4 pin connector for main DC connection to MXi501 Amplifier
- A 3 position terminal block for AC connections for the power supply (TB1)

The MXi501U power supply chassis houses a high efficiency self cooled switching power supply. The power supply provides power to the amplifier. The chassis also contains the power supply current sensor board.

The current sensor board mounted at the rear of the chassis reads the current consumption of the power supply using an onboard current sensor.

MXi501U POWER SUPPLY CHASSIS

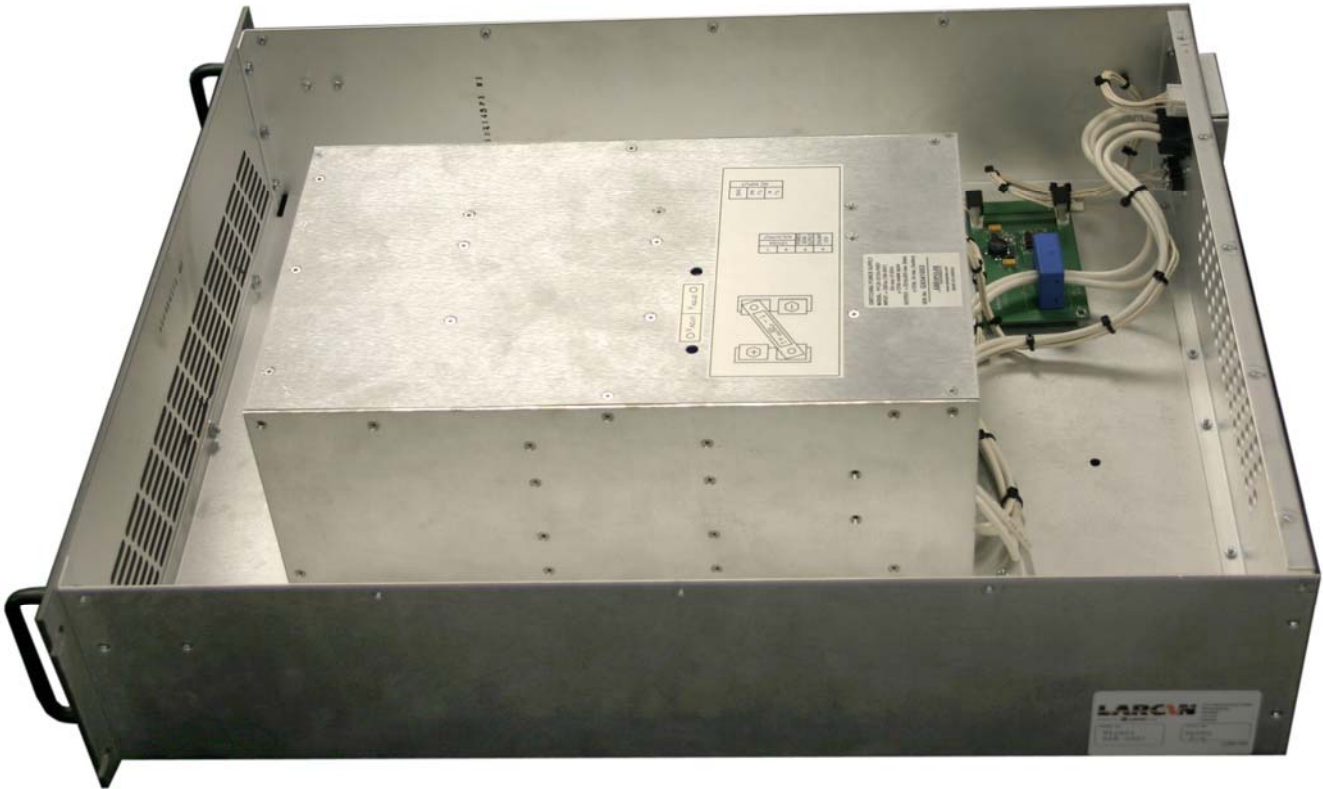


Figure 3 MXi501U Power Supply Chassis Interior

The chassis is wired according to the functional diagram 41D2185 as shown in Figure 5.

MXi501U POWER SUPPLY CHASSIS

2 CURRENT SENSOR BOARD 11A2226G1

The current sensor board has a built-in Hall Effect current sensor that is able to measure the current drawn by the RF amplifier from the +50 volt power supply. The current sensor is able to handle up to 100 amps. Figure 4 shows current sensor board schematic.

The Hall Effect sensor requires +12v and -12v supply voltages to maintain linearity especially at lower currents. The MXi501U only has a +12v power source input and therefore a fixed low current (about 250 mA) inverter is implemented by U1 to generate the required -12v supply voltage. The resulting voltage is sent to the Hall Effect Sensor, U2.

The two high current +50 volt DC wires are fed through an aperture in the Hall Effect Sensor U2 as these are routed from the power supply to the rear panel connector (and from there onto the amplifier). These high current wires do not make actual physical contact with the circuit board. The Hall Effect Sensor is effectively a current source output that is 1/2000 of the current through the aperture of the sensor. If the DC current is 40 Amps, then the sensor will generate a current of 20 mA.

The Hall Effect output current of U2 is fed through the 150 ohm resistor R4 to convert it to a voltage where the 40 Amps input current would generate 20 mA of output current resulting in a voltage across R4 of 3.0 volts. This voltage is sent into OpAmp circuit U3A.

U3A buffers this voltage and feeds it through potentiometer R3 and resistor R5. Adjustment of potentiometer R3 allows the operator to calibrate the power supply current. This calibrated voltage is buffered by OpAmp U3B which sends this voltage to test point TP1 and also to connector J2.

The current sensor board has 2 six-pin connector that have all the interface connections for the +32V power supply. Included are an ON command, P/S OK status, the +50V sample and a ground reference from the power supply. Also included on this connector is a +12V power supply output that is used to power the current sensor board itself. The ground reference is shared with that of the +50V power supply. All of these signals come in on J1 and are passed straight through to J2 in a one to one relationship. The only signal that is present on J2 that is not on J1 is the power supply current reading that is generated by the circuitry on the board.

CONTENTS

1 INTRODUCTION1

2 GENERAL OPERATIONS3

2.1 CONNECTOR AND SIGNAL DEFINITIONS.....3

2.1.1 J1 BDM (Background Debug Mode) Connection.....3

2.1.2 J2 Remote RS232 Connection.....3

2.1.3 J3 Front Panel LCD and Touchpad.....3

2.1.4 J4 +32 Volt DC Power Supply.....3

2.1.5 J5 +32 Volt DC Power Supply Sensing (External).....3

2.1.6 J6 Remote Controls.....3

2.1.7 J7 Transmitter Switch Interface.....4

2.1.8 J8 Fan Interface.....4

2.1.9 J9 External Controls.....4

2.1.10 J10 AGC Control.....4

2.1.11 J11 Aural Detector (Optional).....4

2.1.12 J12 Forward RF Sample.....4

2.1.13 J13 Reflected RF Sample.....4

2.1.14 J14 Front Panel LCD Power.....4

2.2 JUMPER OPTIONS4

2.2.1 BDM Slide Switch S2.....4

2.3 FRONT PANEL AND CONTROL INDICATORS.....7

2.3.1 Default/Normal E5= Ext E7=Out.....7

2.3.2 Manual Override E5= Int E7=Out.....7

2.3.3 Remote Override E5= Ext E7=In.....7

2.3.4 Manual and Remote Override E5= Int E7=In.....7

2.4 RF DETECTOR OPERATION8

2.5 AGC, VSWR AND CUTBACK OPERATION9

2.6 INTERLOCKS10

2.6.1 Hard Interlocks.....10

2.6.2 Soft Interlocks.....11

2.7 EXTERNAL SIGNALS AND REMOTE CONTROL11

2.7.1 External #1 Interlock.....11

2.7.2 Remote Controls (Individual).....12

2.7.3 Remote Interface (Serial).....12

2.7.4 Transmitter Switching Interface.....12

2.7.5 External DC Power Supply.....12

3 LCD GUI INTERFACE AND TOUCHPAD.....13

3.1 MAIN SCREEN AND TOUCHPAD OPERATIONS13

3.1.1 REM.....14

3.1.2 AGC.....14

3.1.3 ERR.....14

3.1.4 LOG.....14

3.1.5 AMP.....15

3.1.6 P/S.....15

3.1.7 INTK.....15

3.1.8 GEN.....15

3.2 AMPLIFIER SCREEN15

3.2.1 TRIP.....17

3.2.2 L/O.....17

3.2.3 RF.....17

3.2.4 INTK.....17

3.2.5 PSOK.....17

3.2.6 FANI.....17

MXi AMPLIFIER CONTROLLER BOARD REV.2

3.2.7	FAN2.....	18
3.2.8	FAN3.....	18
3.3	POWER SUPPLY SCREEN	18
3.3.1	OK STAT.....	19
3.3.2	PS ON.....	19
3.3.3	INTK.....	19
3.3.4	FAN.....	19
3.4	INTERLOCKS SCREEN.....	19
3.4.1	TRIP.....	20
3.4.2	L/O.....	21
3.4.3	TEMP.....	21
3.4.4	PSOK.....	21
3.4.5	VOR.....	21
3.4.6	CUTB.....	21
3.4.7	FANS.....	21
3.5	REMOTE CONTROLS AND RS232 SERIAL SCREEN.....	22
3.5.1	Remote	23
3.5.2	NewFmt.....	23
3.5.3	ExtCmd	23
3.5.4	SerCmd	23
3.5.5	Error	24
3.5.6	Logs Screen.....	24
3.6	GENERAL SCREEN	25
4	SETUP PROCEDURES	27
4.1	RF DETECTOR	27
4.2	AGC AND CUTBACK PROTECTION.....	29
4.2.1	AGC Setup.....	29
4.2.2	Cutback Setup.....	29
4.3	VSWR PROTECTION.....	29
4.4	REMOTE CONTROL INTERFACE BAUD	30
4.5	POWER SUPPLY VOLTAGE AND CURRENT CALIBRATION.....	31
5	REMOTE CONTROL CONNECTIONS MXi TRANSMITTER.....	32
5.1	REMOTE CONTROLS.....	32
5.1.1	RC_TX_On Remote Transmitter ON Control.....	33
5.1.2	RC_TX_Off Remote Transmitter OFF Control.....	33
5.1.3	RC_TX_VOR Remote Transmitter VOR Control.....	34
5.1.4	RC_RESET Remote RESET Control.....	34
5.2	EXT1 SECONDARY EXTERNAL #1 INTERLOCK.....	34
5.2.1	Status Outputs.....	35
5.3	TELEMETRY OUTPUTS	35
6	CIRCUIT DESCRIPTIONS	37
6.1	MC68HC908 MICROPROCESSOR.....	37
6.2	POWER SUPPLY VOLTAGE AND CURRENT MONITORING	38
6.3	ON/OFF RELAY K1.....	40
6.4	AGC, CUTBACK AND VSWR.....	40
6.5	SPI UART.....	41
6.6	SPI NVPOT	42
6.7	RF DETECTOR	42
6.7.1	Circuit Description	42
6.8	J12 CHANNEL – VISUAL FORWARD	42
6.9	J13 CHANNEL – REFLECTED	43
6.10	J12 CHANNEL – AURAL FORWARD	44
7	ADDENDUMS	45

MXi AMPLIFIER CONTROLLER BOARD REV.2

7.1	ADDENDUM 1– CDS51405 DISPLAY CONTROLLER.....	46
7.2	ADDENDUM 2–DUAL DIGITAL POTENTIOMETER WITH EEPROM	49
7.3	ADDENDUM 3–SPI/MICROWIRE-COMPATIBLE UART AND +/-15kV ESD-PROTECTED RS-232 TRANSCEIVERS WITH INTERNAL CAPACITORS	52
7.4	ADDENDUM 4–MC68HC908GTXX DATA SHEET	55
7.5	ADDENDUM 5– CURRENT TRANSDUCER HXS 20-NP	62

FIGURES

FIGURE 1	MXI CONTROLLER.....	1
FIGURE 2	MXI FRONT PANEL	1
FIGURE 3	MAIN MENU SCREEN	2
FIGURE 4	AMPLIFIER (AMP) SUBMENU	2
FIGURE 5	POWER SUPPLY (P/S) SUBMENU SCREEN	2
FIGURE 6	AMPS SUBMENU SCREEN	9
FIGURE 7	SAMPLE POWER-UP SCREEN	13
FIGURE 8	MAIN MENU SCREEN	13
FIGURE 9	AMPS SUBMENU.....	16
FIGURE 10	POWER SUPPLY SUBMENU SCREEN.....	18
FIGURE 11	TRANSMITTER ON, INTERLOCKS OK SCREEN	20
FIGURE 12	TRANSMITTER ON, INTERLOCKS BAD SCREEN.....	20
FIGURE 13	TRANSMITTER OFF, INTERLOCKS OK SCREEN	20
FIGURE 14	REMOTE CONTROL SUBMENU	22
FIGURE 15	LOGS SUBMENU SCREEN.....	25
FIGURE 16	GENERAL SUBMENU SCREEN	26
FIGURE 17	AMPS SUBMENU SCREEN	29
FIGURE 18	REMOTE CONTROL SUBMENU SCREEN.....	30
FIGURE 19	POWER SUPPLY SUBMENU SCREEN.....	31
FIGURE 20	TX_OFF, RESET, AND VOR REMOTE CONTROLS	32
FIGURE 21	TX_ON REMOTE CONTROL	32
FIGURE 22	STATUS OUTPUTS.....	35
FIGURE 23	MXI CONTROLLER BOARD ASSEMBLY DIAGRAM 31C1897A2 SHT1 REV 2.2	65
FIGURE 24	MXI CONTROLLER BOARD SCHEMATIC 31C1897S1 SHT1 REV 2.3	66
FIGURE 25	MXI CONTROLLER BOARD SCHEMATIC 31C1897S2 SHT2 REV 2.3	67
FIGURE 26	MXI CONTROLLER BOARD SCHEMATIC 31C1897S3 SHT3 REV 2.3	68
FIGURE 27	MXI CONTROLLER BOARD SCHEMATIC 31C1897S4 SHT4 REV 2.3	69
FIGURE 28	MXI CONTROLLER BOARD SCHEMATIC 31C1897S5 SHT5 REV 2.3	70

MXi AMPLIFIER CONTROLLER BOARD REV.2

1 INTRODUCTION

This manual describes revision 2.0 or higher of the circuit board.

The MXi control board (Assembly 31C1897) is a single-circuit assembly that provides all of the control functions required for the MXi series of transmitters on a single circuit board. This board can be configured for a number of different transmitter types, power levels, transmission standards and options.



Figure 1 MXi Controller

The MXi control board provides local front panel interface via ON/OFF and RESET buttons as well as a graphical user interface through a front panel LCD assembly with touchpad for user commands. The board implements controls/status/telemetries for remote control through a rear panel connector that will interface to a typical remote control system (such as Moseley or Gentner). An RS232 serial port is also provided to allow the operator to access the MXi through an external computer (with the appropriate software). The MXi control board has RF detectors for forward and reflected power and all the circuitry to support AGC/VSWR/Cutback functions. Circuitry to control and monitor the +32V power supply is also included on this board.



Figure 2 MXi Front Panel

The user interface to the amplifier is accomplished with the front panel LCD that incorporates a touchpad as an integral part of the unit. The LCD has the capability of displaying a variety of screens, which are selected by the user via the touchpad. Figure 3 shows the LCD main menu, which shows the present status of the amplifier along with the selections of submenus.

MXi AMPLIFIER CONTROLLER BOARD REV.2

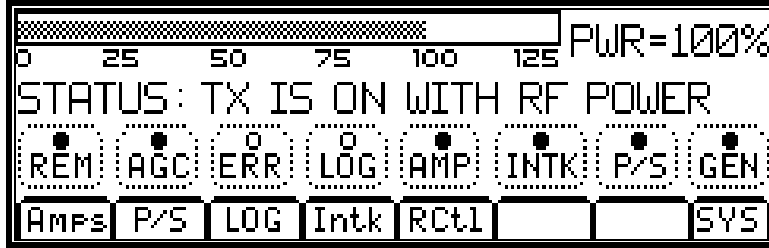


Figure 3 Main Menu Screen

Forward (FWD) and Reflected power (RFL), AURal power, AGC and CUTBack (VSWR) control voltage, as well as the heatsink TEMPerature (Optional) can be displayed by selecting the AMP submenu as shown in Figure 4.

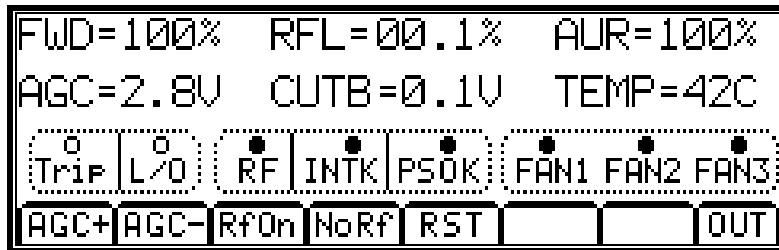


Figure 4 Amplifier (AMP) Submenu

Pressing the power supply P/S submenu from the Main Menu will display the power supply voltage and current consumption as well as its status.

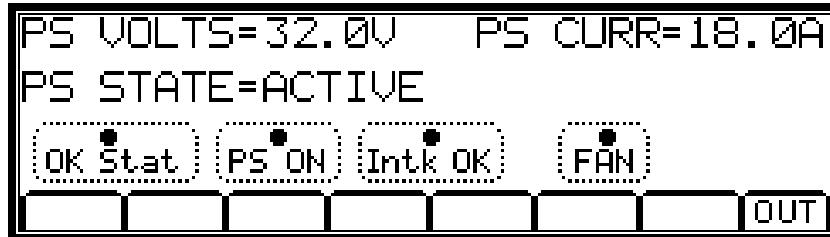


Figure 5 Power Supply (P/S) Submenu Screen

The MXi board has a BDM (Background Debug Mode) connector that allows an external computer or laptop to download the software program into the CPU chip. The CPU chip holds the program in its internal Flash memory and so there is no external chip or device that need be replaced to change/upgrade the software.

The concept of this design places all of the control and monitoring functions in one place and therefore eases the setup and maintenance functions on this series of transmitters.

2 GENERAL OPERATIONS

2.1 CONNECTOR AND SIGNAL DEFINITIONS

The connectors on the MXi control board are all shown in Figure 26, which is sheet #3 of the Schematic. The individual signals that are associated with each pin of the connector are also given. A brief description of each of the connectors on the board follows.

2.1.1 J1 BDM (Background Debug Mode) Connection

This is used by the software developer to debug the software programmed into the HC08 CPU.

The software program is also downloaded into the HC08 CPU via this connector.

The operator has no real use for this connector since it requires a special interface board.

2.1.2 J2 Remote RS232 Connection

This connector would normally have a nine-pin ribbon cable attached to route the serial signals to the rear panel nine-pin D-shell connector. Although J2 has 10 pins, only the first nine are actually used with pin 10 being left open. A typical three-wire serial port (TxD, RxD and Ground) is implemented on this connector to allow interface to an external laptop or PC.

2.1.3 J3 Front Panel LCD and Touchpad

This uses a nine-wire ribbon cable to send and receive serial data from the Front Panel LCD/Touchpad assembly. Although J3 has 10 pins, only the first nine are actually used with pin 10 being left open. This connection is a typical three-wire serial port (TxD, RxD and Ground) that communicates with the LCD/Touchpad.

2.1.4 J4 +32 Volt DC Power Supply

This is a two-pin connector used for the +32VDC power that is supplied to the RF amplifier. The +32V source is fed into one pin, run through a current sensor on the MXi board and then fed back out the second pin to the RF Amplifier. This is the manner in which the current that the +32V power supply is measured. The voltage telemetry sample from the +32V power is also taken from this connector. When an internal power supply without its own current metering is being used, this connector is functional. If an external power supply with its own current metering is being utilized, this connector is left open.

2.1.5 J5 +32 Volt DC Power Supply Sensing (External)

This uses a six-pin connector that has all the interface connections for the +32V power supply. Included is an ON command, P/S OK status and a ground reference from the power supply. In the case where an external power supply is being used with its own current metering, the +32V sample and the current telemetry is fed into this connector.

The last signal on this connector is a +12V power supply input (either from the +32V power supply or an external +12V power supply) that is used to power the MXi controller board itself. The ground reference is shared with that of the +32V power supply.

2.1.6 J6 Remote Controls

This uses a 15-wire ribbon cable to send status/telemetry and receive commands from the rear panel 15-pin D-shell connector. Although J6 has 16 pins, only the first nine are actually used with pin 16 being left open. In addition to the remote signals, there is a single set of contacts made available as an external interlock. This can connect to an external device or be used as a simple remote ON/OFF.

MXi AMPLIFIER CONTROLLER BOARD REV.2

2.1.7 J7 Transmitter Switch Interface

This uses a nine-wire ribbon cable to send status/telemetry and receive commands from the rear panel nine-pin D-shell connector. Although J7 has 10 pins, only the first nine are actually used with pin 10 being left open. This ribbon cable may not be installed if there is only a single transmitter system or if there is no transmitter switching unit included in the RF system.

2.1.8 J8 Fan Interface

This uses a special connector mounted on the bottom of the MXi controller board to connect to the fan assembly. The fan assembly normally includes up to four fans that are mounted below the MXi controller board and is inserted from the bottom of the transmitter control chassis. This connector has ON/POWER control for each of the fans along with a ground reference and a rotational status signal that comes from each of the fans.

2.1.9 J9 External Controls

This has a seven-pin connector that is used to input a variety of signals into the MXi controller. A pair of pins are used for the External interlock that is connected to a terminal block on the rear chassis (this is in parallel with the external interlock on the Remote Controls J6). There is also a thermal interlock that is sent from the RF amplifier. Provision has been made for a thermistor input to measure temperatures for testing purposes. A remote control VOR (Video Operated Relay) input (RC_VOR) is made available which is in parallel with the RC_VOR control input of the Remote Controls J6.

2.1.10 J10 AGC Control

This is a three-pin connector that sends a DC reference voltage (with ground reference and shield) to the RF preamplifier module. This DC reference is generated by the AGC circuitry on the MXi Controller to control the RF output level of the amplifier.

2.1.11 J11 Aural Detector (Optional)

This is an 11-pin connector that allows the option aural RF detector to be mounted above the normal RF detectors. This connector is located in the shielded box on the left side of the MXi Controller board and is not normally visible if the cover is installed on the shield box.

2.1.12 J12 Forward RF Sample

This SMA connector receives the forward power sample from the directional coupler that is mounted on the RF amplifier heatsink. This is used by the RF detector to monitor the level of the RF forward power.

2.1.13 J13 Reflected RF Sample

This SMA connector receives the reflected power sample from the directional coupler that is mounted on the RF amplifier heatsink. This is used by the RF detector to monitor the level of the RF reflected power.

2.1.14 J14 Front Panel LCD Power

This is a two-pin connector that sends power (+5V and ground) to the Front Panel LCD/Touchpad assembly.

2.2 JUMPER OPTIONS

2.2.1 BDM Slide Switch S2

2.2.1.1 Dip Switch S3 System Configuration

These DIP switches are reserved for factory test and system configuration. At the time of publication, they are not assigned for specific functions.

2.2.1.2. Jumper E1–Debug/Normal Mode

This jumper allows factory programming and debug of the HC08 microcontroller. This should always be in the Normal position for proper operation in the field.

2.2.1.3. Jumper E2–Remote Control Reset

This jumper allows the operator to use the remote Reset command to effect a reset of the HC08 microcontroller. This would only be installed if there were a suspicion that the microprocessor is hanging-up and the operator would intend to reset it remotely. This is purely for diagnostic purposes only and should not normally be permanently installed.

2.2.1.4. Jumper E3–Spare Line Configuration

This jumper allows the signal into the PA0 pin 32 of the HC08 microcontroller to be configured as either an input or output. This configuration would already have been done in the software at the factory and this jumper setting should not be altered in the field unless directed by LARCAN personnel.

2.2.1.5. Jumper E4–External or Internal Power Supply Current Sensing

The MXi Amplifier can be configured with a +32VDC power supply that has a built-in current sensing telemetry or, when the power supply lacks this facility, the MXi controller can measure the current from the +32VDC supply using the onboard current sensor. When the power supply has its own current sensing telemetry, jumper E4 would be set to the External position. When the power supply does not have its own current sensing telemetry, jumper E4 would be set to the Internal position allowing the controller's own current sensor to provide the telemetry. This jumper is normally set at the factory and should not be altered in the field.

2.2.1.6. Jumper E5–Front Panel ON/OFF Control Switch (System/Manual)

This jumper controls the function of the front panel ON/OFF switch. When in the Ext position, the ON/OFF command is fed through the HC08 microcontroller allowing the operator to utilize remote ON and OFF commands. When in the Int position, the ON/OFF directly controls the ON/OFF relay bypassing the microcontroller and disabling its OFF control ability.

2.2.1.7. Jumper E6–Tx Switching Interlock Enable

Facility has been designed into the controller interlock chain to allow an external interlock contact that a transmitter switching unit could use to force the amplifier into an OFF state. This would occur if the controller is moving a coax switch or if this amplifier has been removed from the antenna. When there is no transmitter switching unit installed, jumper E6 would be installed to disable this particular interlock.

2.2.1.8. Jumper E7–Manual Remote ON/OFF Control

This jumper would be installed to allow the operator to manually turn the amplifier ON or OFF via a remote command that would directly control the ON/OFF relay and bypass the HC08 microcontroller. For this mode to work properly, the front panel ON/OFF switch should be left in the OFF position. In normal operation, this jumper is not installed.

2.2.1.9. Jumper E8–Forward RF Detector, Peak or Average Power

This jumper selects whether the intermediate stage of the RF detector of the Forward power will measure Peak or Average power. When measuring digital signals, the jumper would normally be set to Average and when measuring analog signals the jumper would be set to Peak. This jumper determines the amount of RC filtering (or averaging) of the signal power by selecting which value of resistance is placed in series with capacitor C22. This jumper is set by the factory depending on the signal standard of the particular amplifier and level that is obtained from the RF coupler. This should not be changed in the field.

2.2.1.10. Jumper E9–Forward RF Detector Color Burst Trap

When installed, this jumper enables the filter that removes the color burst from the RF signal. This would only be installed on the analog transmitters, as the digital amplifier does not have a color burst.

2.2.1.11. Jumper E10–Forward RF Detector Sound Carrier Trap

When installed, this jumper enables the filter that removes the sound carrier from the RF signal. This would only be installed on the analog transmitters, as the digital amplifier does not have a sound carrier.

2.2.1.12. Jumper E11–Forward RF Detector Final Gain Control

This jumper selects either a high or low gain for the final stage of the RF detector of the Forward power. This jumper is set by the factory depending on the output power of the particular amplifier and level that is obtained from the RF coupler. This should not be changed in the field.

2.2.1.13. Jumper E12–Reflected RF Detector, Peak or Average Power

This jumper selects whether the intermediate stage of the RF detector of the Reflected power will measure Peak or Average power. When measuring digital signals, the jumper would normally be set to Average and when measuring analog signals the jumper would be set to Peak. This jumper determines the amount of RC filtering (or averaging) of the signal power by selecting which value of resistance is placed in series with capacitor C22. This jumper is set by the factory depending on the signal standard of the particular amplifier and level that is obtained from the RF coupler. This should not be changed in the field.

2.2.1.14. Jumper E13–Reflected RF Detector Color Burst Trap

When installed, this jumper enables the filter that removes the color burst from the RF signal. This would only be installed on the analog transmitters, as the digital amplifier does not have a color burst.

2.2.1.15. Jumper E14–Reflected RF Detector Sound Carrier Trap

When installed, this jumper enables the filter that removes the sound carrier from the RF signal. This would only be installed on the analog transmitters, as the digital amplifier does not have a sound carrier.

2.2.1.16. Jumper E15–Reflected RF Detector Final Gain Control

This jumper selects either a high or low gain for the final stage of the RF detector of the Reflected power. This jumper is set by the factory depending on the output power of the particular amplifier and level that is obtained from the RF coupler. This should not be changed in the field.

2.2.1.17. Jumper E16–AGC Disable Control

When installed, this jumper disables the AGC control of the transmitter and its controller. This is normally only used with setting up the maximum input drive level for the amplifier. In normal operation, this jumper should always be removed, since it can allow excessive power to be mistakenly fed through the amplifier.

2.2.1.18. Jumper E17–VSWR Disable Control

When installed, this jumper disables the VSWR trip interlock of the transmitter and its controller. This is normally only to be used with setting up the VSWR trip level for the amplifier. In normal operation, this jumper should always be removed, since it removes the VSWR protection from the amplifier. In the presence of a VSWR condition, this could result in damage to the amplifier FET devices.

2.2.1.19. Jumper E18–Manual VSWR Reset Control

When installed, this jumper allows the operator to directly reset the VSWR trip relay and effectively bypass the HC08 microcontroller. In normal operation, this jumper would not be installed.

2.2.1.20. Jumper E19– Peak or Sync Detection

This jumper allows the forward power sample to be either a Peak detection or Back Porch detection using the visual sync. The optional Aural detection piggyback board must be installed to provide the sync detection facility. For most applications (including all of the digital modulation standards), jumper E19 would be set for peak (Pk) since there is no vertical sync interval that can be locked onto for these signals. The only application where E19 is set to the Sync position is when the optional Aural Detection board is installed and Back Porch detection for the Forward power sample is desired. The purpose of using Back Porch detection is to regulate the output power more precisely, independent of APL level. This jumper is set by the factory and should not be changed in the field.

2.3 FRONT PANEL AND CONTROL INDICATORS

The MXi has a very simple set of front panel controls and indications that consists of three primary sections.

The ON/OFF pushbutton can be set up to turn the transmitter ON or OFF for local control. This button is an alternate action device that, once pressed, remains in the ON state (pressed in). If the operator presses the button a second time, it releases into the OFF state. The function of this button can be set up for a variety of operations depending on how the circuit board jumpers are configured. A brief description of the possible configurations follows.

2.3.1 Default/Normal E5= Ext E7=Out

Allows the MXi CPU to directly control all local and remote ON/OFF commands. The front panel ON/OFF command will only operate when the system is in local and the remote commands will only operate when the system is in remote.

2.3.2 Manual Override E5= Int E7=Out

Forces the MXi circuitry to always respond to the front panel ON/OFF commands. The front panel ON/OFF command is always active, so if it is left in the ON position, it will not be possible to shut OFF the transmitter remotely with the ON/OFF command. However, a remote opening of the EXT1 interlock will shut down the transmitter at all times. For proper remote operation in this condition, the operator must place the front panel ON/OFF switch in the OFF position before leaving the site. This allows the remote command to operate normally.

2.3.3 Remote Override E5= Ext E7=In

Forces the MXi circuitry to always respond to the remote ON command. The transmitter remains ON as long as the remote ON command is asserted. In this mode the remote command will always be active even if the system has been placed in LOCAL mode. The front panel ON/OFF command will not be able to shut OFF the transmitter while the remote ON/OFF command is asserted.

This is clearly an emergency type configuration and should not be used for normal operations. For proper front panel operation in this condition, the operator must remove the remote ON/OFF command or disconnect the remote connector to achieve local controls again.

2.3.4 Manual and Remote Override E5= Int E7=In

This enables the overrides on both the remote and local ON/OFF commands. The MXi circuitry will turn the transmitter ON if either the Front Panel or the Remote ON command is present. These functions are independent of the transmitters REMOTE or LOCAL mode. This is clearly an emergency type configuration and should not be used for normal operations.

The green front panel LED (DS5 on the MXi board) beside the ON/OFF pushbutton indicates the current ON/OFF state of the transmitter. This LED follows the condition of the ON/OFF relay K1 and is not affected by the source of the ON/OFF command.

A second momentary front panel pushbutton is provided to reset any VSWR trips or lockout conditions. When a VSWR Lockout has occurred, the transmitter is shut down. The operator must find the source of the VSWR and, when repaired, this reset button will clear the lockout and the transmitter will automatically turn ON again. Note

MXi AMPLIFIER CONTROLLER BOARD REV.2

that a VSWR trip/Lockout does not change the ON/OFF state of the transmitter, it just opens an interlock to shut it down.

The LED beside this pushbutton shows the state of the VSWR relay K2. When there is a VSWR trip, the MXi controller resets it automatically until three trips occur in a one minute span. When a VSWR trip occurs, this LED momentarily flashes, indicating that a trip did occur but the CPU has reset the trip. If three trips do occur that result in a Lockout, this LED is on continuously and must be reset to clear it.

The MXi also provides a more detailed and graphical interface to the operator via the front panel LCD and touchpad. This device has extensive information on the operations of the transmitter and provides a number of controls to the transmitter. This device and its interface are described in Section 3.

2.4 RF DETECTOR OPERATION

The RF Detector circuitry is show in Figure 27. This circuitry can be used for internally diplexed analog transmitters or for digital transmitters.

RF Power levels are sampled by a directional coupler located on the RF amplifier heatsink and the resulting RF samples are detected and appropriately processed to provide DC outputs corresponding to the amplitude of the desired parameter of the input signal. These DC outputs contribute to the AGC/VSWR supervision of the transmitter and are also processed in analog to digital conversion circuits on the MXi controller board to provide digital metering.

The RF Detector can have different group assemblies to support the NTSC system, the PAL system and Digital transmission. NTSC and PAL application differ only in their color subcarrier frequency, consequently in a few component values. All group assemblies use the same PC Board and have many jumpers used to change circuits sensitivity, introduce/remove traps for color subcarrier and/or aural intercarrier and change envelope detector characteristics for digital and analog applications.

The schematic included in this publication shows the circuitry for NTSC and Digital transmissions. For PAL systems a separate schematic would be included that is currently not in this publication.

All jumpers are set in the factory and should not be modified in the field unless under direction from LARCAN personnel.

An optional circuit board is available for internally diplexed analog systems to monitor the aural power separated from the combined forward signal. This board is mounted on top of the existing RF detector circuitry in a piggy-back configuration. This extra board uses a sync detector to obtain the back porch (blanking level) of the RF signal and subtracts the overall RF signal level from the visual only signal level to obtain the aural output. When this extra board is installed, an added benefit is the provision of a more stable visual output level that is more independent of APL level due to the fact that the blanking level is used to determine power instead of a simple envelope detection method. Note that the standard MXi transmitter does not come with this extra board installed but it must be ordered as an option. When the option is included, an addendum to this manual will be included to cover this option.

Required signal levels are as follows:

- FWD (overall forward sample) metering requires 20dBm sync peak signal for full scale (100% rated power).
- RFL (overall reflected sample) metering requires 10dBm sync peak signal for full scale (10% rated power).

The forward RF detector can be configured for a number of different signal types as the following table shows.

MXi AMPLIFIER CONTROLLER BOARD REV.2

Note the AGC voltage from the LCD, if it is near to a value of 0 (i.e., under 0.1V), then there is no AGC action left and the power cannot be raised any further. If the amplifier power is under 100%, then check the RFL power level and CUTBACK voltage to verify that the amplifier is not reducing power to protect from a VSWR condition.

The cutback circuit checks the level of reflected power as displayed on the LCD screen above [RFL=00.1%]. If this reflected power is greater than 1%, the cutback circuit automatically reduces the amplifier forward power to protect the devices. This indicates a mild VSWR condition such as may be caused by an icy antenna. The cutback function is a safety protection and is therefore permanently in circuit and cannot (or should not) be disabled. If the VSWR condition worsens such that reflected power exceeds 10% of forward power, the MXi shuts the transmitter down.

The MXi has built-in VSWR protection to prevent damage to the amplifier from excessive power being reflected back from the output system. This VSWR protection becomes operational when reflected power exceeds 10% of forward power. The system shuts down the amplifier for a few seconds and then tries to restart again. This is done to check if the VSWR was a temporary condition that could have been caused by a lightning strike nearby. The LCD shows the TRIP status light on the third row of the LCD to indicate that a VSWR trip had occurred. If the condition persists such that three VSWR trips occur within 1 minute, the system completely shuts down. The LCD will then illuminate the L/O (Lockout) status light on the LCD to show that a Lockout has occurred.

2.6 INTERLOCKS

Interlocks on the MXi can be divided into two different types: hard interlocks that shut down the transmitter without any CPU intervention and soft interlocks that are generated by the CPU chip in response to abnormal system parameters.

2.6.1 Hard Interlocks

There are hardware interlocks that directly affect the ON/OFF relay K1 by removing the +12V arming voltage on its coil and preventing it from turning on. There are four of these interlocks as follows:

2.6.1.1. Amplifier Thermal

Heatsink thermal opens if heatsink temperature is too high. Dry Contact across Connector J9 pins 5 and 6.

2.6.1.2. Transmitter Switching

Interlock provided for an external Transmitter Switching unit to shut down the Transmitter.

Dry Contact across Connector J7 pins 1 and 2.

When there is no transmitter switching, jumper E6 defeats this interlock.

2.6.1.3. External #1

Interlock supplied for customer use such as RF system interlock or RF Load.

Dry Contact across Connector J9 pins 1 and 2.

Parallel contact provided across J6 pins 14 and 15, only one of J6 or J9 is required.

If not used, then this contact should be shorted out externally.

2.6.1.4. VSWR Relay K2

Contact from VSWR Trip relay K2 pins 11 and 13.

Contact will be closed (OK) if there is no VSWR condition.

Contact will open whenever a VSWR is detected.

Note: Jumper E17 disables this interlock, this is for setup only.

MXi AMPLIFIER CONTROLLER BOARD REV.2

2.6.2 Soft Interlocks

There are parameters that the CPU monitors and if they indicate an error condition, the CPU will issue an ON/OFF command to the ON/OFF relay and set the appropriate error flag. **Note:** if the Local or Remote ON/OFF commands are jumpered to the Override state, the CPU will be unable to shut off the amplifier via K2.

For this reason it is recommended that the ON/OFF controls are left jumpered in the normal positions unless an emergency condition exists. The software interlock parameters are as follows:

2.6.2.1. *Power Supply OK*

+32V Power Supply is indicating an error, +12V signal at J5 pin 5 means OK state.

2.6.2.2. *Power Supply Voltage*

+32V telemetry shows a voltage over +34VDC, Telemetry at J4 pin 1 and J5 pin 6.

2.6.2.3. *Power Supply Current*

Power Supply Current exceeding the max rating, value depends on MXi model.

For the internal power supply, the telemetry is found at U7 pin 7.

For an external power supply, the telemetry is found at J5 pin 5.

2.6.2.4. *Amp Temperature*

If the amplifier heatsink is configured with a thermistor. This is optional.

When the heatsink temperature rises too high, the CPU cuts back output power.

This is not a true interlock since the Thermal interlock is used to shut off the transmitter.

This power cutback tries to keep the heatsink from reaching shutoff temperature.

2.6.2.5. *Fan Failure*

The four fans are monitored for their rotational status.

When one or more fans show a failure, the CPU cuts back output power.

This is not a true interlock, as the Thermal interlock is used to shut off the transmitter.

This power cutback tries to keep the heatsink from reaching shutoff temperature.

2.7 EXTERNAL SIGNALS AND REMOTE CONTROL

There are a number of signals that are connected externally at the back panel of the MXi transmitter chassis. These can be classified as either interlocks, remote controls, external power supplies or transmitter switching.

2.7.1 External #1 Interlock

The interlock that is available on the rear panel is the External #1. This is a single dry contact that is provided to shut down the RF amplifier in the case of some external problems (such as a bad RF load). It has two possible connection points that are logically in parallel so that only one needs to be connected. One point is from pins 1 and 2 of J9 on the MXi board. This connector is normally wired to a two-pin terminal block TB1 located on the back panel. This would be the most accessible and likely connection point.

The second parallel connection is from pins 14 and 15 of J6 on the MXi board which is assigned for Remote Controls. This 16-pin connector would usually have a 15-wire ribbon cable attached that would route the signals from the first 15 pins of J6 to a 15-pin D-shell connector Jxx on the rear panel.

2.7.2 Remote Controls (Individual)

Connector J6 provides for individual lines of control/status/telemetry that would normally be connected to an external vendor remote control system (such as Moseley or Gentner). This 16-pin connector would usually have a 15-wire ribbon cable attached that would route the signals from the first 15 pins of J6 to a 15-pin D-shell connector Jxx on the rear panel. The details of the signals on this connector are given in Section 5.

2.7.3 Remote Interface (Serial)

Connector J2 provides a standard three-wire serial interface (TxD, RxD and Ground) that would normally be connected to an external computer or laptop serial port. If the operator wishes to connect a modem to this port, a null modem would be needed to swap the TxD and RxD lines. This modem would need to be auto-answer since no modem controls are provided by the MXi. The MXi sends a serial stream out this serial port that reports all of the operating parameters of the transmitter. It can also receive serial commands from an appropriate computer program.

2.7.4 Transmitter Switching Interface

Connector J7 provides for individual lines of control/status/telemetry that would normally be connected to an external transmitter switching unit. Of course, this switching unit would only be necessary if there are two (or more) MXi transmitters in the system. For a single transmitter, these signals would not be used. When configured for transmitter switching, this 10-pin connector would usually have a nine-wire ribbon cable attached that would route the signals from the first nine pins of J7 to a nine-pin D-shell connector Jxx on the rear panel. The transmitter switch interface consists of a telemetry output of the RF forward power level, a status output indicating TX failure, and interlock input used to shut down the transmitter and a few spare signals for future use. The exact use and operation of the transmitter switching unit would be documented in its own publication when implemented.

2.7.5 External DC Power Supply

Higher power MXi transmitters require that the DC power supply for the amplifier be located external to the amplifier chassis. Connector J5 receives the interface signals for this external supply. These include a +12V input that provides power to the MXi control board itself, a reference ground, a sample of the +32VDC that is used to power the amplifier, and current telemetry sample and a control output from the MXi board used to turn on the supply.

The actual connection is made via a power connector at the rear panel and is wired to connector J5. The actual connection that supplies the amplifier(s) is wired directly from the rear panel to the amplifier and not through the MXi control board.

3 LCD GUI INTERFACE AND TOUCHPAD

The user interface to the transmitter is mainly accomplished with the front panel LCD that incorporates a touchpad as an integral part of the unit. The touchpad consists of a thin membrane attached to the LCD surface which implements a software-driven menu selection system. The LCD has the capability of displaying a number of different screens, which are selected by the operator via the touchpad.

Each of the separate display screens (called Menus) are detailed in the following subsections along with their respective touchpad menu options. When the MXi transmitter is first powered on or returns from an AC power outage, the LCD displays a screen [Power Up Screen] that only shows for a few seconds and describes the particular transmitter that this MXi is configured for. The same MXi controller board, LCD and software is used for a number of different transmitter configurations. The one specific Power Up Screen reflects the current transmitter configuration. This same information is available on the General Menu screen described in a later subsection.

A sample Power Up screen configured for a 50 watt UHF digital transmitter can be seen below. Note that there are no touchpad menu options on this screen, since it only displays for a few seconds. After these seconds have passed, the MXi proceeds into the Main Menu screen described in the next section.



Figure 7 Sample Power-Up Screen

3.1 MAIN SCREEN AND TOUCHPAD OPERATIONS

The Main Menu screen as shown below gives the operator all of the most pertinent values and status to verify the operation of the transmitter. This screen is the one that is normally left displayed when no maintenance or diagnostic checks are being performed. It is from this Main screen that all of the other submenu screens can be accessed. If the operator has switched to another submenu, it is recommended that the LCD is returned to the Main screen, since this shows an overview of the system operation.

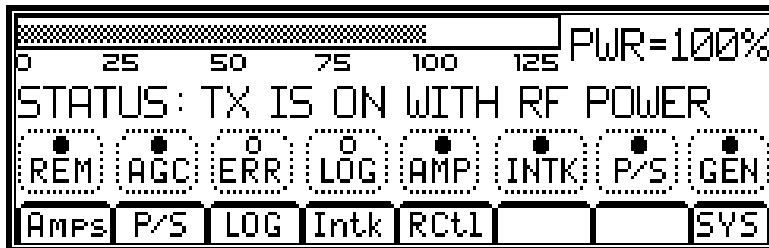


Figure 8 Main Menu Screen

The Main screen can be subdivided into four distinct sections, the main forward RF power at the top line, the transmitter status on the second line, the individual subsystem status on the third line and the submenu options on the fourth and last line.

The first line shows the forward RF power that the transmitter is currently generating. This is the power that is actually being sent out to the antenna or system load. There are two elements that show the same information but in different formats. The bar graph gives a graphic display of the RF power output level and is calibrated for 100% at the transmitter's rated output power. The bar graph will display up to 125% but it is not recommended that the operator increase the power beyond the rated power without prior approval from LARCAN field service. When the power exceeds 110%, the bar graph becomes more solid and darker in the area above 110% to indicate that an overpower condition is present.

The same information is provided to the left of the bar graph in a three-digit display which shows the current power output. When calibrating or setting up the transmitter, this three-digit display value should be used as a

MXi AMPLIFIER CONTROLLER BOARD REV.2

reference for the current transmitter power (not the bar graph). This display has a maximum value of 169% power when the transmitter detectors are set up for a DC output of 4.0 at full power. This value is derived from the fact that the detector can output a maximum of 5.0VDC to the telemetry circuits, which translates to an output power of 169%. Of course, this is a maximum display value on the LCD fixed by circuit constraints and the operator should never be approaching this type of power level with the transmitter. If a display of 169% is indeed displayed, then either there is a problem with the detector or the power of the transmitter is in fact exceeding 169% and should be attended to immediately.

The second line of the LCD shows the current state of the transmitter and any important errors that are current. This line typically tells the operator if the transmitter has been asked to be in the ON state. The transmitter is placed in the ON state either by the local front panel ON button or by a remote ON command. If the transmitter has been turned off by the operator, the LCD reports that the transmitter is OFF normally (i.e., it was not due to an error).

If an error condition has occurred that caused the transmitter to shut down, the LCD displays that the transmitter is OFF and then shows what the error condition is that has caused the shutdown. As an example, if the External#1 interlock has been opened, the LCD displays TX IS OFF, EXT1 INTERLOCK OPEN.

The third line of the display has a number of status lights with a legend describing the particular status underneath and all enclosed in a dashed line box. When the light is fully darkened, it indicates that this particular status is true. When the light is hollow, it indicates that this particular status is false. Each status is detailed below.

3.1.1 REM

Remote Status for the remote controls, operator controlled via the REM submenu.

- Lit when the system is in REMOTE mode and enables remote commands.
- Not lit when in LOCAL mode and remote commands are disabled.

3.1.2 AGC

AGC (Automatic Gain Control) Status, operator controlled via the AMP submenu.

This should always be enabled, the only purpose to have this OFF is during setup.

- Lit when the AGC is enabled and the system holds the output at a specific power level.
- Not lit when AGC is disabled, the output power depends on drive level and amplifier gains.

3.1.3 ERR

Status that shows an error either is current or has occurred since last check.

This is a composite of the other status, however it holds its value even when the error has cleared.

When an error happens such as Ext1 Interlock open, both the ERR and INTK status light.

If the error corrects, the INTK status will clear but not the ERR to show an error has occurred.

The user should check the AMP screen to check the error and then clear this status.

- Lit when an Error has occurred.
- Not lit if no Error has occurred since that last clear.

3.1.4 LOG

Status that shows that there are current entries in the LOG file.

- Lit whenever one or more LOG entries are currently in the LOG file via the LOG submenu.

Note these may not be new LOG entries, if the operator checks the LOG file but does not clear it.

The log entries status remains lit even if there are no new Logs.

The operator should clear the Logs once viewed so that this Log status indicates a new Log entry.

MXi AMPLIFIER CONTROLLER BOARD REV.2

- Not Lit when there are no current Log entries

3.1.5 AMP

Status that indicates the RF amplifier is currently active and is operating properly.

- Lit when the amplifier is ON, forward power is OK and reflected power is low.
- Not Lit when the amplifier is either OFF or has some operational problems.

If the amplifier has indeed been set to ON and the front panel ON LED is lit then an error is present.

The operator should then check the Amps submenu to determine the source of the problem.

3.1.6 P/S

Status that indicates the 32V power supply to the RF amplifier is currently ON and is operating properly.

- Lit when the Power Supply is ON. The P/S voltage, current and status are all OK.
- Not lit when the Power Supply is either OFF or has some operational problems.

If the Power Supply has indeed been set to ON and the front panel ON LED is lit, then an error is present.

The operator should then check the P/S submenu to determine the source of the problem.

3.1.7 INTK

Status that indicates the interlocks to the RF amplifier are all operating properly.

- Lit when transmitter is ON and all interlocks are closed (i.e., OK).
- Not lit when the transmitter is either OFF or one of the interlocks are opened.

If the transmitter has indeed been set to ON and the front panel ON LED is lit, an error is present.

The operator should then check the INTK submenu to determine the source of the problem.

Note that the same individual interlock status can be found on the other submenus as well, but the INTK submenu is a place where all the individual interlocks are displayed in one place.

3.1.8 GEN

This is a status that is reserved for future use and has no function at this time; it will always be lit.

The bottom line represents the menu selection buttons with a possible option of eight different submenu selections. The operator just needs to press the touch screen (lightly) either on or just above the desired menu select button. There are only six of the eight submenu buttons defined (positions 6 and 7 are blanks). When the operator presses one of these submenu buttons, the LCD screen will change over to the submenu that was selected. Once a selection has been made, the LCD touchpad is programmed to delay any further selections until 1 second after the operator has removed his finger from the LCD. This is an effective debounce of the LCD touchpad.

When the operator has selected a submenu, the LCD will change to the appropriate display submenu. When the operator is finished in the submenu, an OUT command returns to this main LCD screen.

3.2 AMPLIFIER SCREEN

The RF Amplifier submenu is entered by pressing the AMPS submenu button on the main LCD screen.

This submenu displays all the various power, status and controls for the RF amplifier. Each display item and control is described as to its meaning and function.

The LCD displays a typical AMPS submenu as follows:

MXi AMPLIFIER CONTROLLER BOARD REV.2

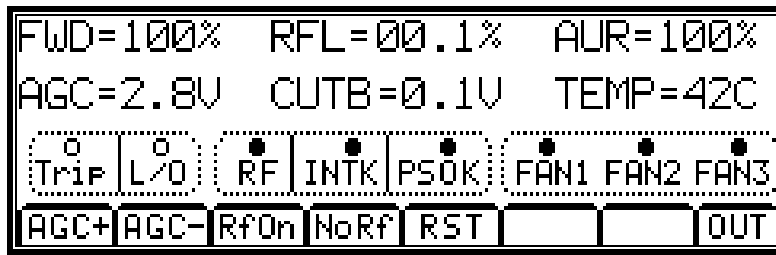


Figure 9 Amps Submenu

The first line shows the three possible RF powers. The first item is the forward power denoted as FWD that represents the total output RF power from the amplifier and would be the same value that is displayed on the Main LCD menu. This is represented as a percentage of the full rated output power of the transmitter.

The second item on the first line is the reflected power from the amplifier. This represents the total power that is being reflected back from the RF output system into the amplifier. The maximum amount of power that should be displayed is 10.0%, since the VSWR protection circuit shuts down the amplifier whenever the reflected power exceeds 10.0%. The expected reflected power would normally be under 1% and a value higher than this indicates a problem with the RF output system. When the reflected power increases, the amplifier automatically cuts back the forward power. When a value of 1% or higher is shown on the RFL power reading, a FWD power reading of less than 100% would be expected.

The third item on the first line is the optional aural power telemetry that represents the amount of aural power in an analog internally diplexed MXi transmitters. Note that this is an optional module that is not automatically included with the MXi transmitter and must be ordered separately, if desired. It requires an extra hardware board to be installed on the MXi control board. If this option is installed, then the percentage of full aural power is displayed here, else it will read 000%. If you do have an internally diplexed analog transmitter without the aural detector option, just ignore this value.

The first item of the second line shows the telemetry of the AGC voltage that the MXi controller uses to regulate the power generated by the RF amplifier and maintain it at 100% (or an other operator defined level). The AGC voltage sent to the RF amplifier can range from 0 to 10VDC, however, the A/D converter of the MXi CPU chip can only receive a level of 0 to 5VDC. To satisfy this requirement, the hardware circuitry divides the actual AGC control voltage by two and displays this half value on the LCD.

The second item of the second line shows the telemetry of the Cutback voltage that the MXi controller uses to reduce the power generated by the RF amplifier in the presence of reflected power (VSWR condition). The Cutback voltage sent to the RF amplifier can range from 0 to 10VDC, however, the A/D converter of the MXi CPU chip can only receive a level of 0 to 5VDC. To satisfy this requirement, the hardware circuitry divides the actual Cutback control voltage by two and displays this half value on the LCD.

Note that when Cutback is present, the AGC voltage will have both an AGC component and a CUTBACK component. That is, if the amplifier was set for 100% power and there is no VSWR, the LCD would show something like AGC=0.45V and CUTB=0.01V. When there is a VSWR condition, the LCD would show something like AGC=1.45V and CUTB=1.00V. The AGC voltage displayed is a composite of 0.45 volts of AGC action and 1.0V of cutback action.

The third item of the second line shows the telemetry of the temperature thermistor of the RF amplifier heatsink. Note that not all MXi transmitters will have this thermistor installed. The value is used as a factory diagnostic tool when checking the RF amplifier.

The third line of the display has a number of status lights with a legend describing the particular status underneath and all enclosed in a dashed line box. When the light is fully darkened, it indicates that this particular status is true. When the light is hollow, it indicates that this particular status is false. Certain related status are grouped together in the same box. The purpose of these status is to point the operator to the area that is currently causing the RF amplifier to be shut down. Each status is detailed as follows.

MXi AMPLIFIER CONTROLLER BOARD REV.2

3.2.1 TRIP

VSWR Trip Status

- Lit when the system has seen at least one VSWR trip, can be reset by operator using LCD touchpad.
- Not lit when there have been no VSWR trips since the last time this was cleared.

Note that this does not mean that there is a current VSWR trip but that one did occur.

The operator may have this status as true (with no Lockout status) and still have the RF amplifier active.

3.2.2 L/O

VSWR Lockout Status

- Lit when the system has seen three VSWR trips in under 1 minute.

When a VSWR trip occurs, the MXi controller will reset the trip automatically and repower the RF amplifier.

If three trips occur within 1 minute, the Lockout status is set and the RF amplifier will remain OFF.

The Lockout status can be reset by the operator pushing the RST button on the LCD touchpad.

- Not lit when there have been no VSWR trips since the last time this was cleared.

3.2.3 RF

RF ON/OFF Mode Status

This should always be enabled, the only purpose to have this OFF is during setup.

- Lit when the RF drive to the amplifier is enabled, operator enables/disables this with the LCD touchpad.
- Not lit when RF drive to the amplifier is disabled.

3.2.4 INTK

Interlock inputs that affect the RF amplifier are all closed and OK.

- Lit when transmitter is ON and all interlocks are closed (i.e., OK).
- Not lit when the transmitter is either OFF or one of the interlocks are opened.

If the transmitter has indeed been set to ON and the front panel ON LED is lit, an error is present.

The operator should then check the INTK submenu to determine the source of the problem.

3.2.5 PSOK

Power Supply OK status, the 32V power supply to the RF amplifier is currently ON and is operating properly.

- Lit when the Power Supply is ON. The P/S voltage, current and status are all OK.
- Not lit when the Power Supply is either OFF or has some operational problems.

If the Power Supply has indeed been set to ON and the front panel ON LED is lit, an error is present.

3.2.6 FAN1

Status that shows if FAN1 is currently operational.

When the transmitter is turned ON, all the fans are turned on.

- Lit when fan rotational status is true, this only happens if the fan is actually rotating.
- Not lit when the fan is not rotating; if the other fans are OK, this indicates a failure.

MXi AMPLIFIER CONTROLLER BOARD REV.2

3.2.7 FAN2

Status that shows if FAN2 is currently operational.

When the transmitter is turned ON, all the fans are turned on.

- Lit when fan rotational status is true, this only happens if the fan is actually rotating.
- Not lit when the fan is not rotating; if the other fans are OK, this indicates a failure.

3.2.8 FAN3

Status that shows if FAN3 is currently operational.

When the transmitter is turned ON, all the fans are turned on.

- Lit when fan rotational status is true, this only happens if the fan is actually rotating.
- Not lit when the fan is not rotating; if the other fans are OK, this indicates a failure.

The bottom line represents the menu selection buttons with a possible option of eight different submenu selections. The operator just needs to press the touchpad (lightly) either on or just above the desired menu select button.

The first two buttons from the left control the power output level of the transmitter via the AGC buttons.

The operator just needs to press the AGC+ button on the touchpad to increase the power or the AGC- button to decrease the power. The top line of the LCD displays the current level of the FWD power. This AGC level will be saved even after AC power outages. If the RF power is nil or very low, make sure that the RF drive has been enabled by pressing the RF ON button on the touchpad.

The next two buttons control the RF drive to the amplifier. This RF is removed from the amplifier by pressing the RF OFF menu button. This causes the MXi to apply the maximum (+5VDC) AGC voltage to the preamp attenuator. This is not a shut-off of the amplifier but just reduces the drive level substantially. The output power of the amplifier will not be at a zero level but will be at a low level, depending on the range of the AGC attenuation. When the RF OFF command is issued, the MXi saves the previous level of the transmitter power. If the operator presses the RF ON button, the MXi restores the previous power level to the AGC system. Note that if the transmitter is already running with RF ON, then pressing this button will do nothing.

The next button is the RST button that clears any VSWR trips or Lockouts when pressed. The operator can verify its operation by checking the TRIP and L/O status lights on the third line of the LCD screen.

When the operator is finished in the submenu, an OUT command returns to the Main LCD screen.

3.3 POWER SUPPLY SCREEN

The Power Supply submenu is entered by pressing the P/S submenu button on the main LCD screen.

This submenu displays the status, voltage and current for the 32V power supply. Each display item and control is described as to its meaning and function.

The LCD displays a typical P/S submenu as shown below.

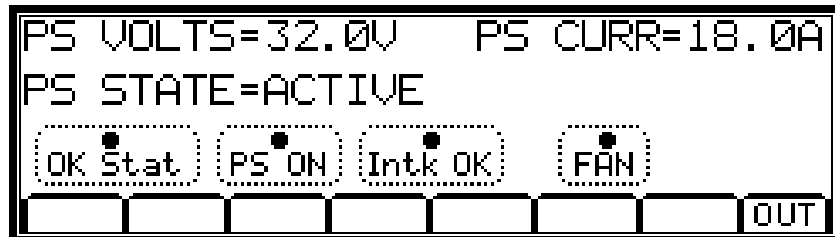


Figure 10 Power Supply Submenu Screen

The first line gives the measured telemetry values for the power supply voltage and current for the +32V power output. The second line gives the power supply state, which can have three possibilities: ACTIVE (operating

MXi AMPLIFIER CONTROLLER BOARD REV.2

normally), OFF NORMAL (turned off by operator) or OFF TRIPPED (off due to an error). **Note:** if the power supply is OFF, there will be no voltage or current telemetries.

The third line has four status lights that will tell the operator which element has caused the power supply to shut off.

3.3.1 OK STAT

Power Supply OK status, the 32V power supply generates this internal status that all is OK.

- Lit when the Power Supply is ON. The P/S voltage, current and status are all OK.
- Not lit when the Power Supply is either OFF or has some operational problems.

If the Power Supply has indeed been set to ON and the front panel ON LED is lit, then an error is present.

3.3.2 PS ON

Power Supply ON Command

- Lit when the Power Supply ON command has been issued by the MXi controller.
- Not lit when the Power Supply has been shut down by the Controller (not due to an error).

3.3.3 INTK

Interlock inputs that affect the power supply are all closed and OK.

- Lit when transmitter is ON and all interlocks are closed (i.e., OK).
- Not lit when the transmitter is either OFF or one of the interlocks are opened.

If the transmitter has indeed been set to ON and the front panel ON LED is lit, an error is present.

The operator should then check the INTK submenu to determine the source of the problem.

3.3.4 FAN

Status that shows if FAN is currently operational.

When the transmitter is turned ON, one of the four fans is dedicated to cooling the power supply.

- Lit when fan rotational status is true, this only happens if the fan is actually rotating.
- Not lit when the fan is not rotating and there is limited cooling.

The bottom line represents the menu selection buttons with a possible option of eight different submenu selections. The operator just needs to press the touchpad (lightly) either on or just above the desired menu select button.

There is only one menu button selection for the Power supply menu and that is the eight button labeled OUT which exits this submenu. When the operator is finished in the submenu, an OUT command returns to the Main LCD screen.

3.4 INTERLOCKS SCREEN

The Interlocks submenu is entered by pressing the INTK submenu button on the main LCD screen.

This submenu displays all the various interlocks for the RF amplifier. Each display item and control is described as to its meaning and function.

The LCD displays a typical INTK submenu as follows:

The first line of the LCD shows the transmitter ON/OFF status and the resulting interlock status. If the transmitter has been turned ON and the Interlocks are OK, then the RF amplifier is indeed receiving the +32V power feed. Note that some interlocks will not be closed if the transmitter has been purposely shut down. An example of this would be the fan interlock. If the transmitter is shut down, the controller will shut down the fans since they are not

MXi AMPLIFIER CONTROLLER BOARD REV.2

needed and the fan interlock status would then normally be OFF. This makes it important to indicate to the operator the intended state of the transmitter as either ON or OFF to correctly interpret the subsequent status.

This sample LCD screen shows the state when the transmitter is ON and the interlocks are OK

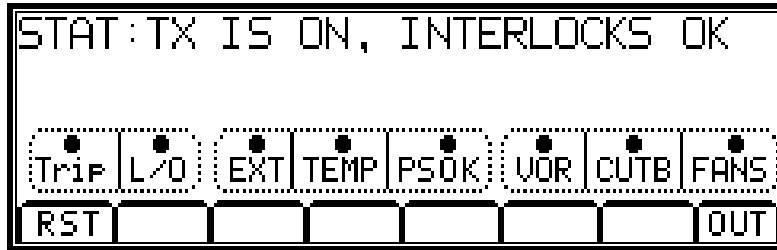


Figure 11 Transmitter On, Interlocks OK Screen

In the case when the transmitter is ON and the interlocks are BAD (there is an open interlock), the LCD displays the top priority interlock that is opened on the second line. Note that it is possible to have more than one interlock that is open, so the LCD sorts these out in priority and displays the higher priority one. An example of this is given in the sample display below.

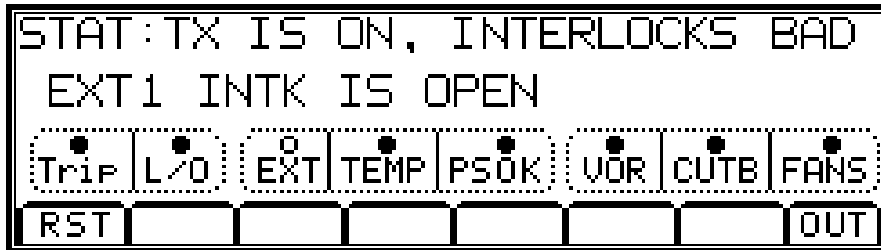


Figure 12 Transmitter On, Interlocks Bad Screen

When the transmitter is OFF, the system still looks at some of the interlocks that should be closed regardless of the state of the transmitter. The two interlocks that are ignored when the transmitter is OFF are the PSOK and FANS. An example of this is given in the sample display below.

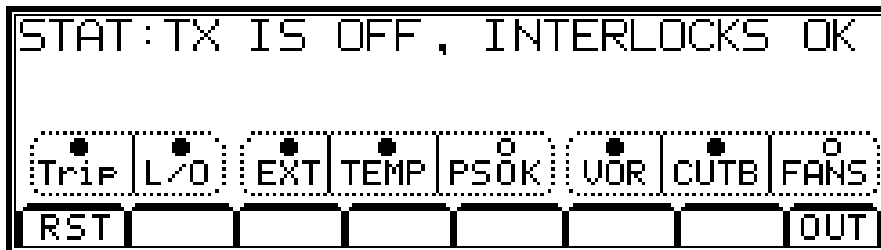


Figure 13 Transmitter Off, Interlocks OK Screen

The third line of the display has a number of status lights with a legend describing the particular status underneath and all enclosed in a dashed line box. When the light is fully darkened, it indicates that this particular status is true and that interlock is closed (OK). When the light is hollow, it indicates that this particular status is false and the interlock is open (BAD). Certain related status are grouped together in the same box. The purpose of these status is to point the operator to the area that is currently causing the RF amplifier to be shut down. Each status is detailed below.

3.4.1 TRIP

VSWR Trip Status

- Lit when there have been no VSWR trips since the last time this was cleared.
- Not lit when the system has seen at least one VSWR trip.

Note that this does not mean that there is a current VSWR trip but that one did occur.

MXi AMPLIFIER CONTROLLER BOARD REV.2

The operator may have this status as true (with no Lockout status) and still have the RF amplifier active. This can be reset by the operator using the LCD touchpad button RST or by the front panel Reset button.

3.4.2 L/O

VSWR Lockout Status

- Lit when there is no VSWR Lockout condition.
- Not lit when the system has seen three VSWR trips in under 1 minute.

When a VSWR trip occurs, the MXi controller will reset the trip automatically and repower the RF amp. If three trips occur within 1 minute, the Lockout status is set and the RF amplifier will remain Off. The Lockout status can be reset by the operator pushing the RST button on the LCD touchpad.

3.4.3 TEMP

Thermal Interlock

This is the thermal interlock that is mounted on the amplifier heatsink.

- Lit when the thermal interlock is closed, the heatsink temperature is OK.
- Not lit when the thermal interlock is open, the heatsink temperature is too high.

3.4.4 PSOK

Power Supply OK status, the 32V power supply to the RF amplifier is currently ON and is operating properly.

- Lit when the Power Supply is ON. The P/S voltage, current and status are all OK.
- Not lit when the Power Supply is either OFF or has some operational problems.

If the Power Supply has indeed been set to ON and the front panel ON LED is lit, then an error is present.

3.4.5 VOR

Video Operated Relay Control, this is used in some configurations to control the ON/OFF transmitter state.

When enabled or configured, the transmitter will respond to the VOR input by turning ON or OFF.

This function is client specific and would not be enabled in most transmitter configurations.

Most sites can safely ignore this status unless it has been specifically requested by the customer.

- Lit when VOR is present and the transmitter is enabled to be ON.
- Not lit when VOR is off, the transmitter is OFF only if the VOR function is enabled.

3.4.6 CUTB

Cutback Function is currently active.

When there is power being reflected from the output RF system back into the MXi transmitter, the Cutback function will automatically reduce the forward RF power to protect the amplifiers. The cutback does not shut down the amplifier but reduces its power.

- Lit when the cutback voltage is under a minimum of 0.5V, indicating no or little cutback action.
- Not lit when the cutback voltage is over 0.5V, indicating a significant cutback action.

3.4.7 FANS

Status that shows if FANS 1 through 4 are all currently operational.

When the transmitter is turned ON, all the fans are turned on.

MXi AMPLIFIER CONTROLLER BOARD REV.2

- Lit when fan rotational status are all true, this only happens if the fan is actually rotating.
- Not lit when at least one fan is not rotating.

The bottom line represents the menu selection buttons with a possible option of eight different submenu selections. The operator just needs to press the touchpad (lightly) either on or just above the desired menu select button.

The first button is the RST button that clears any VSWR trips or Lockouts when pressed. The operator can verify its operation by checking the TRIP and L/O status lights on the third line of the LCD screen.

When the operator is finished in the submenu, an OUT command will return to the Main LCD screen.

3.5 REMOTE CONTROLS AND RS232 SERIAL SCREEN

The Remote Control submenu is entered by pressing the RCtrl submenu button on the main LCD screen.

This submenu displays all the various parameters that affect the remote controls and the remote RS232 status communications stream.

The LCD displays a typical RCtrl submenu as follows:

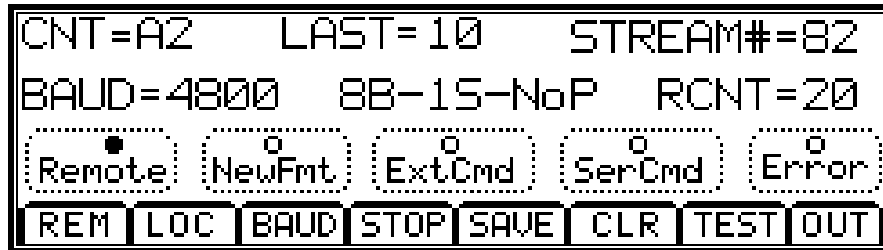


Figure 14 Remote Control Submenu

The first line of the LCD shows three parameters that can assist the operator in checking remote operations.

The first item is the CNT=A2, which is the count of remote commands that have been received by the MXi. The value is a hexadecimal count (A2 in our example which is 162 decimal) which will increment upon the arrival of a new remote command. The source of the remote command can either be through the external individual remote commands on J6 or through a command received via the RS232 serial program. When the count hits \$FF the next command will cause it to roll over to a value of \$00.

The second item is the LAST=10, which is the actual hexadecimal value assigned to the remote command that was just received. The operator can use this information to determine what command has been received and determine whether the action has been indeed taken.

The third item is the STREAM#=82, which is the actual hexadecimal count of the number of serial streams sent out the RS232 port. The MXi sends a complete serial stream out the RS232 port about once per second and so this count should increment around once per second. When the count hits \$FF, the next command causes it to roll over to a value of \$00. The operator can use this information to verify that the MXi is indeed sending serial data and can compare the stream number to that received by the remote computer program.

The second line of the LCD shows three parameters that can assist the operator in checking remote RS232 serial operations and setups.

The first item is the BAUD=4800, which is the serial baud (bits per second) that is currently being used by the MXi to send serial data out the RS232 port. The value can be set by the operator and can range from 300 to 38,400 bits per second. The operator would need to set this baud to match the remote PC and modem setup.

The second item is the 8B-1S-NoP, which is the serial format that is being used for the RS232 stream. This stands for 8 data bits, 1 stop bit and no parity. The operator should set his remote computer to match this serial format setting. The only parameter that can be changed by the user is the number of stop bits. The user can set either 1 or 2 stop bits.

The third item is the RCNT=10, which is the actual hexadecimal count of the last RS232 remote commands that were received. Note that this is a count of only the commands received via the RS232 serial port, the commands

MXi AMPLIFIER CONTROLLER BOARD REV.2

from the individual J6 commands are not counted. The operator can use this information along with the CNT value from line #1 of the LCD to determine the source of the remote command. If the CNT increments but the RCNT does not, then the recent remote command came from J6. If both the CNT and the RCNT increment, then the recent remote command came from the RS232 stream.

The third line of the display has a number of status lights with a legend describing the particular status underneath and all enclosed in a dashed line box. When the light is fully darkened, it indicates that this particular status is true or active. When the light is hollow, it indicates that this particular status is false and inactive. Each status is detailed as follows.

3.5.1 Remote

Remote Control Enable

The operator has the option of allowing remote commands or disabling them. When performing some sort of maintenance or local setups, the operator will usually disable any remote commands until the work on the transmitter is completed. If the operator has elected to disable the remote mode, be careful not to forget to put the transmitter back in Remote mode or else the remote controls will not be operational. The menu button options on the bottom line of the LCD provide the controls to Enable/Disable remote controls.

- Lit when Remote commands are enabled.
- Not lit when Remote commands are disabled.

3.5.2 NewFmt

New Serial Format has been selected but not taken.

The operator has the option changing the baud rate or number of stop bits for the serial RS232 communications. If a change has been selected, it is not implemented until the operator presses the SAVE menu button on the LCD. This status tells the operator that the recently selected format is different from the one currently being used for the serial stream.

- Lit when there is a pending change in the serial format.
- Not lit when there is no serial format change or the selected format is the same as the current one.

3.5.3 ExtCmd

External Serial Command Received

The external remote control system can assert a command onto the individual remote inputs at J6. The MXi will set the ExtCmd status if a valid command has been received. This is useful in detecting remote commands issued to the MXi from the remote control system. This bit can be cleared by the CLR menu button on the LCD.

- Lit when an external serial command from J6 has been received.
- Not lit when no external serial command from J6 has been received since the last clear.

3.5.4 SerCmd

RS232 Serial Command Received

The external computer will send a four-byte serial stream of a specific format to ask for a certain action to be taken. The MXi will set the SerCmd status if a valid command has been received. This is useful in detecting serial transmissions between the external computer and the MXi. This bit can be cleared by the CLR menu button on the LCD.

- Lit when a RS232 serial command from the computer has been received.
- Not lit when no RS232 serial command from the computer has been received since the last clear.

3.5.5 Error

Serial Input Stream Error

The external computer will send a four-byte serial stream of a specific format to ask for a certain action to be taken. The MXi monitors the format of this four-byte serial stream and sets the Error status if the stream has the wrong format. This is useful in determining if there is a serial transmission problem between the external computer and the MXi. This bit can be cleared by the CLR menu button on the LCD.

- Lit when an error was detected in the RS232 command stream since the last clear.
- Not lit when no error has been detected in the RS232 command stream since the last clear.

The bottom line represents the menu selection buttons with a possible option of eight different selections. The operator just needs to press the touchpad (lightly) either on or just above the desired menu select button.

The first two buttons from the left control the Remote mode of the MXi transmitter. The operator has the option of allowing remote commands or disabling them. When performing some sort of maintenance or local setups, the operator will usually disable any remote commands until the work on the transmitter is completed. If the operator has elected to disable the Remote mode, be careful not to forget to put the transmitter back in Remote mode or else the remote controls will not be operational. The first menu button Remote enables the remote commands and the second button Local disables the remote commands. The status light labeled Remote on the third line of the LCD indicates the current state of the transmitter.

The BAUD button on the bottom of the LCD touchpad causes the baud to increment from the current displayed baud up to the next higher one. At the same time, the NewFmt light on the third line lights to indicate that a new serial format (Baud or Stop bits or both) is pending but not taken. Successive pushes of the BAUD button cause the baud to increment until it reaches the maximum of 19,200 baud, after which it will roll back to 300 baud, which is the lowest rate. Note that when setting the baud, if the NewFmt light is on, the rate displayed on the screen is the new baud that is not yet programmed. The MXi will still operate at the original Baud rate until the new one is saved.

If the user presses the STOP menu button, then the number of stop bits in the serial format will toggle between 1 and 2. The new desired number of stop bits will be displayed in the second line of the LCD within the 8B-1S-NoP section where the stop bits will be either 1S or 2S in this string. At the same time, the NewFmt light on the third line will light to indicate that a new serial format (Baud or Stop bits or both) is pending but not taken.

Once the operator is satisfied with the new baud and Stop bits, pressing the SAVE button causes the MXi to implement the new serial format. Pressing the CLR button abandons all selections and revert to the previous baud and Stop bits without any action be taken.

The CLR button will also clear the CNT value on the first line, the RCNT value on the second line along with the ExtCmd, SerCmd and Error status lights on the third line.

The TEST button is for factory testing and has no function to the end user.

When the operator is finished in the submenu, an OUT command returns to this main LCD screen.

3.5.6 Logs Screen

The LOGS submenu is entered by pressing the LOGS submenu button on the main LCD screen.

This submenu begins by displaying the first three log entries that are stored in the internal log table. If there are fewer than three entries, only those one or two log entries are displayed. The first three lines of the display are used to display log entries and the last line is used for menu button options. The LCD displays a typical LOGS submenu as follows:

MXi AMPLIFIER CONTROLLER BOARD REV.2



Figure 15 Logs Submenu Screen

The logs are displayed up to three at a time, in the order in which they were detected in the controller. That is, the logs are in chronological order from the time they were received. The seventh menu button on the fourth line of the LCD shows the total number of log entries [our example shows 2 entries #=02].

A maximum of 99 log entries can be held in the log table. If the log table already contains 99 entries and a new log has occurred, the oldest log is discarded and the new log is entered into the table. In this manner the log table will hold the 99 most recent logs.

In the fourth menu button line of the LCD, the first four button selections (from the left side) allow the operator to navigate through the log table when there are more than three logs. If there are three logs or less, all the entries are already displayed on the LCD.

The first menu button is labeled 1ST and causes the display to return to the beginning of the log table and display the first three entries.

The second menu button is labeled LAST and causes the display to jump to the end of the log table and display the last three entries.

The third menu button is labeled NEXT and causes the display to scroll down one log entry. If the LCD was displaying LOGS 2-4, then pressing NEXT displays LOGS 3-5.

The fourth menu button is labeled 1ST and causes the display to scroll down up one log entry. If the LCD was displaying LOGS 2-4, then pressing PREV displays LOGS 1-3.

The fifth menu button is labeled CLR and causes the log table to be cleared and the LCD will have no logs to display and the count will revert back to zero #=00. As noted previously, the log count is located in the seventh menu button position. Pressing this button does not perform any function.

The eighth menu button is labeled OUT and causes the LCD screen to return to the Main Menu.

3.6 GENERAL SCREEN

The General submenu is entered by pressing the GEN submenu button on the main LCD screen.

This submenu displays all the configuration and setup information of the particular model of MXi transmitter. The first line displays the transmitter type, the second line displays the software code and revision, the third line displays the LARCAN ID number that is used in the factory to determine options, date the boards were made and other information. This information is not really important for day to day operations but can be useful when dealing with LARCAN service in verifying the transmitter configuration.

There is only one menu button option on the fourth line of the LCD screen, which is the OUT button in the eighth position. Pressing this button causes the LCD screen to return to the Main Menu.

The LCD displays a typical GEN submenu as follows:

MXi AMPLIFIER CONTROLLER BOARD REV.2

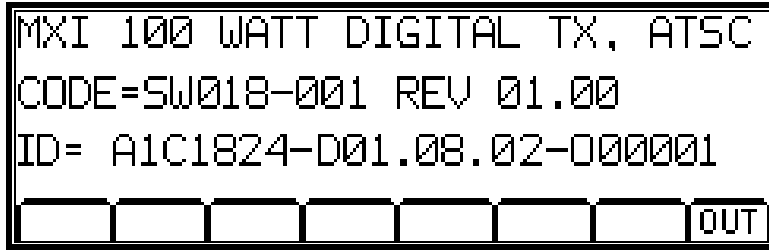


Figure 16 General Submenu Screen

The eighth menu button is labeled OUT and will cause the LCD screen to return to the Main Menu.

4 SETUP PROCEDURES

The following sections detail the various set up procedures for the MXi transmitter system. These procedures should only be done by qualified personnel. If the calibrations and setups are done improperly, it can result in the transmitter being prone to damage.

The transmitter is normally set up in the factory for the particular operating power required when first installed. Set up procedures would only be required if certain elements of the MXi transmitter had to be replaced or repaired that would have affected the calibrations. An example of this would be the MXi controller board itself, the output RF couplers, the RF cables or the 32V power supply.

If the output power is being changed, then some setup and calibration would be needed since the transmitter would be set up for the previous RF power level. **Caution:** do not increase the power output of the MXi transmitter beyond the original factory set level without first consulting LARCAN field service.

4.1 RF DETECTOR

The RF detector is normally calibrated at the factory or by LARCAN field personnel and should not require onsite re-adjustments except in the following circumstances.

- The desired output power level of the transmitter is to be changed from the factory setting for a full 100% power reading. Note that the operator should not just increase and readjust power beyond the recommended rating of the transmitter without prior approval from LARCAN technical services.
- A replacement MXi control board or directional coupler has been installed in the transmitter.

This procedure assumes that the RF detector is being set-up with the transmitter connected to an RF modulator input and output load (or antenna) that is the actual configuration it is intended to operate with.

4.1.1 Test Equipment Required

- a) An RF power meter such as the HP 436A or similar. For analog transmitters, a BIRD through-line wattmeter is sufficient.
- b) A Spectrum Analyzer, HP 8558B or similar.

If the operator wishes to set up the unit on the bench, then a number of extra pieces of test equipment are necessary.

- An RF generator/modulator that will replicate the desired signal and level
- An analog transmitter would need a video generator such as Tektronix 1900 or similar
- A modulator such as LARCAN TTC (Catel X - ATM -1600 - 6 - 01/01) or similar.
- An upconverter such as Philips PM 5690 or similar (or one supplied with transmitter)
- A digital transmitter would need the Zenith modulator used with the transmitter. With serial data input, the Zenith will still generate the appropriate digital spectrum
- An upconverter such as Philips PM 5690 or similar (or one supplied with transmitter)
- RF Load rated at the transmitter power and associated cable

4.1.2 Jumper Installation

If the transmitter is not being upgraded from Analog to Digital service (or vice versa), then there should be no need to change the jumpers for the traps or gain. If there is a change, the trap jumpers would need to be modified and perhaps the gain as well.

For Analog service, the color burst and aural carrier traps should normally be installed.

For the forward power sample, this would be jumpers E9 and E10.

For the reflected power sample, this would be jumpers E13 and E14.

MXi AMPLIFIER CONTROLLER BOARD REV.2

For Digital service, the above four jumpers would not be installed.

If the desired transmitter output power is the same as what the transmitter was originally set up for at the factory, there should be no need to change the gain jumpers on the RF detectors.

If a change in power is required or the directional coupler has been changed or the transmitter is being moved between Analog/Digital service, the RF detector should be first set to the lowest possible gain and the jumpers moved to increase the gain.

For the forward power sample, the gain is controlled by jumpers E8 and E11.

Digital + Low Gain: E8= Av and E11=LO

Digital + High Gain: E8= Av and E11=HI

Analog + Low Gain: E8= Pk and E11=LO

Analog + High Gain: E8= Pk and E11=HI

For the reflected power sample, the gain works identically where E12 is the same as E8 and E15 is the same as E11.

4.1.3 Verify OpAmp Offsets

1. With no RF signal applied, measure the voltage at TP1 and adjust R58 to make this level under 0.1VDC
2. With no RF signal applied, measure the voltage at TP4 and adjust R80 to make this level under 0.1VDC

4.1.4 Verify Output Power Level

1. Attach the RF output power measuring device (Wattmeter or Average Power Meter) to the RF output.
2. Turn down the drive level of the modulator/upconverter before applying the RF input signal.
3. Turn up the drive level until the output power measures the desired reading. Do not use the meter of the transmitter itself to determine output power, since at this point it may be uncalibrated.
4. When increasing the power, it is always instructive to measure the current on the 32VDC supply in case there is a problem with how the output power meter is connected or working. If the supply current is increasing but the output power is not, set the drive to a sufficiently lower level and double check your setup.
5. When the RF output power is at the desired level, do the following checks:
 - a) For the forward power sample, the voltage at TP1 should be within 4.5 to 9.0VDC as a maximum
 - b) If not, then you have either too much power or too high a coupling in the directional coupler.
6. Reverify the output power: if this is correct, a pad can be inserted between the coupler and J12.
7. Adjust potentiometer R48 until the voltage at TP3 is 4.0VDC.
8. At this point, the meter on the transmitter should read 100%
9. To calibrate the reflected power, install jumper E17 that prevents any VSWR trips
10. Remove the RF cable from J12 and attach a -10dB pad, then connect this reduced forward power sample to J13.
11. If the original power sample into J12 required a pad, this must be retained in addition to the -10dB pad.
12. For the reflected power sample, the voltage at TP4 should be within 4.5 to 9.0VDC as a maximum
13. If not, reverify that the output power has not changed in the meantime.
14. Adjust potentiometer R80 until the voltage at TP5 is 4.0VDC.
15. At this point, the reflected power meter on the transmitter should read 10.0%.

Note: Make sure that you remove jumper E17 when done, else you will have no VSWR protection!

MXi AMPLIFIER CONTROLLER BOARD REV.2

At this point, the operator should proceed to verify cutback and VSWR trip functions, as described in the next two sections.

4.2 AGC AND CUTBACK PROTECTION

Before the operator attempts to set up the AGC or cutback circuitry, the forward and reflected power levels must be properly set up to calibrated levels as described in Section 4.1.

4.2.1 AGC Setup

The AGC is simply set up using the Amps submenu that is accessed from the Main menu of the LCD. A view of this submenu is given below. The operator just needs to press the AGC+ button on the touchpad to increase the power or the AGC- button to decrease the power. The top line of the LCD displays the current level of the FWD power. This AGC level will be saved even after AC power outages. If the RF power is nil or very low, make sure that the RF drive has been enabled by pressing the RF On button on the touchpad

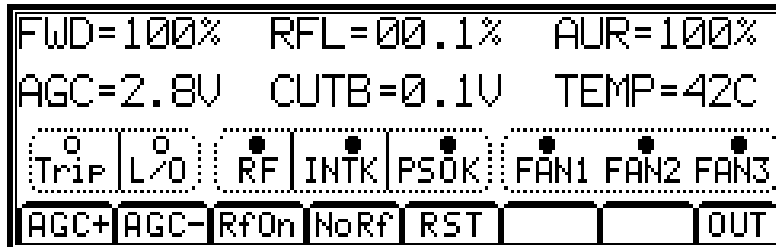


Figure 17 Amps Submenu Screen

4.2.2 Cutback Setup

To set up the cutback level, a power sample must be fed into the reflected power connector of the MXi board that is -16dB down from the forward power sample level. The most convenient way to accomplish this is to take this sample from the RF monitor port on the rear of the transmitter chassis.

1. Disconnect the AGC control connector J10 from the MXi board to remove any possible AGC or cutback action while verifying the Reflected power. If the forward power is greater than 100%, adjust the output level of the upconverter until it is at 100% (+/- 2%).
2. Attach an RF cable from the RF monitor connector at the rear of the MXi control chassis and insert a -16dB pad. This pad can consist of a -10dB and -6dB pad in series. Remove the RF cable from J13 that comes from the output coupler and attach a cable from the -16dB pad off the forward monitor sample.
3. We are assuming that the coupling level from the monitor connector is the same as the coupling level for the forward power RF coupler. To verify this by checking the RFL power level on the LCD, it should read around 2.5% power. If it is off by more than 0.5%, adjust the amount of padding until the RFL power reading is within the range of 2% - 3%. A variable attenuator pad would be ideal for this application.
4. Readjust the upconverter output level so that the forward power reads 110% again.
5. Also disconnect the cable from the monitor port for now.
6. Reconnect the AGC control connector J10 on the MXi board.
7. Reconnect the cable from the monitor port to the reflected power sample at J13.
8. Adjust the potentiometer R105 until the forward power reading is about 96% - 98%, which puts the system just at the edge of cutback.

The setup is now complete, remove the monitor cable from J13 and attach the output coupler back to J13.

4.3 VSWR PROTECTION

The VSWR protection does not really need any setup or calibration since it is fixed to trip when the reflected power is -10dB of the forward power level. To verify the VSWR trip function, the following steps must be taken.

MXi AMPLIFIER CONTROLLER BOARD REV.2

To check the VSWR trips, a power sample must be fed into the reflected power connector of the MXi board that is -10dB down from the forward power sample level. The most convenient way to accomplish this is to take this sample from the RF monitor port on the rear of the transmitter chassis.

1. Disconnect the AGC control connector J10 from the MXi board to remove any possible AGC or cutback action while verifying the Reflected power. If the forward power is greater than 100%, adjust the output level of the upconverter until it is at 100% (+/- 2%).
2. Install a jumper in E17 that will prevent any VSWR trips.
3. Attach an RF cable from the RF monitor connector at the rear of the MXi control chassis and insert a -10dB pad. Remove the RF cable from J13 that comes from the output coupler and attach a cable from the -16dB pad off the forward monitor sample. We are assuming that the coupling level from the monitor connector is the same as the coupling level for the forward power RF coupler. To verify this by checking the RFL power level on the LCD, it should read over 10.1% power but less than 11% power. Note that a minimum of 10.1% power is needed to insure a VSWR trip. If the RFL power is under 10.1%, decrease the amount of padding until the RFL power reading is within the range. If the RFL power is too high (over 11%), increase the amount of padding until it is in the range. A variable attenuator pad would be ideal for this application.
4. Readjust the upconverter output level so that the forward power reads 110% again.
5. Also disconnect the cable from the monitor port for now.
6. Reconnect the AGC control connector J10 on the MXi board.
7. Reconnect the cable from the monitor port to the reflected power sample at J13.
8. Remove the jumper from E17 and the transmitter should trip three times and lock out on the fourth trip.
9. The TRIP and Lockout status on the LCD Amps submenu should both be set.
10. The setup is now complete: remove the monitor cable from J13 and attach the output coupler back to J13.
11. Clear the VSWR lockout and trip condition by either pressing the front panel reset button or issuing a remote reset command.

4.4 REMOTE CONTROL INTERFACE BAUD

The Remote Control submenu is entered by pressing the RCtl submenu button on the main LCD screen.

This submenu will display all the various parameters that affect the remote controls and the remote RS232 status communications stream. It will allow the operator to set the baud that is used to communicate with an external computer. The other parameter that can be adjusted is the number of stop bits.

The LCD displays a typical RCtl submenu as follows:

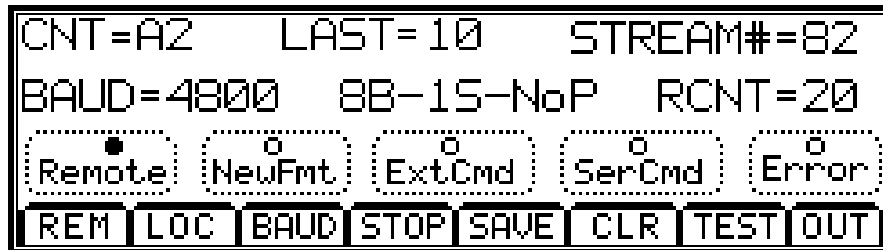


Figure 18 Remote Control Submenu Screen

The BAUD button on the bottom of the LCD touchpad will cause the baud to increment from the current displayed baud up to the next higher one. At the same time, the NewFmt light on the third line lights to indicate that a new serial format (Baud or Stop bits or both) is pending but not taken. Successive pushes of the BAUD button will cause the baud to increment until it reaches the maximum of 19,200 baud, after which it will roll back to 300 baud, which is the lowest rate. Note that when setting the baud, if the NewFmt light is on, the rate displayed on the

MXi AMPLIFIER CONTROLLER BOARD REV.2

screen is the new baud that is not yet programmed. **Note:** The MXi will still operate at the original baud until the new one is saved.

If the user presses the STOP menu button, then the number of stop bits in the serial format will toggle between 1 and 2. The new desired number of stop bits will be displayed in the second line of the LCD within the 8B-1S-NoP section where the stop bits will be either 1S or 2S in this string. At the same time, the NewFmt light on the third line lights to indicate that a new serial format (Baud or Stop bits or both) is pending but not taken.

Once the operator is satisfied with the new Baud and Stop bits, pressing the SAVE button causes the MXi to implement the new serial format. Pressing the CLR button abandons all selections and reverts to the previous Baud and Stop bits without any action taken.

4.5 POWER SUPPLY VOLTAGE AND CURRENT CALIBRATION

To set up the power supply voltage and current reading, the operator must enter the Power Supply submenu on the LCD. The Power Supply submenu is entered by pressing the P/S submenu button on the main display.

This submenu displays the status, voltage and current for the 32V power supply. Each display item and control is described as to its meaning and function.

The LCD displays a typical P/S submenu as follows:



Figure 19 Power Supply Submenu Screen

1. To set up the voltage reading, turn on the transmitter and verify that the power supply is indeed running. Line two of the LCD should have the power supply as active, with all of the status lights in line #3 as true, just as is shown in the above LCD screen.
2. With a voltmeter, measure the actual voltage from the power supply; this can be measured at pin 1 of J4.
3. Adjust potentiometer R14 until the displayed voltage equals that being measured by the voltmeter.
4. To set up the current reading, the power supply should be ON as in the above paragraph and enough RF drive (at least 50%) should be applied to get a reasonable current level for calibration.
5. Use a clamp-on current Ammeter to measure the current draw from the 32V power supply. If multiple wires are being used to connect the power supply to the RF amplifier, insure that all of the wires are included in the clamp-on meter. However, make sure that none of the ground wires are included (only the +32V wires) or else the reading will be too low.
6. If the MXi is configured to measure the current with the onboard current sensor U9 via connector J4, adjust potentiometer R15 until the displayed current agrees with that measured on the clamp on meter.

If an external power supply is used that has its own current telemetry sensing, it may have its own setup as well. The current reading on the LCD will still be affected by R15 but the external supply may require its own calibration, if the level it sends to the MXi is too low or high. A good level would be in the range of 2-4 volts for full scale current.

5 REMOTE CONTROL CONNECTIONS MXi TRANSMITTER

On the rear of the transmitter Chassis, the remote control connections are available on a 15-pin male D-shell connector J6. This includes all of the remote controls, status and telemetries available to the operator.

These remote signals are routed from the MXi Control board via a 15-wire ribbon cable from connector J6 of the MXi Control board. The signals designations for each pin of J6 can be viewed on sheet 3 of the schematic in Figure 26. The actual circuitry that drives these signals is spread out on all five sheets of the schematic.

5.1 REMOTE CONTROLS

The Transmitter MODE must be in REMOTE for any of these remote controls to be operational. The transmitter is placed in the REMOTE mode via the touch LCD menu options as described in Section 3. The main LCD screen has a status light to show if the REMOTE MODE is active.

To place the transmitter into REMOTE MODE, the operator must enter the REMCTL submenu on the LCD and enable the REMOTE MODE.

The MXi provides 4 remote control inputs that effectively replicate the its own front panel mode control buttons. The VOR (Video Operated Relay) input is not available from the front panel since it is a special type of input that only makes sense as a remote input.

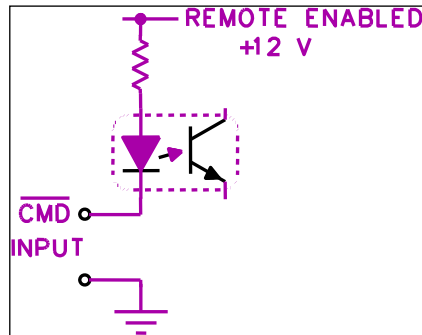


Figure 20 TX_OFF, RESET, and VOR Remote Controls

The TX_OFF , RESET and VOR remote controls are active low, opto-isolated inputs configured as shown, all of which require a GROUND for assertion and the activator to be able to sink 15mA or more for at least 200 milliseconds to accomplish reliable keying. Each of these is current-limited by an individual resistor.

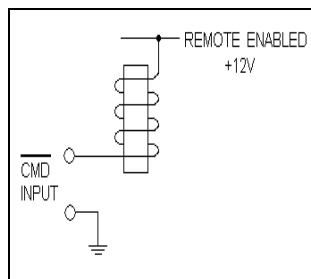


Figure 21 TX_ON Remote Control

The TX_ON remote control is an active low input configured to drive a relay coil off +12V supply. It requires a GROUND for assertion and the activator to be able to sink 100 mA or more for at least 200 milliseconds to accomplish reliable keying.

MXi AMPLIFIER CONTROLLER BOARD REV.2

TX D-Connector	PC Board Connector	Designation	Description
Remote Control			
Pin 1	J6 Pin 1	RC_TX_On	Turns Transmitter ON
Pin 9	J6 Pin 2	RC_TX_Off	Turns Transmitter OFF
Pin 2	J6 Pin 3	RC_Reset	Resets VSWR Trip
Pin 4	J6 Pin 7	RC_VOR	VOR On Controls
Pin 12	J6 Pin 8	Ground	Ground Reference
Pin 15	J6 Pin 14	EXT1+	Secondary Ext1 Intk
Pin 8	J6 Pin 15	EXT1-	Secondary Ext1 Intk

5.1.1 RC_TX_On Remote Transmitter ON Control

The MXi controller has the facility to force the ON/OFF function to follow the front panel ON button. Jumper E5 is a two-position jumper that can be placed in the EXT or INT position (these are silk screened on the PC board). When in the INT position and the front panel button is the ON position, this will force the transmitter to the ON state regardless of the remote or CPU controls. If the front panel button is the OFF position, then the remote ON command will function normally. When jumper E5 is in the EXT position (normal state), then the remote ON command will function normally as well.

A second jumper E7 (Manual Control) also affects the remote ON commands. When installed, this jumper effectively bypasses the CPU and the REMOTE MODE. The transmitter will turn ON whenever there is a low signal applied to the RC_TX_On command input. When this signal is removed, the transmitter turns OFF. This jumper is really a Bypass of the CPU's remote control function and is only meant for emergency purposes. In normal operation, jumper E7 would not be installed. Also note that if jumper E5 (mentioned above) is in INT and the front panel ON button is in the ON position, the remote control input will not be able to turn OFF the transmitter, since it is being held on by the front panel pushbutton.

The following description assumes that jumper E5 is in the EXT position and jumper E7 is not installed.

An active low signal applied to the RC_TX_On command input causes the CPU to read this active state and if the transmitter is in REMOTE mode, then the CPU will issue an ON command to the ON relay K1.

Note that this changes the transmitter's state to ON (when in REMOTE) such that after any subsequent power outage, the MXi transmitter will return to its previous state.

If the operator changes the transmitter's MODE from REMOTE to LOCAL, the ON/OFF state of the transmitter will be controlled by the position of the front panel ON/OFF button.

If the operator changes the transmitter's MODE from LOCAL to REMOTE, the ON/OFF state of the transmitter will revert to the previous state when REMOTE MODE was active.

5.1.2 RC_TX_Off Remote Transmitter OFF Control

The following description assumes that jumper E5 is in the EXT position and jumper E7 is not installed.

An active low signal applied to the RC_TX_Off command input causes the CPU to read this active state and if the transmitter is in REMOTE mode, the CPU removes the ON command from the ON relay K1.

Note that this changes the transmitters state to OFF (when in REMOTE) such that after any subsequent power outage, the MXi transmitter will return to its previous state.

If the operator changes the transmitter's MODE from REMOTE to LOCAL, the ON/OFF state of the transmitter will be controlled by the position of the front panel ON/OFF button.

If the operator changes the transmitter's MODE from LOCAL to REMOTE, the ON/OFF state of the transmitter will revert to the previous state when REMOTE MODE was active.

5.1.3 RC_TX_VOR Remote Transmitter VOR Control

The following discussion is assuming that jumper E5 is in the EXT position and jumper E7 is not installed.

The VOR (Video Operated Relay) control is a specialized input that performs a very rudimentary control of a network of transmitters. The VOR is a signal that is active when video has been present for a specified length of time, typically around 30 seconds or longer. The presence of video for more than this time causes the CPU to issue an ON command to the ON relay K1.

When video disappears for more than a shorter amount of time, typically around 5 seconds, the CPU removes the ON command from the ON relay K1.

This is used when full remote controls are not available for transmitters located in areas that are difficult to access. In this manner, the operator can turn ON or OFF any number of transmitters in the network by either applying (or removing) video at the source feed. When this VOR control is being used, the normal remote ON or OFF commands would not be utilized.

Note that this changes the transmitter's state to ON (when in REMOTE) such that after any subsequent power outage, the MXi transmitter returns to its previous state.

If the operator changes the transmitter's MODE from REMOTE to LOCAL, then the ON/OFF state of the transmitter will then be controlled by the position of the front panel ON/OFF button.

If the operator changes the transmitter's MODE from LOCAL to REMOTE, the ON/OFF state of the transmitter will revert to the previous state when REMOTE MODE was active.

5.1.4 RC_RESET Remote RESET Control

The remote reset command can have four different possible operations depending on which jumpers are selected in the MXi board.

If both jumpers E18 and E2 are removed (this is the normal mode), the reset command is fed only to the CPU chip, which then issues a VSWR reset, only if the MXi system is in Remote Mode.

If jumper E18 is installed but E2 is removed, the reset command is manually routed to the VSWR relay reset coil and effectively bypasses the CPU chip. In this configuration, a remote reset command clears the VSWR relay and does not depend on the MXi being in Remote Mode.

If jumper E18 is out but E2 is installed, the remote reset command first causes a reset of the CPU chip itself and, if the MXi system is in Remote Mode, the CPU will itself then issue a VSWR reset command.

If both jumper E18 and E2 are installed, the remote reset command causes a reset of the CPU chip itself and will be manually routed to the VSWR relay reset coil bypassing the CPU chip.

5.2 EXT1 SECONDARY EXTERNAL #1 INTERLOCK

The remote connector also has a pair of contacts that replicate a parallel set of contacts for the EXT1 interlocks at TB1 on the rear panel. This is not really a remote control, but it could be used as a simple ON/OFF by supplying a set of controlling contacts across EXT1+ and EXT1-. There is no real polarity required and the + and - designations are just to differentiate the two pins. The other set of contacts on TB1 should be left unconnected if this is being used.

5.2.1 Status Outputs

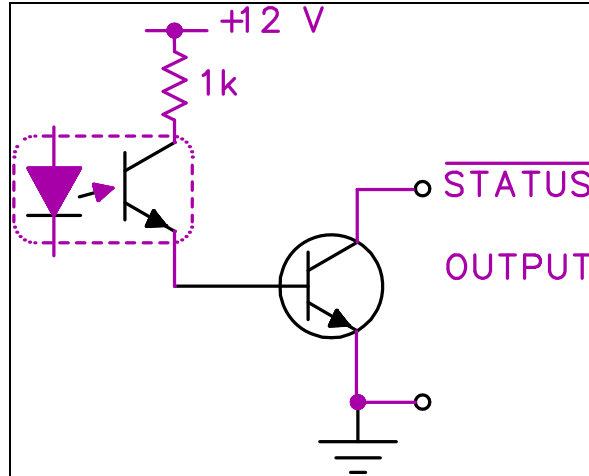


Figure 22 Status Outputs

These are current sinking open collector outputs, out of quad pack MPQ2222 (2N2222A) NPN transistors driven by opto-isolator devices. The available output sink current is dependent on the gain of the NPN and the opto-isolator transfer ratio. Generally, one can expect at least 100mA of sinking current for each output listed here. Because these are open collector, they can be used in special applications, such as on-site warning signal activation if desired, but they are limited in external circuit voltage to maximum 60VDC. Each status (in parentheses) indicates what it means when in its active low condition.

The MXi provides three remote control outputs that represent the current operating state of the switching system via the Digital Output Board

TX D-Connector	PC Board Connector	Designation	Description
Remote Control			
Pin 9	J6 Pin 2	RS TXOn	Transmitter is turned ON
Pin 2	J6 Pin 3	RS_Error	Transmitter has an error
Pin 10	J6 Pin 4	RS_Remote	Transmitter is in Remote Mode
Pin 12	J6 Pin 8	Ground	Ground Reference

5.3 TELEMETRY OUTPUTS

These are buffered OpAmp outputs, out of quad pack LM324 operational amplifiers. The available output voltage is limited to the range of 0 – 5VDC. The OpAmp can reliably source around 5mA of current and so a relatively high impedance input of at least 2K ohms should be used. Each telemetry has a description to indicate what parameter it is measuring.

The MXi provides five remote telemetry outputs that represent the current operating levels of the MXi transmitter.

MXi AMPLIFIER CONTROLLER BOARD REV.2

TX D-Connector	PC Board Connector	Designation	Description
Remote Controls			
Pin 5	J6 Pin 9	RT_FWD	Forward RF power level
Pin 13	J6 Pin 10	RT_RFL	Reflected RF power level
Pin 6	J6 Pin 11	RT_AUR	Aural RF power level (optional)
Pin 15	J6 Pin 12	RT_AGC	AGC voltage (1/2 scale)
Pin 7	J6 Pin 13	RT_CUTB	Cutback voltage (1/2 scale)
Pin 12	J6 Pin 8	Ground	Ground Reference

6 CIRCUIT DESCRIPTIONS

6.1 MC68HC908 MICROPROCESSOR

The Motorola MC68HC908GT microprocessor (often referred to as the CPU or HC08) performs all of the control interface and communications in the MXi transmitter system. It is a 44-pin surface mount PLCC type device that is permanently soldered to the circuit board and is not field serviceable or easily replaced without special surface mount tooling. A brief description of the part is given in this section and a portion of the manufacturer's documentation is given in Appendix A. More detailed information on this part can be obtained from the Motorola web site.

The HC08 chip used in the MXi can come with either 8K or 16K bytes of non-volatile flash memory, which can be erased and reprogrammed to allow updating of software code or system parameters. The MXi code is typically smaller than 8k and so would fit in either size of Flash memory. The HC08 chip has a dedicated serial input pin designated as the BDM (Background Debug Mode) port that is used to program the internal Flash memory and for debug testing. The MXi is programmed at the factory and it is not expected that reprogramming would need be done in the field, although it is possible to do with the proper software. System parameters and status that need to be retained during power failures (such as the LOG entries) are also stored in the Flash memory.

Most of the external pins on the HC08 are configured as programmable Input/Output (I/O) ports, where the software program determines whether a certain pin is to be configured as either an input or output. The pins on the HC08 are grouped together in sets called PORTs. These Ports will have eight pins (or fewer) to support the byte wide data path in the CPU. Port A is used for general system inputs and outputs. Port B is used as an eight-channel A/D converter to measure system telemetry values. Port C is used for general system inputs and outputs. Port D assigns four pins for the synchronous serial port (SPI) with the other four pins used for system inputs. Port E assigns two pins as a serial communications port (SCI), one pin is the external CPU clock and the other two pins used for general system inputs and outputs.

The definition of each Port pin is as follows:

PORT A

PA0	Input or Output	Jumper E3 configures as I/P or O/P
PA1	Input	Remote Control ON Command
PA2	Input	Remote Control OFF Command
PA3	Output	Select enable for Serial NvPot U16
PA4	Input	Front Panel ON Command
PA5	Input	Front Panel VSWR RESET Command
PA6	Input	32V Power Supply OK Status
PA7	Input	Remote Control VOR Status

PORT B

PB0	Telemetry	Temperature of Heatsink [Optional]
PB1	Telemetry	Power Supply Current
PB2	Telemetry	Power Supply Volts
PB3	Telemetry	Cutback Volts [Scaled at half the actual value]
PB4	Telemetry	AGC Volts [Scaled at half the actual value]
PB5	Telemetry	RF Aural Power [from RF detector - Optional]
PB6	Telemetry	RF Reflected Power [from RF detector]
PB7	Telemetry	RF Forward Power [from RF detector]

MXi AMPLIFIER CONTROLLER BOARD REV.2

PORT C

PC0	Output	Remote Status – Error
PC1	Input	DipSw #1
PC2	Input	Power Supply (Relay K1) ON Status
PC3	Input	DipSw #2
PC4	Input	External #1 Interlock
PC5	Output	VSWR Reset Control
PC6	Output PS ON Ctl	+12V out [could be 24V too]

PORT D

PD0	SPI	SS	Used by UART
PD1	SPI	MISO	Used by UART and NvPot
PD2	SPI	MOSI	Used by UART and NvPot
PD3	SPI	SCLK	Used by UART and NvPot
PD4	Input	Fan#1 Status, Active Low	
PD5	Input	Fan#2 Status, Active Low	
PD6	Input	Fan#3 Status, Active Low	
PD7	Input	Fan#4 Status, Active Low	

PORT E

PE0	SCI	Transmit Data	Used by LCD
PE1	SCI	Receive Data	Used by LCD
PE2	O/P	Remote Status – Remote Mode	
PE3	Input	VSWR Trip Status	
PE4	System	Main CPU Clock – 4.9152MHz	

The HC08 provides two separate serial interfaces to external components, these are the synchronous peripheral interface (SPI) and the serial communications interface (SCI).

The SCI implements the standard three-wire serial port (Rx Data, Tx Data and Ground) that would interface to a typical computer port. The baud is settable from 300 up to 38,400 bits per second via the LCD menus. The baud is derived from the system oscillator clock at 4.9152MHz. This frequency is recommended by the manufacturer to easily obtain the most common bauds.

The SPI implements a four-wire clocked serial port that has four signals, Slave Select (SS), Master Out Slave In (MOSI), Master In Slave Out (MISO) and Serial Clock (SCLK). The HC08 is always set as the Master who initiates all serial communications. The SPI port is used to communicate with the MAX3110 UART (U2) and the DS1867 NovPot (U16). The HC08 will send out its data stream from the MOSI line and reads any responses from the external (Slave) devices via the MISO line. The SCLK is a serial clock (set for around 64K baud) that synchronizes the data transfer. The presence of this clock allows much higher data rates than the asynchronous SCI serial protocol. The SS line is a select that enables the MAX 3110 UART when low. A second individual select line from Port A (pin PA3) is used to select the DS1867 NovPot.

6.2 POWER SUPPLY VOLTAGE AND CURRENT MONITORING

For the following description, refer to Figure 25 (Sheet #2 of the Schematic) in the upper section of the drawing for the power supply monitoring circuitry.

MXi AMPLIFIER CONTROLLER BOARD REV.2

The MXi board has a built-in Hall Effect current sensor that is able to measure the current drawn by the RF amplifier from the +32 volt power supply. The standard MXi low power transmitter would have a 25 amp current sensor. There are two possible sensors that could be installed in the MXi which depend on the actual current level that is to be measured. A higher power MXi transmitter would be fitted with a 40 amp current sensor. For higher power transmitters, the power supply would be external to the amplifier chassis and is fitted with its own current sensor telemetry that is fed into the MXi board separately and the MXi current sensor would be left unused. Another consideration for making the current sensor external on higher power MXi transmitters is the gauge of wire required for these higher current make it difficult to wire into the MXi board connector J4.

The circuit board has winding jumpers E20-E23 that allow a single input winding to the current sensor or a dual winding input to the current sensor. These winding jumpers allow for lower power transmitters (which require lower power supply currents) to generate a reasonable output voltage from the current sensor. When the winding jumpers are in the low current setting ("Lo I" = E20 jumpered to E21), this causes the input current to pass through the input of the current sensor twice (in two windings) producing double the output voltage than would be generated by a single winding. This is used for lower power transmitters where the maximum power supply current draw is under half of the rating of the current sensor.

When the winding jumpers are in the high current setting ("Hi I" = E20 jumpered to E22 and E21 jumpered to E23), this causes the input current to pass through the input of the current sensor only once (in one winding) producing half the output voltage than would be generated by a double winding. This is used for higher power transmitters where the maximum power supply current draw is over half of the rating of the current sensor.

When the internal current sensing is being utilized, the MXi expects the +32V to be applied at connector J4 pin 1. This voltage is passed through a current monitoring circuit and then fed back out on pin 2 of J4 to the RF amplifiers. The Hall Effect Sensor U9 has a built in voltage reference of 2.5 volts. The sensing output would be at this 2.5V level when there is no current through the sensor. When current passes through the sensor, then the output voltage would either increase or decrease from the 2.5V reference. Whether the voltage increases or decreases depends on the direction of current flow through the sensor thus making this device bi-directional. In our configuration, the current only flows one way and increasing current will result in decreasing sensor output voltages. Jumper E4 selects between the internal U9 2.5V reference or an external current sensor. When using U9 as the sensor, jumper E4 must be placed in the INT position. The output of E4 is fed into the positive input of OpAmp U7B with the negative input fed from the U9 sensing output such that the OpAmp effectively removes the 2.5V offset introduced by the U9 sensor. A potentiometer R15 is placed in the feedback path of U7A to allow the current to be calibrated.

When the power supply is external (usual in higher power MXi transmitters), the actual power supply is external to the amplifier chassis and will then do its own current metering. In this configuration, the MXi board would not have its own U9 current sensor installed but would receive this telemetry information from J5 pin 5. Jumper E4 selects between the internal U9 sensing output or an external current sensor. When using the external sensor, jumper E4 must be placed in the EXT position. OpAmp U7A allows for a gain control through potentiometer R15 so that the current reading can be calibrated.

The Power Supply voltage is expected to be +32 volts DC +/- 0.5V and can be fed into the MXi board from one of two points, depending on whether the supply is internal or external to the amplifier chassis.

When the power supply is internal to the MXi amplifier chassis, then the MXi expects the +32V to be applied at connector J4 pin 1. This voltage is passed through a current monitoring circuit and then fed back out on pin 2 of J4 to the RF amplifiers. This configuration is used when the MXi is a lower power transmitter that can accommodate the power supply internally.

When the power supply is external (usual in higher power MXi transmitters), the actual power supply is external to the amplifier chassis and will then do its own current metering. The +32V sample is connected to J5 pin 6 (which is in parallel with J1 pin 1). Connector J1 is a higher current contact that would allow the current to be passed through the internal current sensor U9. For an external supply these are not required and so both U9 and J4 will most likely not be installed on the board.

MXi AMPLIFIER CONTROLLER BOARD REV.2

6.3 ON/OFF RELAY K1

The ON/OFF relay K1 and associated circuitry is shown in Figure 25. Relay K1 is a four-pole, single-side stable relay that requires a constant voltage applied to its coil to maintain contact closure. The contacts of this relay provide the control signals to activate the +32V power supply and the cooling fans.

There are two elements that determine if power is applied to the coil of K1. One is the +12V arming voltage on the positive side of the coil that comes from the interlock chain. Four interlocks are placed in series with this coil such that all four must be closed in order for K1 to receive its +12V arming voltage. The four interlocks are Thermal, Tx Switching, External #1 and VSWR Trip. If any of these interlocks are open, then the relay will not be energized and transmitter amplifier will be shut down.

The second element that determines if power is applied to the coil of K1 is the control signal on the negative side of the coil. Note that LED DS5, which can be seen on the MXi front panel, indicates that the ON control signal has been issued to relay K1. This control signal can come from one or more of three sources.

The HC08 CPU can always activate the coil from its PC6 pin. This pin activates the base of transistor U10B that in turn will energize the coil of K1. The second source is the remote control TX_ON command at connector J6 pin 1. When jumper E7 is installed, the remote control TX_ON command can directly energize the coil of K1. The third source is the front panel ON button. When jumper E5 is in the INT position, the front panel ON button when pressed in will directly energize the coil of K1.

When K1 is energized, all four poles of the relay will close and cause the transmitter to generate RF power.

Two poles are connected in parallel and send +12V (or +24 volts in some applications) to the fans at connector J8. Two poles are used since the current rating of one relay pole is not sufficient for the total current draw of up to four fans. One pole is used to send a +12V command to the +32V power supply. This command causes the power supply to activate and send its +32V to the RF amplifier. The last pole is used for status, when closed a ground is sent to the remote control status output RS_TX_ON at J6 pin 5. When K1 is not energized, the ground of this pole is sent back to the HC08 which uses this input to determine if the relay K1 is energized or not.

6.4 AGC, CUTBACK AND VSWR

Figure 28 shows the circuitry associated with the AGC, cutback and VSWR functions. Each of these is described as follows.

The AGC circuit uses the voltage reference that is set by the HC08 CPU via the NvPot U16 pin 13. This voltage is effectively the desired voltage output that the system wants to see coming from the forward power RF detector. OpAmp U15A compares the U16 reference voltage to the actual voltage from the RF detector and provides an error output voltage when the value of the detected voltage is greater than the desired reference. If the detected voltage is less, then we have lower power than is desired and no AGC action would be needed. The OpAmp 15A has a high value feedback resistor to provide high gain and cause a strong AGC action for relatively small changes in output power.

The output error voltage from U15A is fed through a resistor divider that has jumper E16 in the middle of it. If E16 is installed, this shorts out any error voltage from U15A and disables the AGC action. This jumper should not be normally left installed, it is typically only used during setup operations and should be removed for everyday operations.

If E16 is not installed, the AGC error voltage is fed to the input of buffer OpAmp U15D and then out the MXi control board to the RF PreAmp attenuator via connector J10. The voltage at the PreAmp reduces the drive level to the RF amplifier and thus reduces the output power.

The AGC error voltage from U15A is divided by two with resistor divider R90/R92 and sent to the inputs of buffer OpAmps U15B and U15C. U15B provides AGC voltage telemetry for the remote control and U15C provides AGC voltage telemetry for the HC08 CPU that is displayed on the LCD.

The Cutback circuitry monitors the level of reflected power and compares it to a preset level. If the reflected power exceeds the reference level then an AGC voltage is produced that reduces the transmitter output power. The purpose for doing this is to protect the Amplifier devices from damage resultant from too much RF power reflecting back from the output system.

MXi AMPLIFIER CONTROLLER BOARD REV.2

The reflected power sample is sent to OpAmp U17C which compares this with the reference level set by potentiometer R15 and test point TP6. This reference level is set up by sending -16dB of the transmitter forward power into the reflected port and adjusting R105 until the MXi begins to just start reducing the transmitters output power.

When the reflected power exceeds the reference level, OpAmp U17C will generate an error voltage that is fed into the AGC output OpAmp U15D via diode CR12. This has the same effect as an AGC reduction.

The Cutback voltage from U17C is divided by two with resistor divider R98/R99 and sent to the inputs of buffer OpAmps U19B and U19A. U19A provides Cutback voltage telemetry for the remote control and U19B provides Cutback voltage telemetry for the HC08 CPU that would be displayed on the LCD.

The VSWR trip circuit provides protection to the RF amplifier in the presence of a persistent and high level reflected power condition. The VSWR system is set to trip at a reflected power level of -10dB down from the forward power.

OpAmp U17 compares the reflected power voltage with the forward power voltage. When the RF detector setup is done, the reflected power voltage is set for 4.0V when it is at a level of -10dB lower than the full rated forward power. The forward power voltage is set for 4.0V when it is at the full rated forward power level. When these two voltages are equal, then the reflected power is indeed -10dB under the forward power level.

In the case that the forward power sample has been removed or improperly setup, it is possible for the forward power level to be near 0V or very low. In this condition, any amount of reflected power would cause a VSWR trip which is undesirable and unnecessary. To prevent this event, OpAmp U17B forces a minimum forward power level of about 1.5V into U17D that would require a minimum reflected voltage of 1.5V to cause a VSWR trip. This represents a reflected power level of around -8.5dB instead of -10dB .

When the reflected level exceeds -10dB , set coil of relay K2 is energized, causing a VSWR trip to occur. Relay K2 is a two-coil latched relay where energizing the set coil causes the contacts of K2 to move into the set position and remain there even after the coil is de-energized. Once a VSWR trip has occurred, the relay K2 will remain in the set position until a signal is sent to the other reset coil that moves the contacts back into the original clear position.

The relay K2 can be reset from one or more of three sources.

The HC08 CPU can always activate the coil from its PC5 pin. This pin forces the output of NAND gate U18A high which activates the base of transistor U6C that in turn will energize the reset coil of K2. The second source is the remote control RC_RST command at connector J6 pin 2. When jumper E18 is installed, the remote control RC_RST command can directly drive the base of transistor U6C that in turn will energize the reset coil of K2. The third source is the front panel RESET button. When the front panel RESET button is pressed in, it directly energizes the reset coil of K2.

The VSWR relay has two poles, one for the transmitter interlock and the second for status. The interlock pole is part of the arming interlock chain of the ON/OFF relay K1. If the K2 contact is opened (i.e., there was a VSWR trip), the arming voltage is removed from ON/OFF relay K1 and the transmitter shuts down. Note that jumper E17 is provided to override the VSWR relay trip contacts. This jumper is only for setup purposes and should never be left installed in normal operations.

Note: Leaving the jumper E17 installed will defeat all the VSWR protection and could result in damage to the RF amplifier if a high reflected power condition occurs.

The second pole of K2 lights status LED DS10 when the relay has tripped under VSWR condition. The other side of this pole is fed into the CPU, which uses this to determine if K2 is tripped or not.

6.5 SPI UART

The Maxim MAX3110 is a full single channel serial UART with integral RS232 drivers and receivers. The device uses the SPI interface to communicate with the HC08 CPU. A brief description of the part is given in this section and a portion of the manufacturers documentation is given in Appendix A. More detailed information on this part can be obtained from the Maxim/Dallas Semiconductor web site.

This device can implement a full serial port with data and handshaking lines. In this application, the handshaking lines are not used and these inputs/outputs are used for general signal purposes. The RTS output is used as a remote control TX_FAIL output status and the CTS input is used to read the Thermal Interlock status.

MXi AMPLIFIER CONTROLLER BOARD REV.2

The UART has its own 1.8432MHz crystal to generate the appropriate bauds. The CPU program sets up the baud as 9600 as the default but this can be altered by user command via the LCD touchpad menus.

An interrupt line is provided by the UART to signal the HC08 CPU when it is available for more data to transmit or when new data has been received. The device can also interrupt the HC08 in the presence of certain types of serial transmission error conditions.

The HC08 uses all four of the SPI interface lines to communicate with the UART, since it must both send data to the UART that must be transmitted and must read data from the UART that has been received. The CPU output Slave Select (SS) line is used to enable SPI communications with the UART. The HC08 has assigned the UART to provide communications between the HC08 and the LCD unit.

The UART has two RS232 drivers and two RS232 receivers that will translate the RS232 level to CMOS/TTL levels. One driver/receiver pair is used to interface the UART serial data to the LCD. The second driver/receiver pair is used to interface the HC08 serial data to the external computer.

6.6 SPI NVPOT

The Dallas Semiconductor DS1867 NvPot (non-volatile Potentiometer) dual channel serial potentiometer with data retention on power down. The device uses the SPI interface to communicate with the HC08 CPU. More detailed information on this part can be obtained from the Dallas Semiconductor website.

This device implements two independent variable resistances whose value is controlled by data bytes sent by the HC08 to the NvPot device. These resistances can be varied from close to 0 ohms up to 10k ohms in 256 individual steps (each step would be about 40 ohms each). The NvPot device retains these settings in non-volatile memory so that they can be restored after a power outage. Figure 24 and Figure 28 show the HC08 CPU and the NvPot circuitry.

The HC08 only uses two of the SPI interface signals to communicate with the NvPot. The MOSI signal is used to send data to the NvPot (there is no need to receive any data from the device so MISO is not used).

The SCLK is used to provide the synchronization clock. A separate select line PA3 is used to enable communications to the device. When PA3 is low, the NvPot communications is disabled and when PA3 is high the NvPot communications is enabled. The HC08 must co-ordinate the selects between this NvPot and the UART that share the SPI data line. The select lines are set such that only one of these devices are active at one time.

One of the variable resistance potentiometers is used by the HC08 to set the AGC reference voltage that drives the AGC circuitry in Figure 28.

The second potentiometer is used to calibrate the thermistor temperature reading from the heatsink. Note that the thermistor is an optional component and may not be present in all MXi transmitters.

6.7 RF DETECTOR

6.7.1 Circuit Description

The board is fitted with two RF detectors, which respond to RF samples fed from RF directional couplers mounted on output combiner of the Amplifier heatsink. The modulation envelope blanking level is measured because it remains constant, regardless of the picture content of the transmission. Measurement occurs during the back porch. Both sections of the board are configured in a similar way.

6.8 J12 CHANNEL – VISUAL FORWARD

The RF sample is applied to input J12 and is terminated by R52 in parallel with R53 for an impedance of around 50 ohms. CR5 and Q4 form an envelope detector. CR5 is forward biased slightly by R43 and R54 to overcome CR5 conduction threshold voltage, thereby improving detection linearity. Q4 is forward biased by R43 as well, and when RF is applied, Q4 is driven in the direction of turn off during each positive-going half cycle, thus causing its emitter voltage to become more positive and in effect forming a linear envelope detector.

C24 utilizes the lead inductances of CR5 and Q4 to form a Tee network, which provides a matching section that improves the UHF signal transfer between the devices. Q4 and CR5 have similar temperature coefficients and the opposing connection of the two in this back-to-back configuration provides temperature compensation.

MXi AMPLIFIER CONTROLLER BOARD REV.2

Finally, Q4 serves as a low impedance video source. Jumper E9 is used to introduce color subcarrier trap FL1. An alternate trap consisting of C43, C25 and L1 (marked with asterisks) can also provide this function. The alternate trap can also be easily changed in values to provide different frequency traps for other systems (like PAL). **Note:** only one of either FL1 or the Inductor/Capacitor traps would be installed but never both.

Transistor Q2 serves as a buffer and Q1 serves as another buffer. Following is filter FL2, which removes the aural carrier. An alternate Inductor/Capacitor trap consisting of L2, C44 and C26 is also provided.

The inverted and amplified video signal is fed to a peak detector comprised of CR4, C22 and R47 through either resistor R42 (1k ohm) or resistor R46 (33 ohm). Jumper E8 will determine which resistor is in the path and is silk screened as Pk (peak) or Av (average) on the circuit board. If the RF signal is Digital, then E8 is installed in the Av position where R42 will effectively form a RC charging circuit that averages the signal and eliminates any momentary peaks. If the RF signal is analog, then E8 is installed in the Pk position, where R46 will effectively pass the entire detected envelope to the peak detector.

Because a single supply op-amp is used at U5, the output seen on TP1 and TP2 contains a small DC offset which must be minimized because low level signals are near ground/earth potential. With no RF input, this offset voltage is adjusted by potentiometer R58 as near as possible to ground/earth. The setting can be seen when using a DC coupled scope. Adjust R58 to move the DC level toward ground/earth potential; stop turning the potentiometer immediately the DC ceases moving. A residual voltage offset of 20 millivolts can be expected for the LM358 family of op-amps.

The gain of the amplifier stage at U5A can be adjusted by selecting one of the two available feedback resistors R56 (5.1K ohms) or R59 (10K ohms) using jumper E11. When a lower gain is desired, E11 is placed in the LO position selecting R56 and when a higher gain is desired, E11 is placed in the HI position selecting R59.

The two test points TP1 and TP2 are provided to support the external aural detector. When this option is not installed, a jumper is placed between J11 pin 5 and J11 pin 6 which placed these two test points at the same potential.

Outputs from unity gain op-amps U13A, U13B, U13C and U13D drive the forward power metering circuits. The output of U13A provides telemetry to the CPU A/D converter input. The output of U13B provides telemetry to the AGC (VSWR) circuitry. The output of U13C provides telemetry to the remote controls and U13D provides telemetry for the optional transmitter switch connections. Bench test calibration consists of adjusting R48 with rated, properly modulated input while observing the voltage at TP3, which should read 4.0 volts DC for full scale calibration.

6.9 J13 CHANNEL – REFLECTED

The RF sample is applied to input J13 and is terminated by R74 in parallel with R75 for an impedance of around 50 ohms. CR9 and Q6 form an envelope detector. CR9 is forward biased slightly by R67 and R76 to overcome CR9 conduction threshold voltage, thereby improving detection linearity. Q6 is forward biased by R67 as well, and when RF is applied, Q6 is driven in the direction of turn off during each positive-going half cycle, thus causing its emitter voltage to become more positive and in effect forming a linear envelope detector.

C32 utilizes the lead inductances of CR9 and Q6 to form a Tee network, which provides a matching section that improves the UHF signal transfer between the devices. Q4 and CR5 have similar temperature coefficients and the opposing connection of the two in this back-to-back configuration provides temperature compensation.

Finally, Q6 serves as a low impedance video source. Jumper E13 is used to introduce color subcarrier trap FL3. An alternate trap consisting of C33, C45 and L3 (marked with asterisks) can also provide this function. The alternate trap can also be easily changed in values to provide different frequency traps for other systems (like PAL). Note that only one of either FL1 or the Inductor/Capacitor traps would be installed but never both.

Following is filter FL4 which removes the aural carrier. An alternate Inductor/Capacitor trap consisting of L4, C46 and C32 is also provided.

The inverted and amplified video signal is fed to a peak detector comprised of CR8, C30 and R71 through either resistor R66 (1k ohm) or resistor R70 (33 ohm). Jumper E12 will determine which resistor is in the path and is silk screened as Pk or Av on the circuit board. If the RF signal is Digital, then E12 is installed in the Av position where R66 will effectively form a RC charging circuit that averages the signal and eliminates any momentary peaks. If the RF signal is analog, then E12 is installed in the Pk position where R70 will effectively pass the entire detected envelope to the peak detector.

MXi AMPLIFIER CONTROLLER BOARD REV.2

Because a single supply op-amp is used at U14D, the output seen on TP4 will contain a small DC offset which must be minimized because low level signals are near ground/earth potential. With no RF input, this offset voltage is adjusted by potentiometer R80 as near as possible to ground/earth. The setting can be seen when using a DC-coupled scope. Adjust R80 to move the DC level toward ground/earth potential; stop turning the potentiometer immediately the DC ceases moving. A residual voltage offset of 20 millivolts can be expected for the LM358 family of op-amps.

The gain of the amplifier stage at U14D can be adjusted by selecting one of the two available feedback resistors R79 (6.2K ohms) or R82 (20K ohms), using jumper E15. When a lower gain is desired, E15 is placed in the LO position selecting R79 and when a higher gain is desired, E15 is placed in the HI position selecting R82.

Outputs from unity gain op-amps U14A, U14B and U14D drive the reflected power metering circuits. The output of U14A provides telemetry to the CPU A/D converter input. The output of U14B provides telemetry to the CUTBACK and VSWR circuitry. The output of U14C provides telemetry to the remote controls. Bench test calibration consists of adjusting R72 with rated, properly modulated input while observing the voltage at TP5, which should read 4.0 volts DC for full scale calibration.

6.10 J12 CHANNEL – AURAL FORWARD

Note: This description only applies when the aural metering option has been included in the transmitter system.

The aural metering circuit takes a sample of detected video signal from the forward port and provides DC level proportional to the amplitude of the aural carrier. The sample of this DC level is used to compensate visual forward reading affected by presence of the aural carrier at the forward port.

The inverted and amplified video signal is fed to sync separator U9-2. When sync is detected, the sync output at pin 1 delivers a positive-going composite sync pulse, which turns on Q11 whose collector then goes LOW. If no sync is detected by U9, its pin 1 remains LOW and Q11 remains off.

After U9-1 pulse has finished, Q11 turns off and its collector output goes HIGH. This LOW to HIGH transition activates blanking multivibrator U7 and an active low pulse is fed to Q10, turning it on.

Q2, C4, and U2A form a sample-and-hold circuit that samples the signal originating from the emitter of Q1 and which is buffered by Q18. Sampling occurs during the back porch, and holds during the subsequent horizontal line. This DC sample is amplified in U2A .

The sample of the signal detected by CR1 from J1 port is buffered by Q3. The wideband visual/aural signal drives an aural bandpass ceramic filter FL3. The filter is chosen for the broadcast standard in use. C12 couples the filtered aural CW signal to amplifier Q7. Following is a buffer Q6 and RF amplifier U4. The aural signal from U4 output is then fed to peak detector consisting of CR2, C15, R45. Q8 buffers signal before applying to sample and hold circuit consisting of Q9, C16 and R52. Sampling aural signal during the back porch provides level independent of video content.

Because a single supply op-amp is used at U3B, the output seen on TP3 will contain a small DC offset which must be minimized because low level signals are near ground/earth potential. With no RF input, this offset voltage is adjusted by potentiometer R34 as near as possible to ground/earth. The setting can be seen when using a DC coupled scope. Adjust R34 to move the DC level toward ground/earth potential; stop turning the potentiometer immediately the DC ceases moving. A residual voltage offset of 20 millivolts can be expected for the LM358 family of op-amps.

U3B provides DC amplification of detected signal. Following is another amplifier U5A which gain is set by potentiometer R59, so DC level at TP4 is in the range of 7VDC. This provides enough "safety" range for the signal not to saturate or not being high enough for 4VDC calibration at TP5. The sample of aural output is fed to differential amplifier U3A to compensate for aural carrier influence on visual metering in internally diplexed systems. R42 is used to minimize this influence. Jumper JPH3 set in position 1-2 enables this compensation, otherwise JPH3 must be set in position 2-3.